

COMPAL CONFIDENTIAL

MODEL NAME : BAL20
PCB NO : DAZ1P600100
BOM P/N : 431A2K31L01

SKL-U+MEC1404 board
2016-06-21
REV : 1.0 (A00)

@ : Un-pop Component
UMA@/DIS@ : UMA & DIS Type
KBL@/SKL@ : CPU Type
EC@ : EC
JP@/PJP@ : JUMP

EMI@/ESD@/RF@ : EMI, ESD and RF Component
@EMI@/@ESD@/@RF@ : EMI, ESD and RF Un-POP Component
CMC@ : XDP Component
CONN@ : Connector Component
TP_WAKE@/NTP_WAKE@ : TouchPad wake
KBBL@ : KB Backlight
3D@/3D@EMI@ : 3D Camera
@3D@ : 3D Camera Un-POP Component

M1_70R1@ : GPU R1
M1_70R3@ : GPU R3
2G@/2G_H@/2G_S@/2G_M@ : VRAM type
4G@/4G_H@/4G_S@/4G_M@ : VRAM type

zzz

PCB

DAZ1P600100

PCB@

PCB BAL20 LA-D801P LS-D801P/D802P/D803P

KBL R3

UC1

i7-R1

SA0000A344L

i7KBL2.7G_R3@

S IC FJ8067702739740 SR2ZV H0 2.7G A31!

UC1

i5-R1

SA0000A374L

i5KBL2.5G_R3@

S IC FJ8067702739739 SR2ZU H0 2.5G A31!

SKL R3

UC1

i7-R3

SA000092P3L

i7SKL2.5G_R3@

FJ8066201930408 SR2EZ D1 2.5G A31!

UC1


i5-R3

SA000092O3L

i5SKL2.3G_R3@

FJ8066201930409 SR2EY D1 2.3G A31!

Layout Dell logo



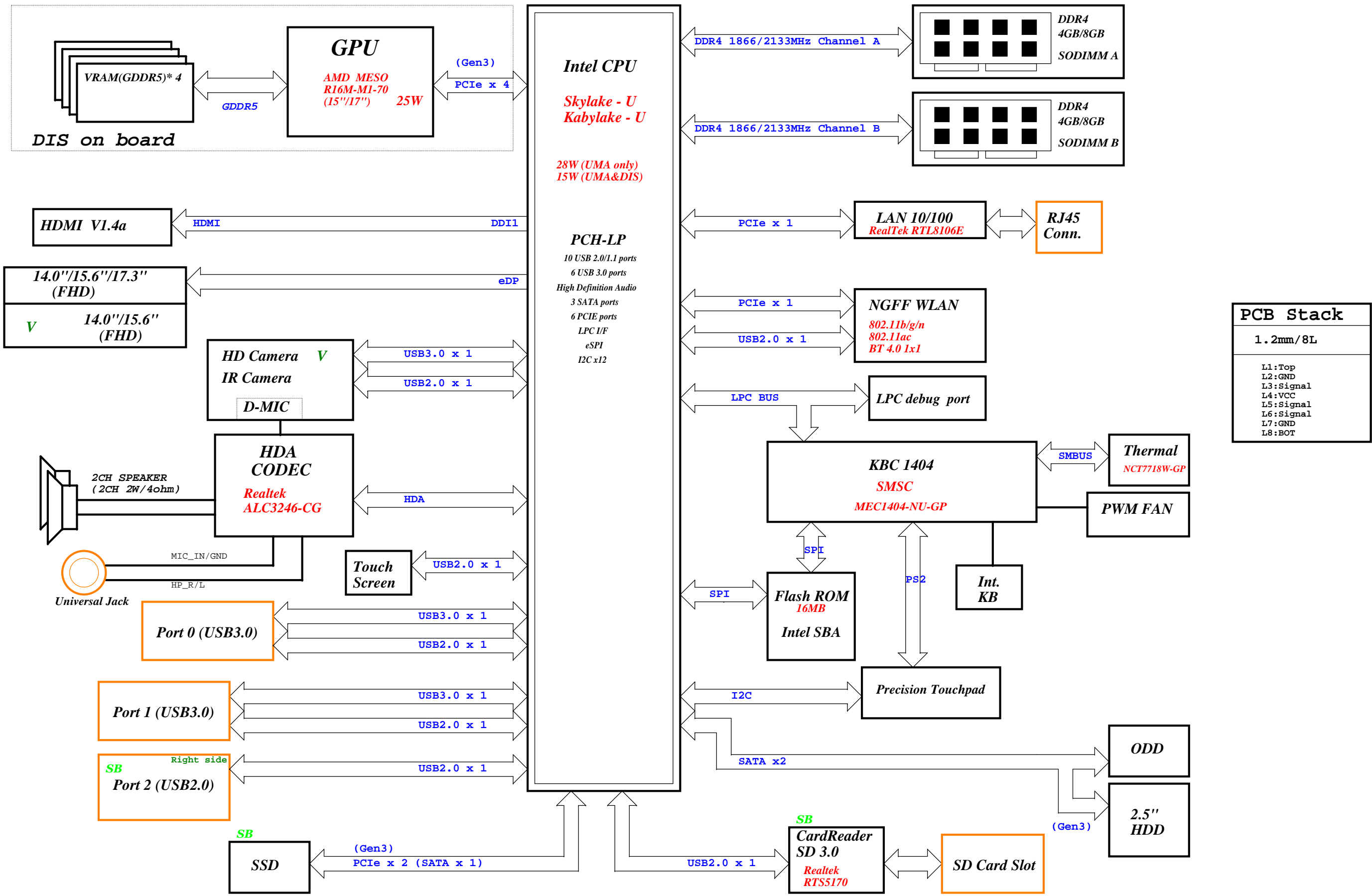
COPYRIGHT 2014
ALL RIGHT RESERVED
REV: X00
PWB: 9HTP8

PROPRIETARY NOTE: THIS SHEET OF ENGINEERING DRAWING AND SPECIFICATIONS CONTAINS CONFIDENTIAL TRADE SECRET AND OTHER PROPRIETARY INFORMATION OF DELL INC. ("DELL") THIS DOCUMENT MAY NOT BE TRANSFERRED OR COPIED WITHOUT THE EXPRESS WRITTEN AUTHORIZATION OF DELL. IN ADDITION, NEITHER THIS SHEET NOR THE INFORMATION IT CONTAINS MAY BE USED BY OR DISCLOSED TO ANY THIRD PARTY WITHOUT DELL'S EXPRESS WRITTEN CONSENT.



DELL CONFIDENTIAL/PROPRIETARY			
Compal Electronics, Inc.			
Title		Cover Page	
Size	Document Number		Rev
	LA-D801P		A00
Date:	Tuesday, June 21, 2016	Sheet	1 of 61

Block Diagram



POWER STATES

Signal State	SLP S3#	SLP S4#	SLP S5#	ALWAYS PLANE	SUS PLANE	RUN PLANE	CLOCKS
S0 (Full ON) / M0	HIGH	HIGH	HIGH	ON	ON	ON	ON
S3 (Suspend to RAM) / M3	LOW	HIGH	HIGH	ON	ON	OFF	OFF
S4 (Suspend to DISK) / M3	LOW	LOW	HIGH	ON	OFF	OFF	OFF
S5 (SOFT OFF) / M3	LOW	LOW	LOW	ON	OFF	OFF	OFF
G3	OFF	OFF	OFF	OFF	OFF	OFF	OFF

USB PORT#	DESTINATION
1	USB3.0 Port1
2	USB3.0 Port2
3	IO/DB
4	N/A
5	CCD
6	Card Reader
7	Touch Screen
8	BT
9	N/A
10	N/A

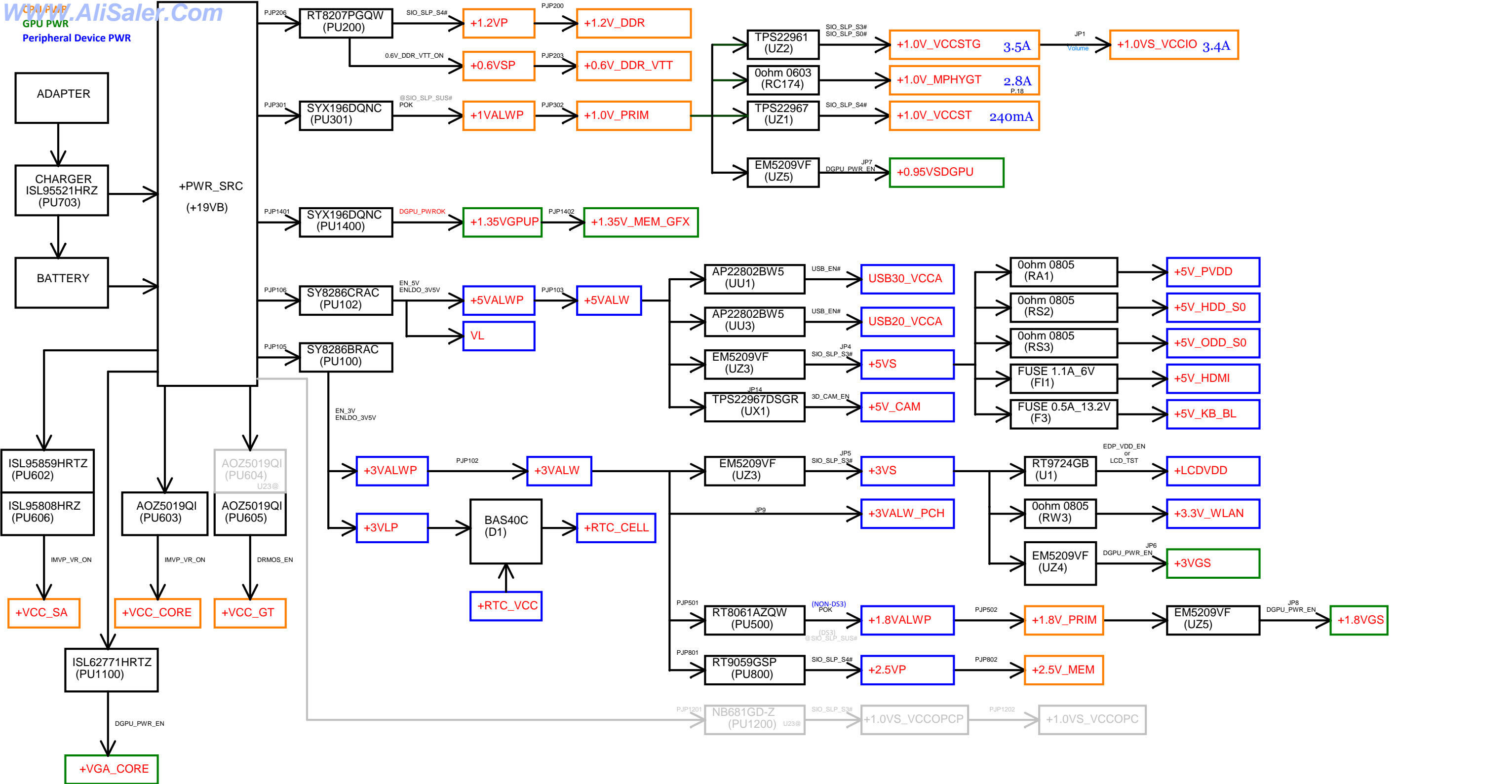
USB3.0	SSIC	PCIE	SATA	DESTINATION
USB3.0-1				USB3.0 Port1
USB3.0-2	SSIC-1			USB3.0 Port2
USB3.0-3	SSIC-2			3D Camera
USB3.0-4				N/A
USB3.0-5		PCIE-1		GPU
USB3.0-6		PCIE-2		GPU
		PCIE-3		GPU
		PCIE-4		GPU
		PCIE-5		WLAN
		PCIE-6		10/100M LAN
		PCIE-7	SATA-0	SATA HDD
		PCIE-8	SATA-1	SATA ODD
		PCIE-9		N/A
		PCIE-10		N/A
		PCIE-11	SATA-1*	N/A
		PCIE-12	SATA-2	N/A

PM TABLE

power plane State	+RTC_CELL	B+	+1.0V_PRIM +1.0V_MPHYGT +1.8V_PRIM +3VALW +3VALW_PCH +3.3V_ALW_DSW +5VALW	+1.0V_VCCST +1.2V_DDR +2.5V_MEM	+1.0VS_VCCIO +1.0V_VCCSTG +VCC_GT +VCC_SA +VGA_CORE +VCC_CORE +0.6V_DDR_VTT
S0	ON	ON	ON	ON	ON
S3	ON	ON	ON	ON	OFF
M3	ON	ON	ON	ON	OFF
S4&S5 / AC	ON	ON	ON	OFF	OFF
S4&S5 / AC doesn't exist	ON	ON	OFF	OFF	OFF
G3	ON	OFF	OFF	OFF	OFF

Board ID & Model ID table

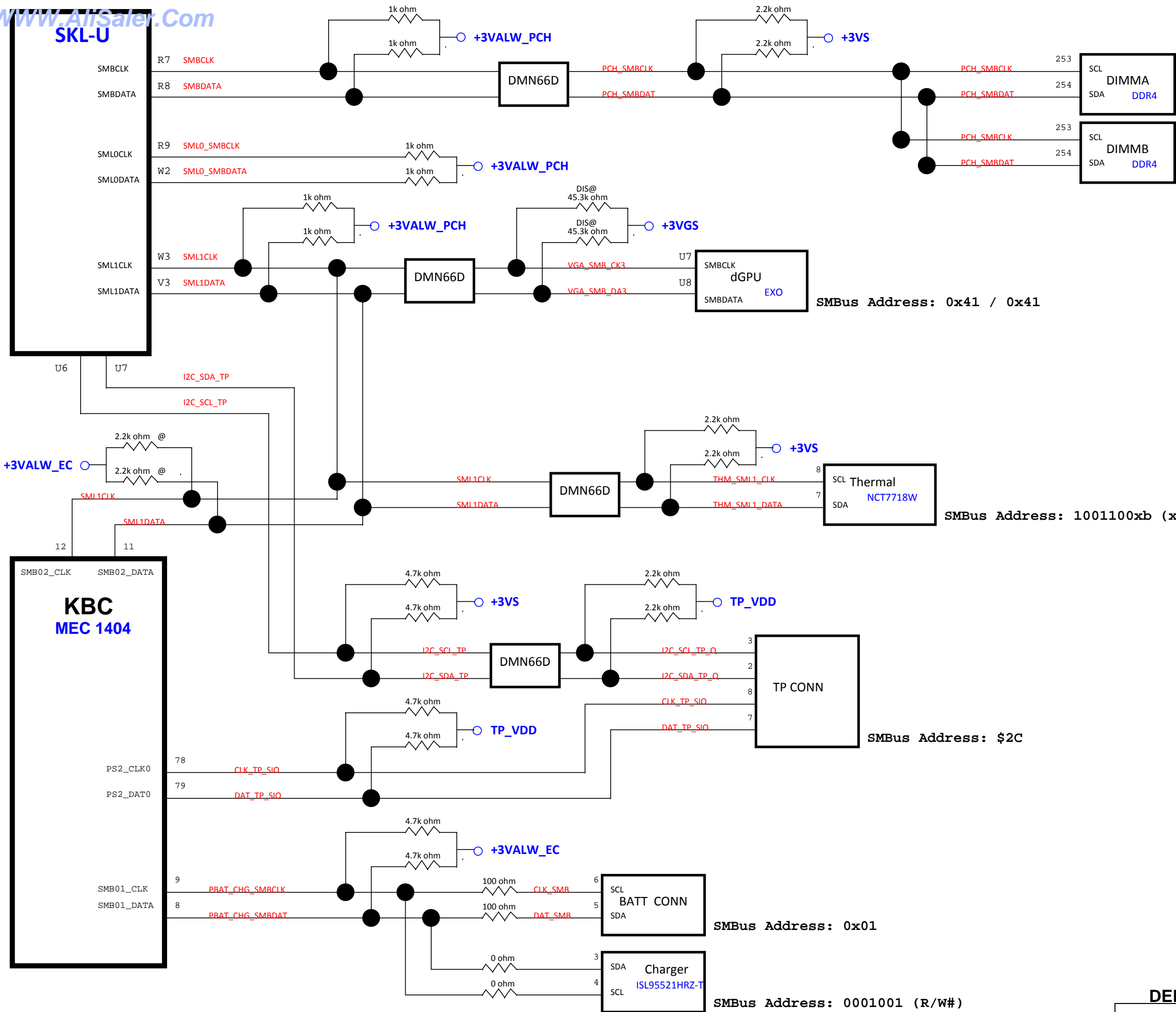
Item	Pull-down	Pull-up	Voltage	Board ID/Model ID
1	100	10.0	3.000	EVT
2	100	13.7	2.902	DVT1
3	100	17.8	2.801	DVT2
4	100	22.1	2.703	
5	100	27.0	2.598	
6	100	32.4	2.492	
7	100	37.4	2.402	
8	100	49.9	2.201	Pilot
9	100	57.6	2.094	
10	100	64.9	2.001	
11	100	73.2	1.905	
12	100	82.5	1.808	
13	100	93.1	1.709	
14	100	107.0	1.594	
15	100	120.0	1.500	
16	100	137.0	1.392	
17	100	154.0	1.299	
18	100	200.0	1.100	
19	100	232.0	0.994	



DELL CONFIDENTIAL/PROPRIETARY

PROPRIETARY NOTE: THIS SHEET OF ENGINEERING DRAWING AND SPECIFICATIONS CONTAINS CONFIDENTIAL TRADE SECRET AND OTHER PROPRIETARY INFORMATION OF DELL INC. ("DELL") THIS DOCUMENT MAY NOT BE TRANSFERRED OR COPIED WITHOUT THE EXPRESS WRITTEN AUTHORIZATION OF DELL. IN ADDITION, NEITHER THIS SHEET NOR THE INFORMATION IT CONTAINS WAY BE USED BY OR DISCLOSED TO ANY THIRD PARTY WITHOUT DELL'S EXPRESS WRITTEN CONSENT.

Compal Electronics, Inc.			
Power Rail			
Size	Document Number	Rev	
	LA-D801P	A00	
Date:	Tuesday, June 21, 2016	Sheet	4 of 61



PROPRIETARY NOTE: THIS SHEET OF ENGINEERING DRAWING AND SPECIFICATIONS CONTAINS CONFIDENTIAL TRADE SECRET AND OTHER PROPRIETARY INFORMATION OF DELL INC. ("DELL") THIS DOCUMENT MAY NOT BE TRANSFERRED OR COPIED WITHOUT THE EXPRESS WRITTEN AUTHORIZATION OF DELL. IN ADDITION, NEITHER THIS SHEET NOR THE INFORMATION IT CONTAINS WAY BE USED BY OR DISCLOSED TO ANY THIRD PARTY WITHOUT DELL'S EXPRESS WRITTEN CONSENT.



DELL CONFIDENTIAL/PROPRIETARY

Compal Electronics, Inc.

SMBus Block diagram

LA-D801P

Size

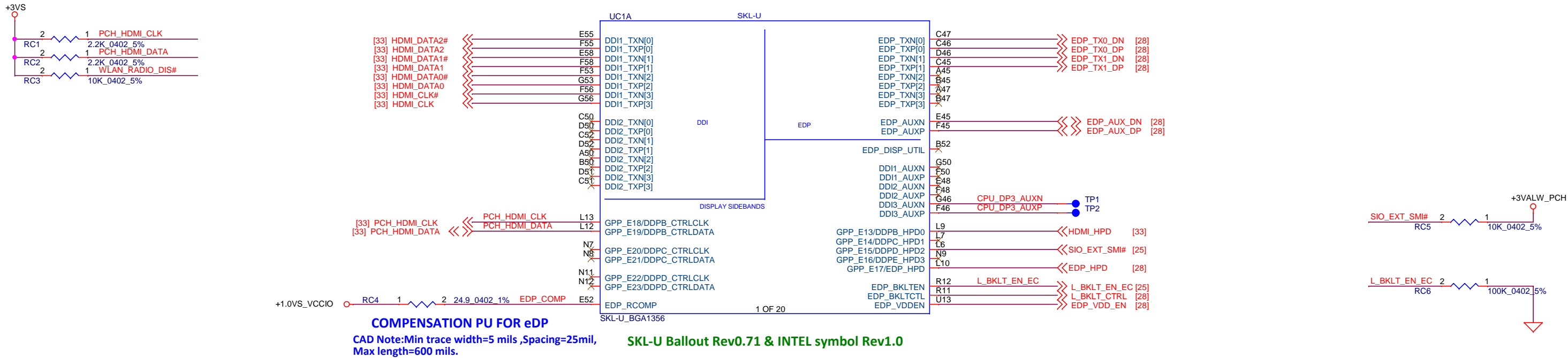
Document Number

Rev

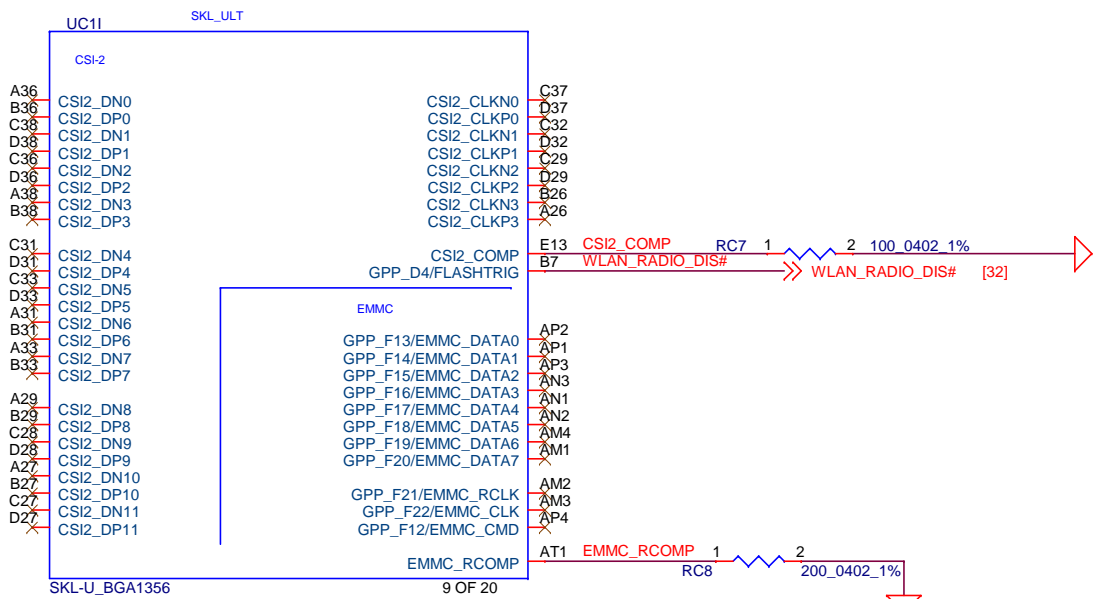
A00

Date: Tuesday, June 21, 2016

Sheet 5 of 61



SKL-U Ballout Rev0.71 & INTEL symbol Rev1.0



DELL CONFIDENTIAL/PROPRIETARY

Compal Electronics, Inc.

Title MCP(1/14)DDI,EDP,CSI2,EMMC

Size Document Number LA-D801P

Date: Tuesday, June 21, 2016 Sheet 6 of 61

PROPRIETARY NOTE: THIS SHEET OF ENGINEERING DRAWING AND SPECIFICATIONS CONTAINS CONFIDENTIAL TRADE SECRET AND OTHER PROPRIETARY INFORMATION OF DELL INC. ("DELL") THIS DOCUMENT MAY NOT BE TRANSFERRED OR COPIED WITHOUT THE EXPRESS WRITTEN AUTHORIZATION OF DELL. IN ADDITION, NEITHER THIS SHEET NOR THE INFORMATION IT CONTAINS WAY BE USED BY OR DISCLOSED TO ANY THIRD PARTY WITHOUT DELL'S EXPRESS WRITTEN CONSENT.

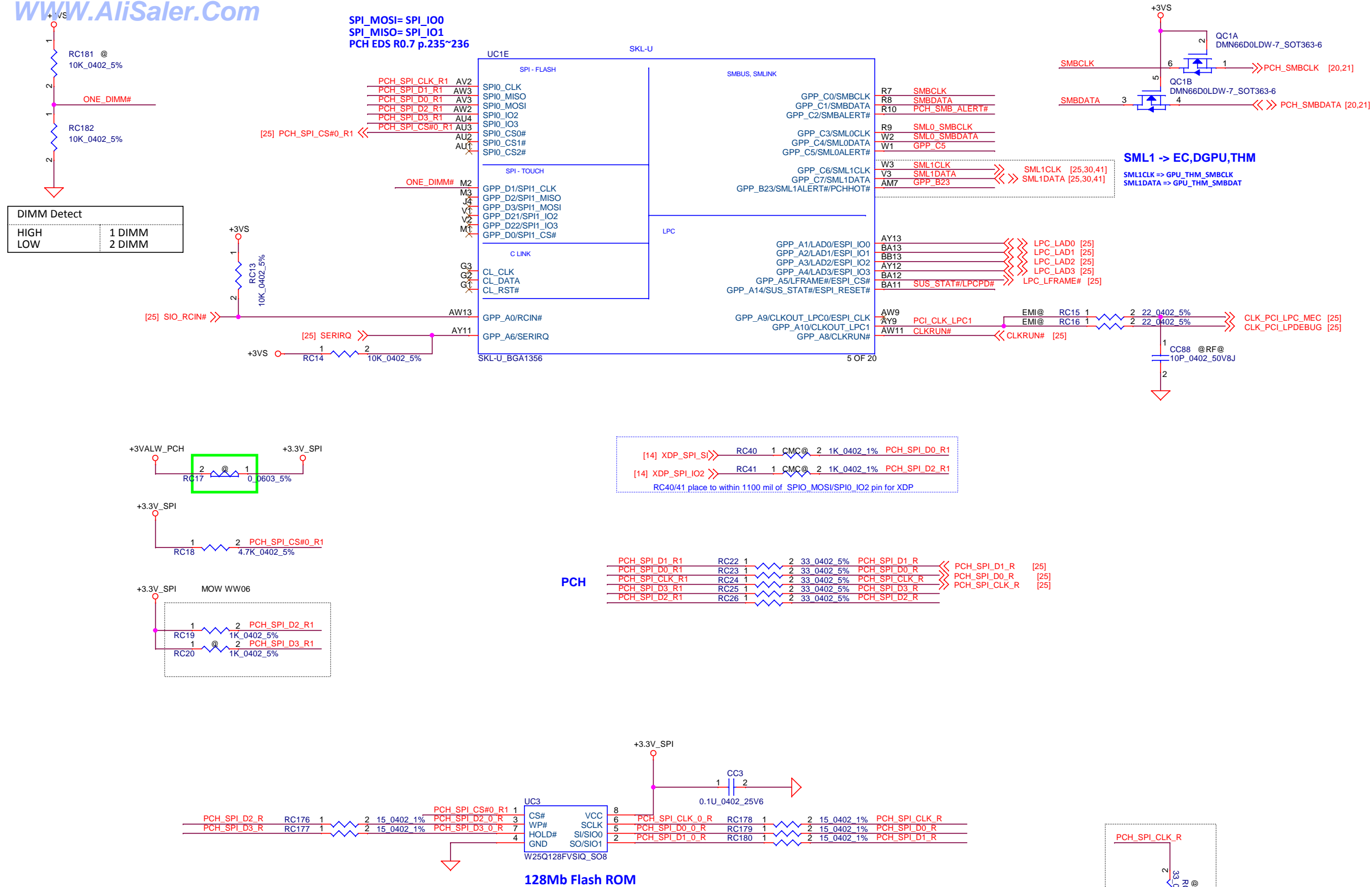
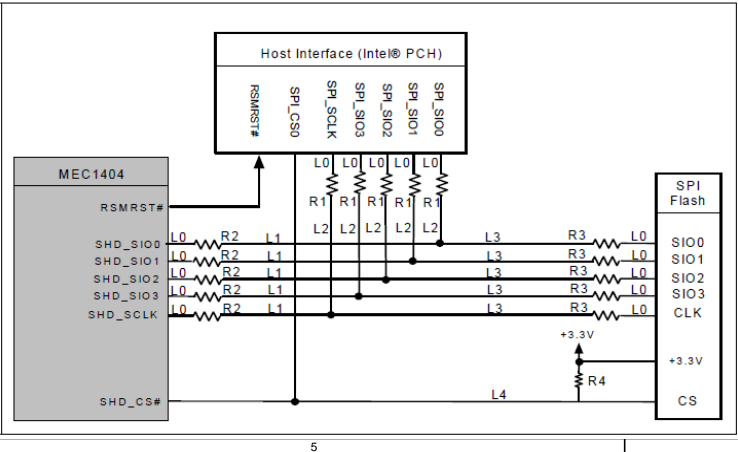
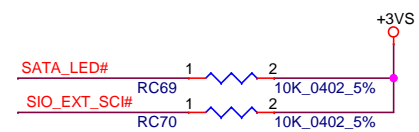
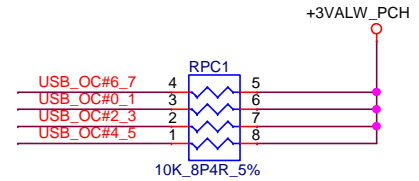
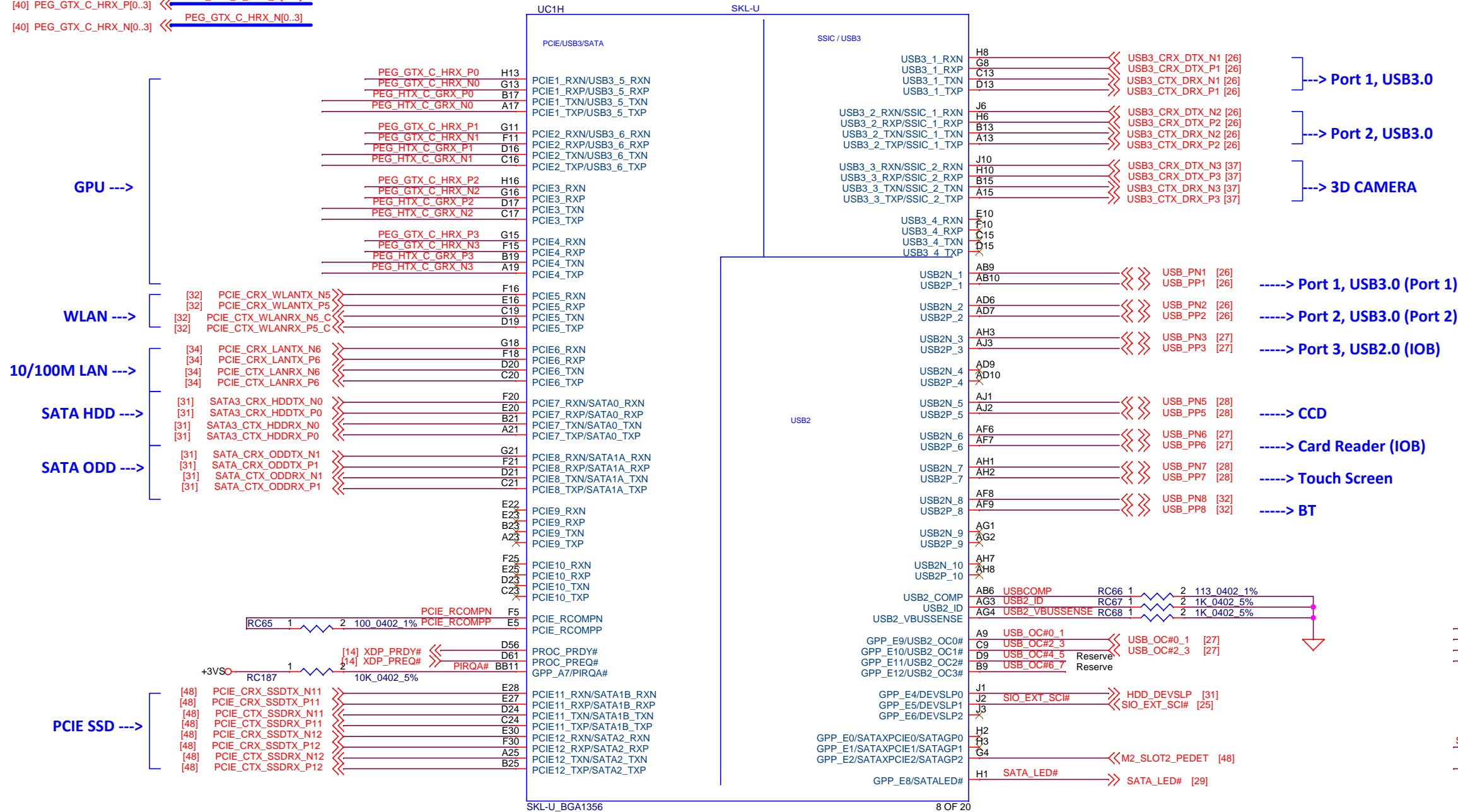


FIGURE 2-4: MEC1404 TOPOLOGY FOR SHARED SPI FLASH DEVICE



PROPRIETARY NOTE: THIS SHEET OF ENGINEERING DRAWING AND SPECIFICATIONS CONTAINS CONFIDENTIAL TRADE SECRET AND OTHER PROPRIETARY INFORMATION OF DELL INC. ("DELL") THIS DOCUMENT MAY NOT BE TRANSFERRED OR COPIED WITHOUT THE EXPRESS WRITTEN AUTHORIZATION OF DELL. IN ADDITION, NEITHER THIS SHEET NOR THE INFORMATION IT CONTAINS WAY BE USED BY OR DISCLOSED TO ANY THIRD PARTY WITHOUT DELL'S EXPRESS WRITTEN CONSENT.

[40] PEG_HTX_C_GRX_P[0..3] >> PEG_HTX_C_GRX_P[0..3]
[40] PEG_HTX_C_GRX_N[0..3] >> PEG_HTX_C_GRX_N[0..3]
[40] PEG_GTX_C_HRX_P[0..3] << PEG_GTX_C_HRX_P[0..3]
[40] PEG_GTX_C_HRX_N[0..3] << PEG_GTX_C_HRX_N[0..3]



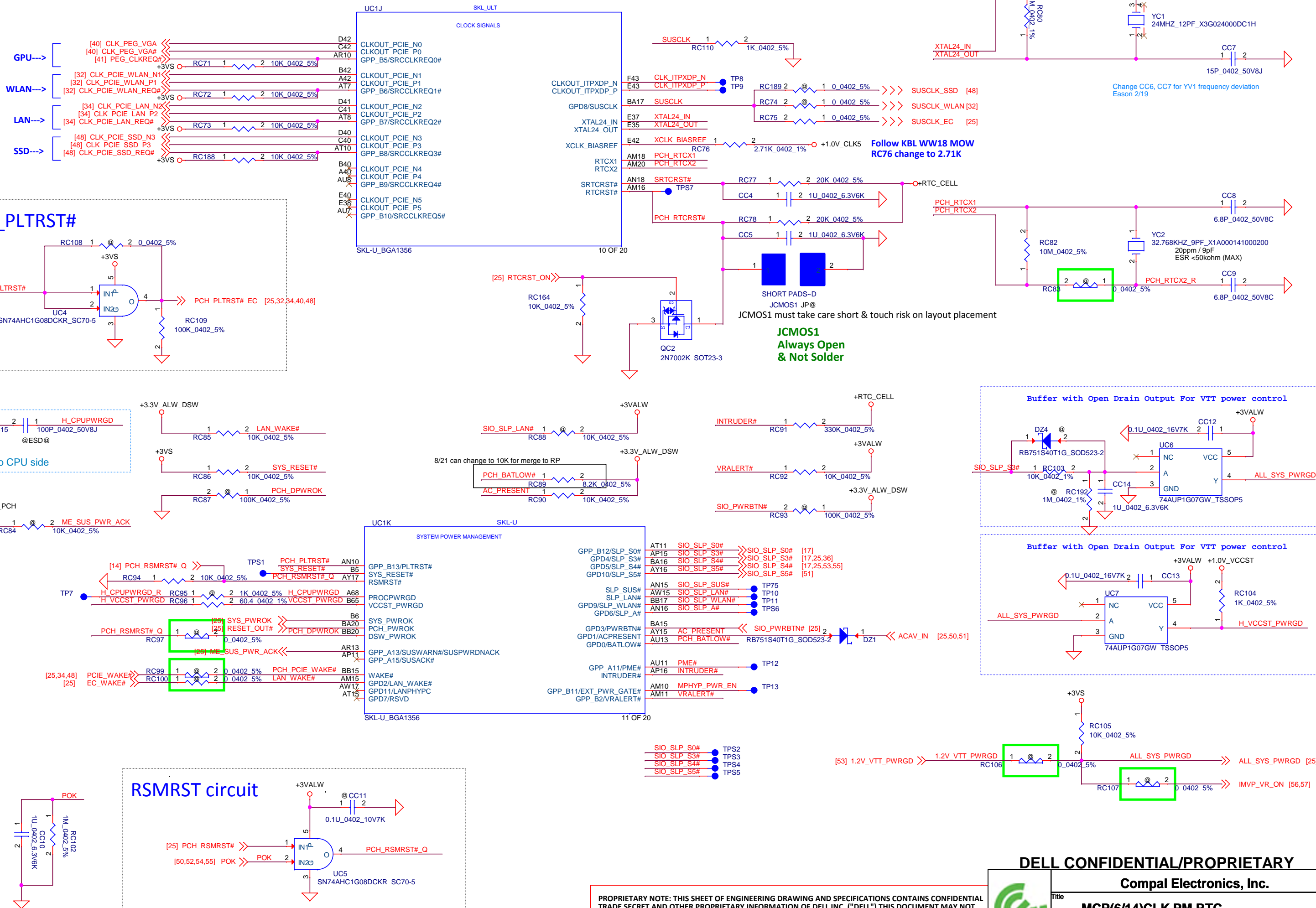
DELL CONFIDENTIAL/PROPRIETARY

Compal Electronics, Inc.



Title			MCP(5/14)PCIE,USB,SATA	
Size	Document Number		LA-D801P	
Date:	Tuesday, June 21, 2016		Sheet	10 of 61

PROPRIETARY NOTE: THIS SHEET OF ENGINEERING DRAWING AND SPECIFICATIONS CONTAINS CONFIDENTIAL TRADE SECRET AND OTHER PROPRIETARY INFORMATION OF DELL INC. ("DELL") THIS DOCUMENT MAY NOT BE TRANSFERRED OR COPIED WITHOUT THE EXPRESS WRITTEN AUTHORIZATION OF DELL. IN ADDITION, NEITHER THIS SHEET NOR THE INFORMATION IT CONTAINS MAY BE USED BY OR DISCLOSED TO ANY THIRD PARTY WITHOUT DELL'S EXPRESS WRITTEN CONSENT.

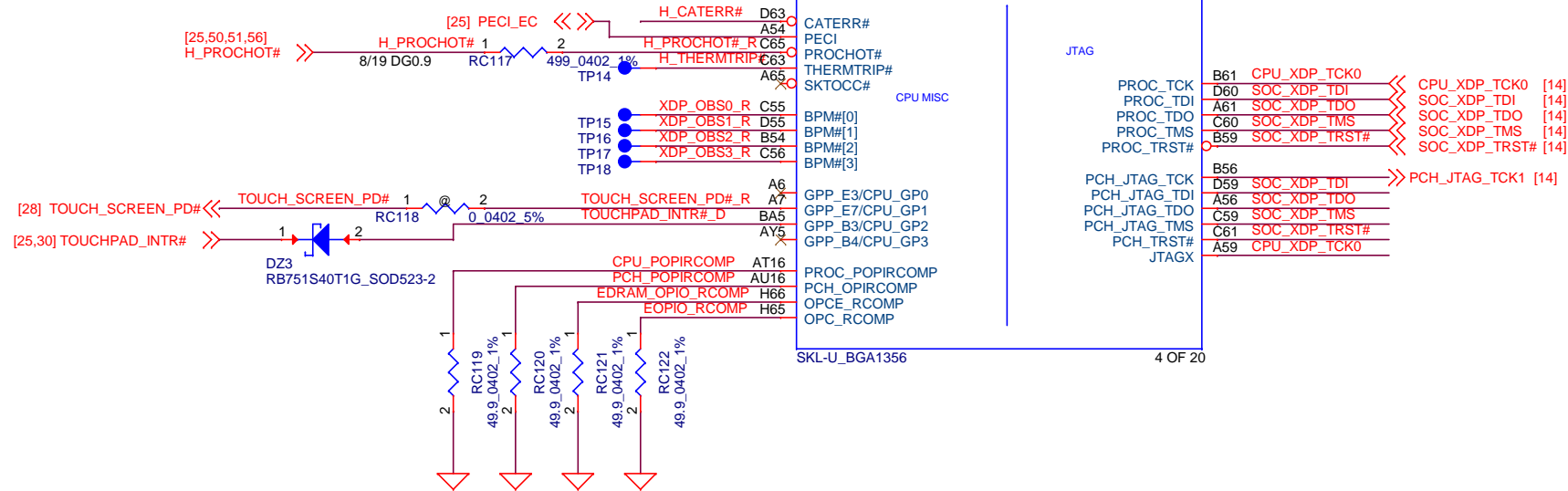
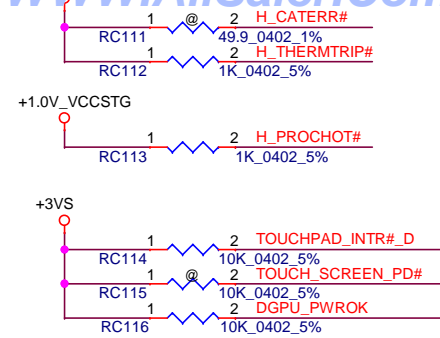


DELL CONFIDENTIAL/PROPRIETARY

Compal Electronics, Inc.

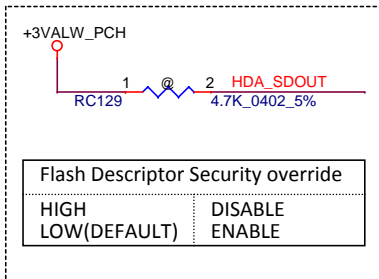
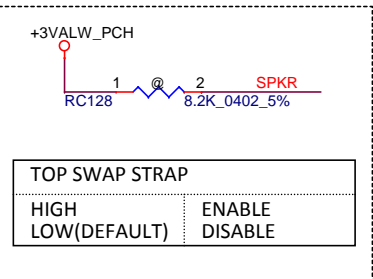
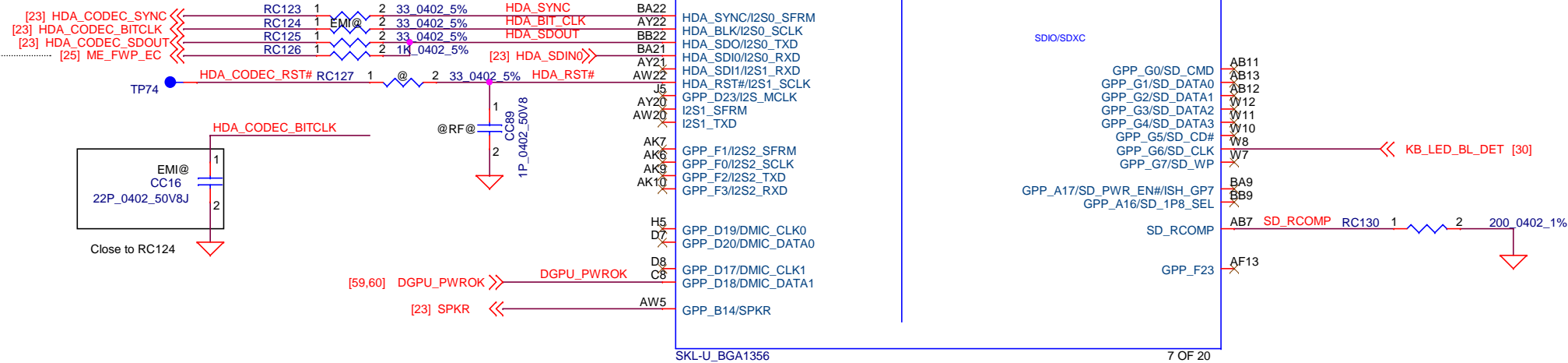


Title	MCP(6/14)CLK,PM,RTC		
Size	Document Number	LA-D801P	
Date	Tuesday, June 21, 2016	Sheet	11 of 61



ME_FWP_EC

- LOW = ENABLE -->ME lock, can't update ME
- HIGH = DISABLE -->ME un-lock, can update ME



PROPRIETARY NOTE: THIS SHEET OF ENGINEERING DRAWING AND SPECIFICATIONS CONTAINS CONFIDENTIAL TRADE SECRET AND OTHER PROPRIETARY INFORMATION OF DELL INC. ("DELL") THIS DOCUMENT MAY NOT BE TRANSFERRED OR COPIED WITHOUT THE EXPRESS WRITTEN AUTHORIZATION OF DELL. IN ADDITION, NEITHER THIS SHEET NOR THE INFORMATION IT CONTAINS WAY BE USED BY OR DISCLOSED TO ANY THIRD PARTY WITHOUT DELL'S EXPRESS WRITTEN CONSENT.

DELL CONFIDENTIAL/PROPRIETARY

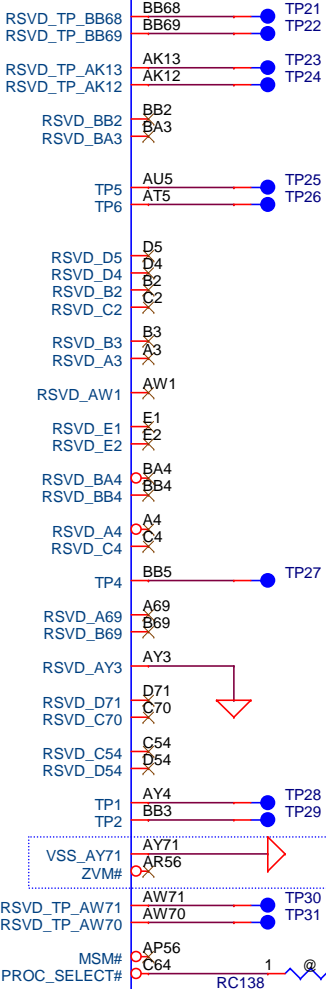
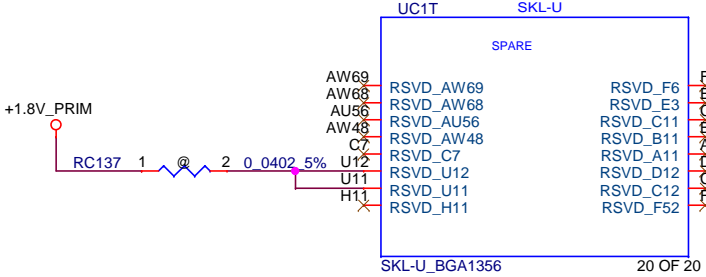
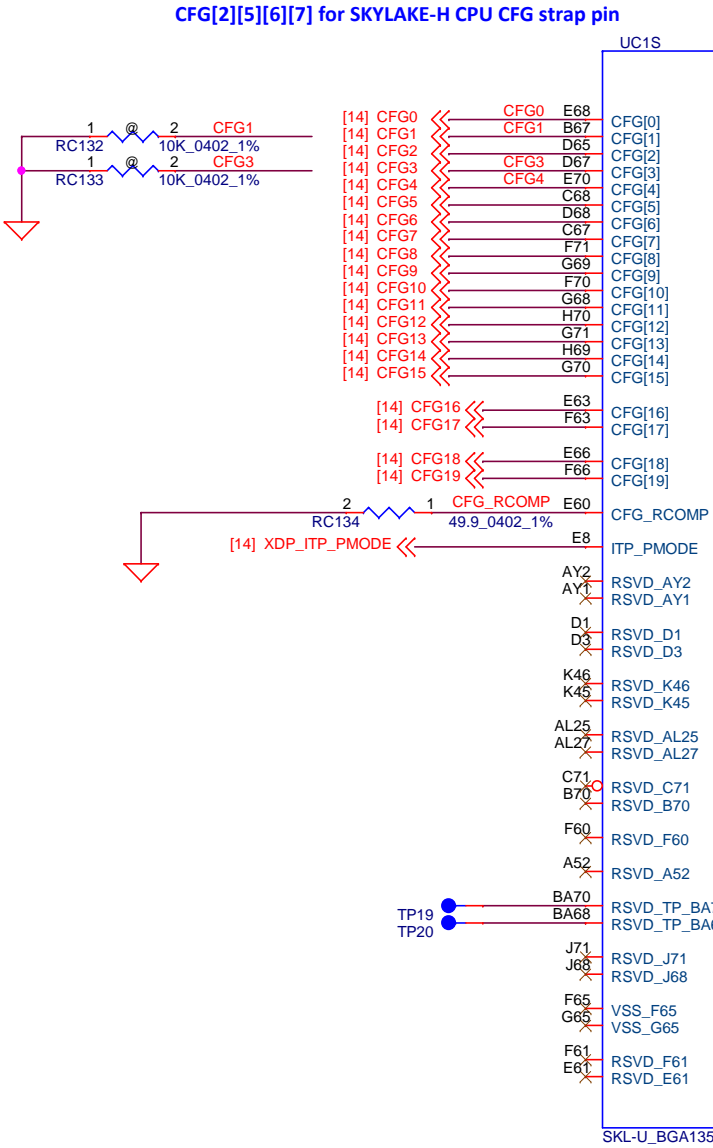
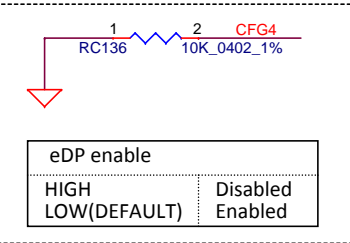
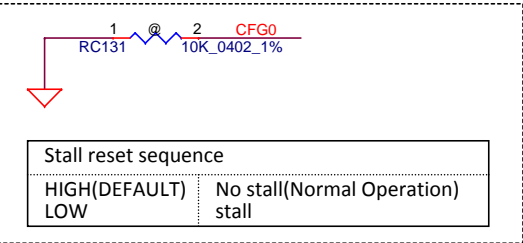
Compal Electronics, Inc.

Title MCP(7/14)MISC,JTAG,HDA,SDIO

Size Document Number LA-D801P

Date: Tuesday, June 21, 2016 Sheet 12 of 61

Rev A00



From WW48 MOW

Stuff 100k(RC138) for Cannonlake

Un-stuff 100k(RC138) for Skylake

P.AR56 ZVM# for SKYLAKE-U 2+3e only

DELL CONFIDENTIAL/PROPRIETARY

Compal Electronics, Inc.

MCP(8/14)CFG,RSVD

LA-D801P

Tuesday, June 21, 2016 Sheet 13 of 61

PROPRIETARY NOTE: THIS SHEET OF ENGINEERING DRAWING AND SPECIFICATIONS CONTAINS CONFIDENTIAL TRADE SECRET AND OTHER PROPRIETARY INFORMATION OF DELL INC. ("DELL") THIS DOCUMENT MAY NOT BE TRANSFERRED OR COPIED WITHOUT THE EXPRESS WRITTEN AUTHORIZATION OF DELL. IN ADDITION, NEITHER THIS SHEET NOR THE INFORMATION IT CONTAINS MAY BE USED BY OR DISCLOSED TO ANY THIRD PARTY WITHOUT DELL'S EXPRESS WRITTEN CONSENT.

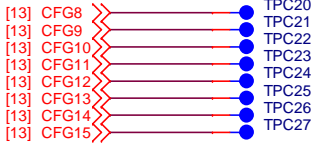
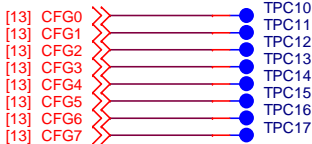
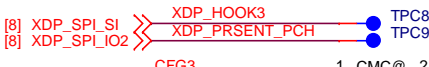
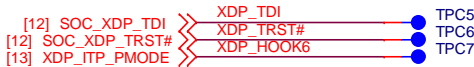
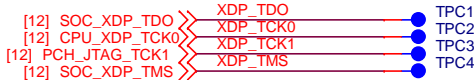
Connector Less Routing Topology

DCI Link
RC142 need POP
RC146 need POP

Place to CPU side

Place to CPU side

PRIMARY CMC CONN



DELL CONFIDENTIAL/PROPRIETARY

Compal Electronics, Inc.

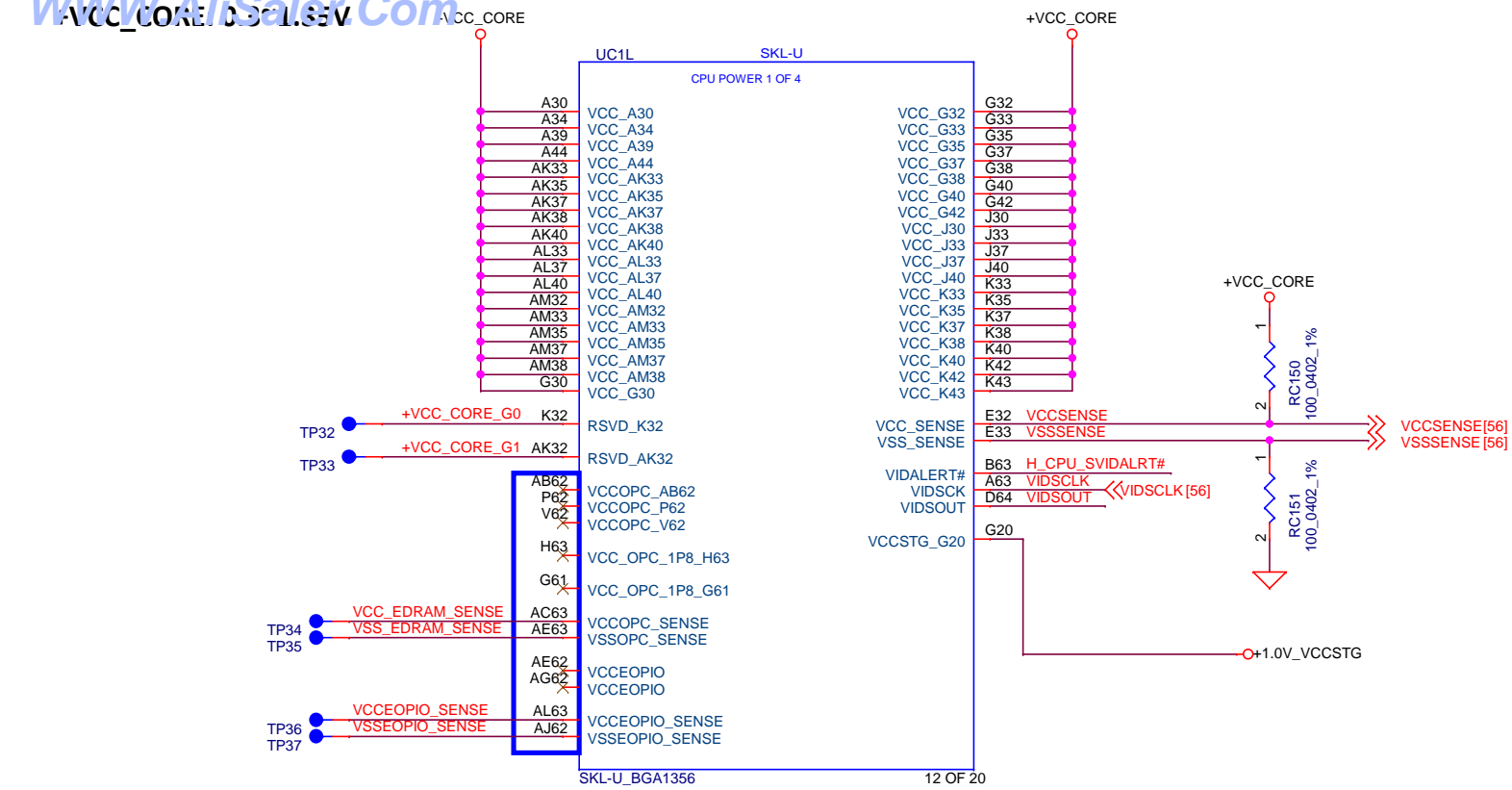


Title
MCP(9/14)XDP

Size Document Number
LA-D801P

Date: Tuesday, June 21, 2016 Sheet 14 of 61

PROPRIETARY NOTE: THIS SHEET OF ENGINEERING DRAWING AND SPECIFICATIONS CONTAINS CONFIDENTIAL TRADE SECRET AND OTHER PROPRIETARY INFORMATION OF DELL INC. ("DELL") THIS DOCUMENT MAY NOT BE TRANSFERRED OR COPIED WITHOUT THE EXPRESS WRITTEN AUTHORIZATION OF DELL. IN ADDITION, NEITHER THIS SHEET NOR THE INFORMATION IT CONTAINS WAY BE USED BY OR DISCLOSED TO ANY THIRD PARTY WITHOUT DELL'S EXPRESS WRITTEN CONSENT.

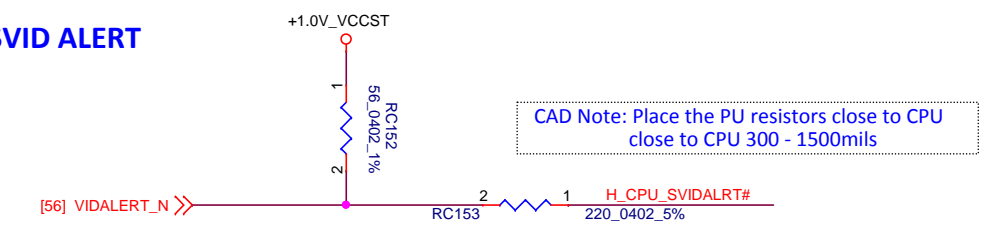


VCCOPC,VCCOPC_1P8,VCCEOPIO for SKYLAKE-U 2+3e (w/ on package cache)

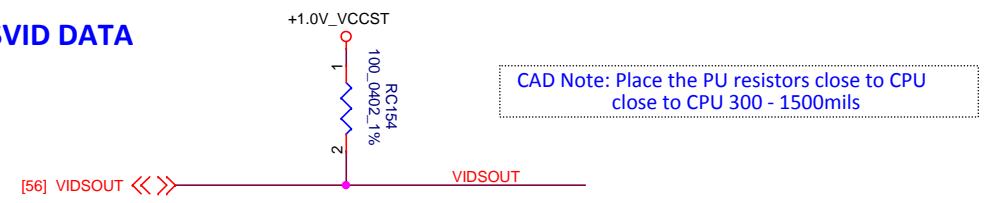
PSC(Primary side cap) : Place as close to the package as possible
BSC(Backside cap) : Place on secondary side, underneath the package

Component placement order:
Package edge > 0402 caps > 0805 caps > Bulk caps > Power source

SVID ALERT



SVID DATA



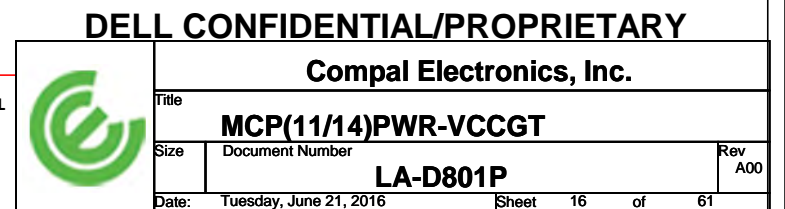
DELL CONFIDENTIAL/PROPRIETARY

Compal Electronics, Inc.

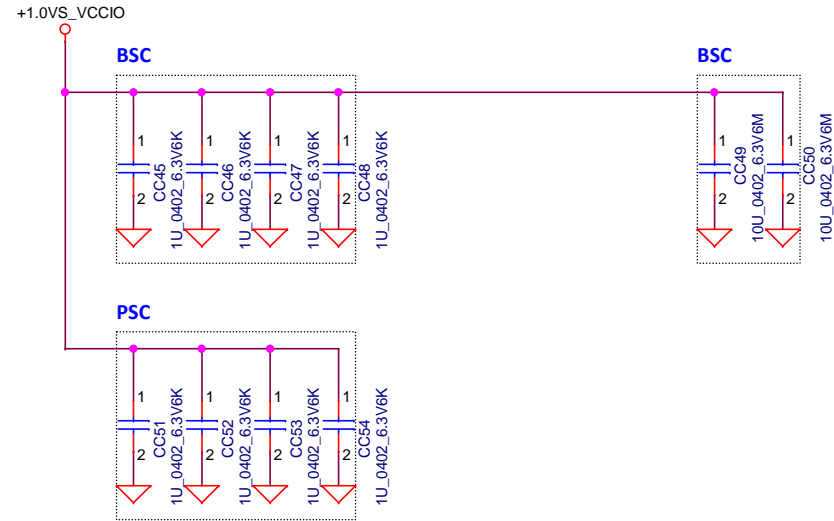


Title			MCP(10/14)PWR-VCC CORE		
Size	Document Number		LA-D801P		Rev A00
Date:	Tuesday, June 21, 2016		Sheet	15	of 61

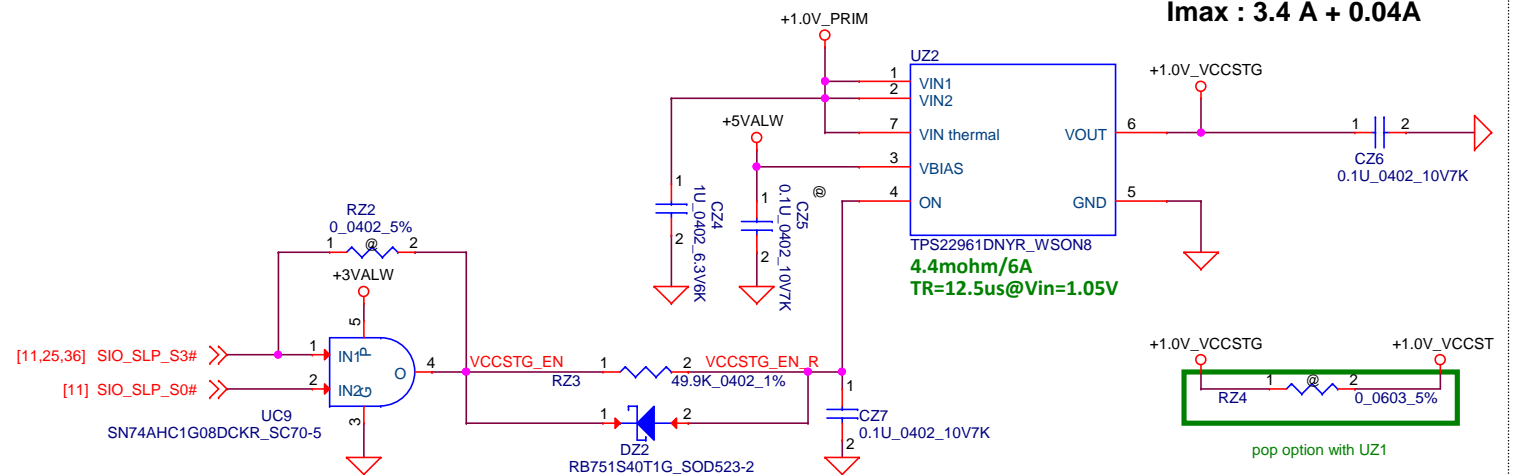
PROPRIETARY NOTE: THIS SHEET OF ENGINEERING DRAWING AND SPECIFICATIONS CONTAINS CONFIDENTIAL TRADE SECRET AND OTHER PROPRIETARY INFORMATION OF DELL INC. ("DELL") THIS DOCUMENT MAY NOT BE TRANSFERRED OR COPIED WITHOUT THE EXPRESS WRITTEN AUTHORIZATION OF DELL. IN ADDITION, NEITHER THIS SHEET NOR THE INFORMATION IT CONTAINS WAY BE USED BY OR DISCLOSED TO ANY THIRD PARTY WITHOUT DELL'S EXPRESS WRITTEN CONSENT.



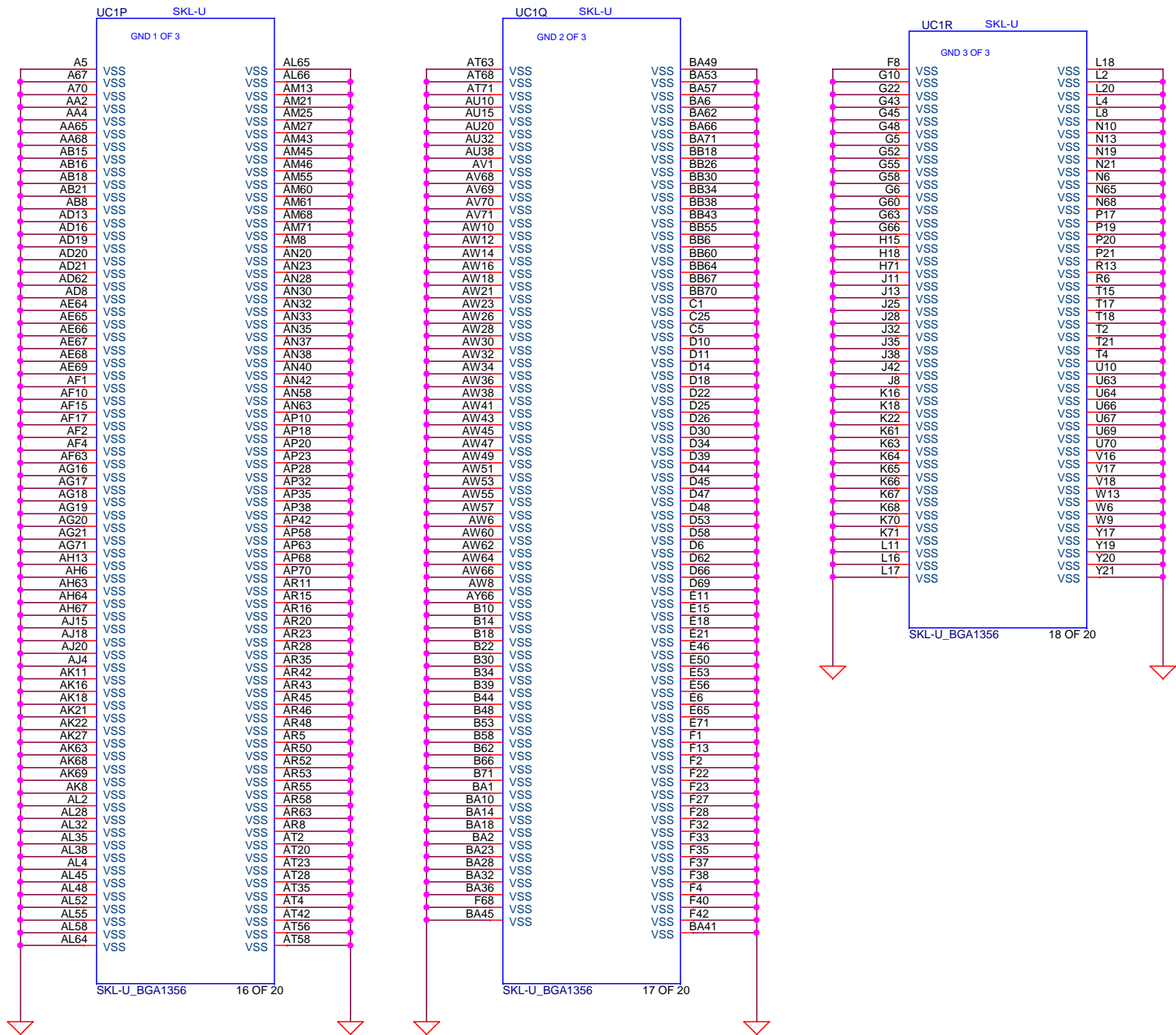
PROPRIETARY NOTE: THIS SHEET OF ENGINEERING DRAWING AND SPECIFICATIONS CONTAINS CONFIDENTIAL TRADE SECRET AND OTHER PROPRIETARY INFORMATION OF DELL INC. ("DELL") THIS DOCUMENT MAY NOT BE TRANSFERRED OR COPIED WITHOUT THE EXPRESS WRITTEN AUTHORIZATION OF DELL. IN ADDITION, NEITHER THIS SHEET NOR THE INFORMATION IT CONTAINS MAY BE USED BY OR DISCLOSED TO ANY THIRD PARTY WITHOUT DELL'S EXPRESS WRITTEN CONSENT.



+1.0V_VCCSTG source



PROPRIETARY NOTE: THIS SHEET OF ENGINEERING DRAWING AND SPECIFICATIONS CONTAINS CONFIDENTIAL TRADE SECRET AND OTHER PROPRIETARY INFORMATION OF DELL INC. ("DELL") THIS DOCUMENT MAY NOT BE TRANSFERRED OR COPIED WITHOUT THE EXPRESS WRITTEN AUTHORIZATION OF DELL. IN ADDITION, NEITHER THIS SHEET NOR THE INFORMATION IT CONTAINS MAY BE USED BY OR DISCLOSED TO ANY THIRD PARTY WITHOUT DELL'S EXPRESS WRITTEN CONSENT.



For Pre-ES Parts: Disconnect PCH CORE_VID[1:0] to the VR and fix PCH VCCPRIM_CORE voltage at 1.00 V.

- R1: not populated
- R2, R3: populated to set VCCPRIM_CORE to 1.00V. Consult with VR vendor for appropriate values.
- R4, R5 (feedback resistor): populated if needed. Some VRs only support up to 0.95V natively with VID options. 1.00 V should be created by selecting 0.95V option and using feedback resistors to shift voltage up 50 mV. Consult with VR vendor for appropriate values for proper VR operation while minimizing power consumption

For ES and Later Parts: Connect PCH CORE_VID[1:0] to the VR.

- R1: populated
- R2, R3: not populated
- R4, R5 (feedback resistors): populated if needed to obtain appropriate voltage per the updated PCH VID encoding table above. Consult with VR vendor for appropriate values

For VRs that only support up to 0.95V natively with VID options, using R4 and R5 to shift the voltage table up 50mV will result in the LPM voltage output being shifted up slightly. If the VR supports LPM voltage, the specified, lowest supportable voltage is 0.70V for optimized power consumption. With R4, R5 configured to shift from 0.95V to 1.00V, the LPM voltage will effectively be shifted from 0.70V to ~0.75V. This will not be a functional issue for the platforms, but will slightly de-optimize power consumption. It is recommended that customers work with their VR vendors to adjust to the new voltage table.

DELL CONFIDENTIAL/PROPRIETARY

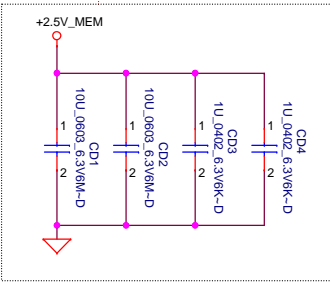
Compal Electronics, Inc.



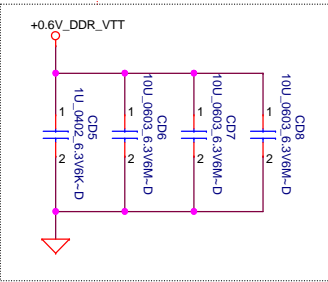
Title		
MCP(14/14)VSS		
Size	Document Number	Rev
	LA-D801P	A00
Date:	Tuesday, June 21, 2016	Sheet 19 of 61

PROPRIETARY NOTE: THIS SHEET OF ENGINEERING DRAWING AND SPECIFICATIONS CONTAINS CONFIDENTIAL TRADE SECRET AND OTHER PROPRIETARY INFORMATION OF DELL INC. ("DELL") THIS DOCUMENT MAY NOT BE TRANSFERRED OR COPIED WITHOUT THE EXPRESS WRITTEN AUTHORIZATION OF DELL. IN ADDITION, NEITHER THIS SHEET NOR THE INFORMATION IT CONTAINS MAY BE USED BY OR DISCLOSED TO ANY THIRD PARTY WITHOUT DELL'S EXPRESS WRITTEN CONSENT.

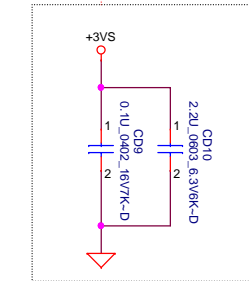
Layout Note:
Place near JDIMM1.257,259



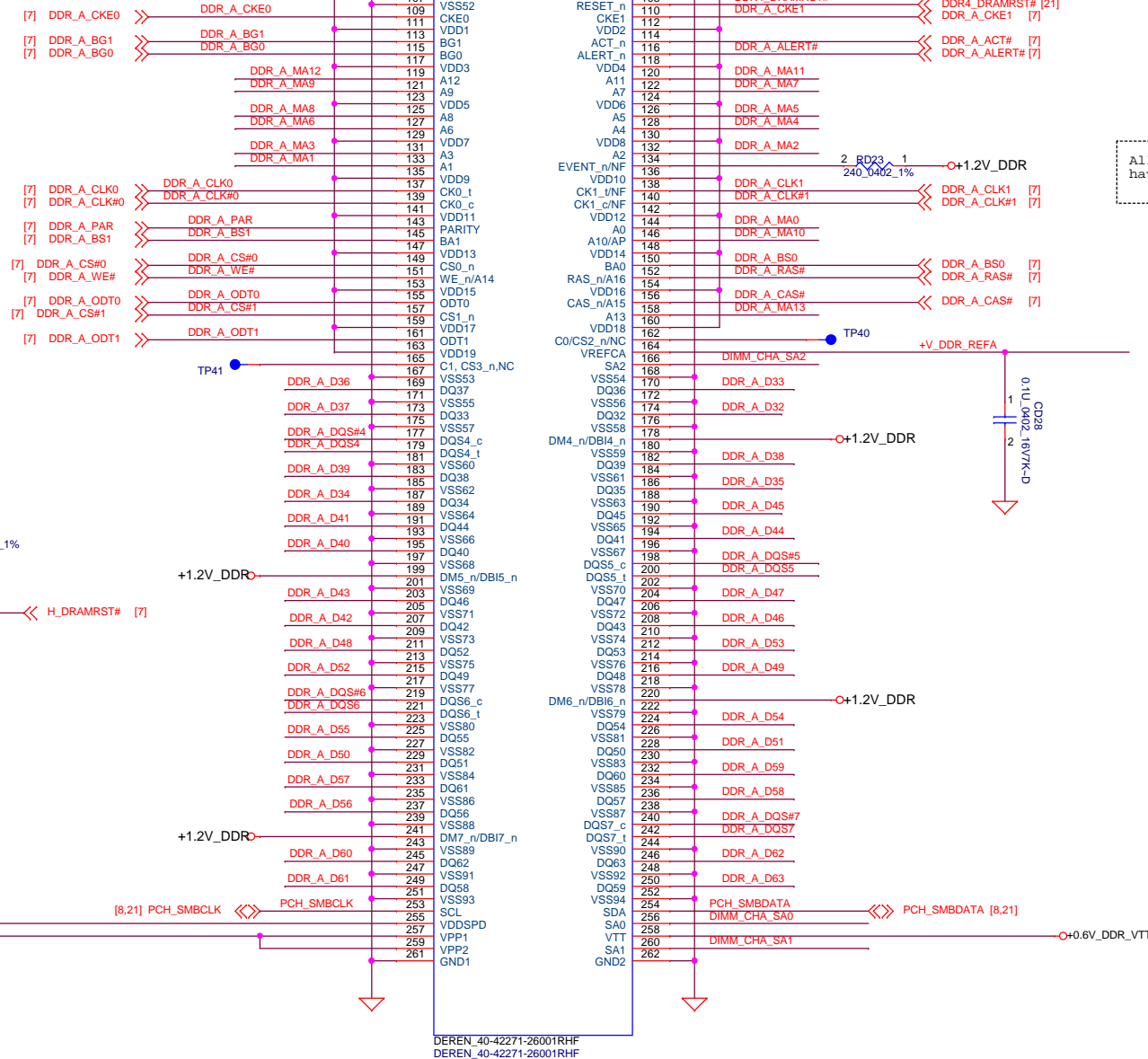
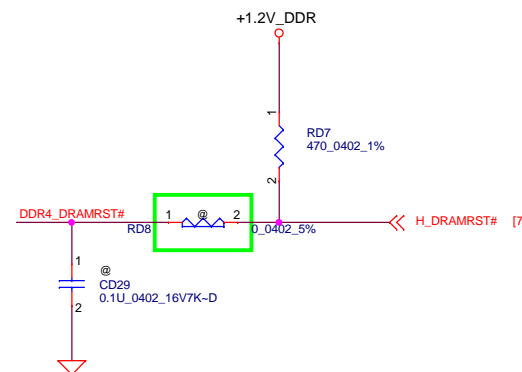
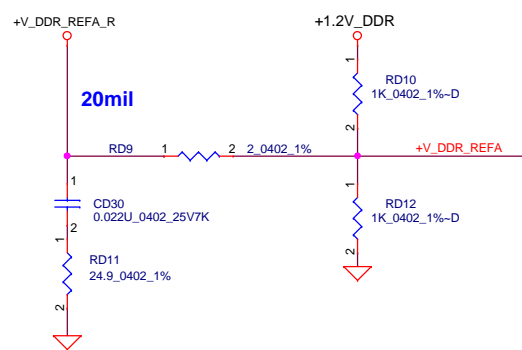
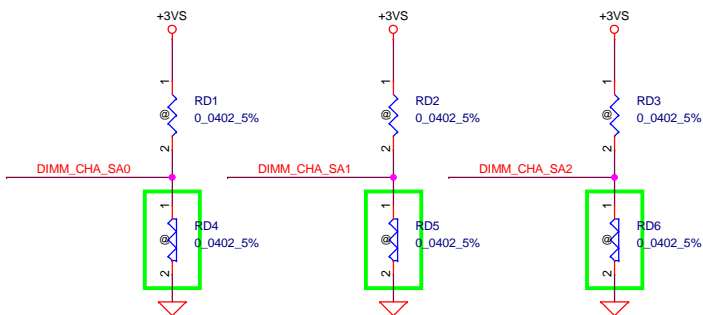
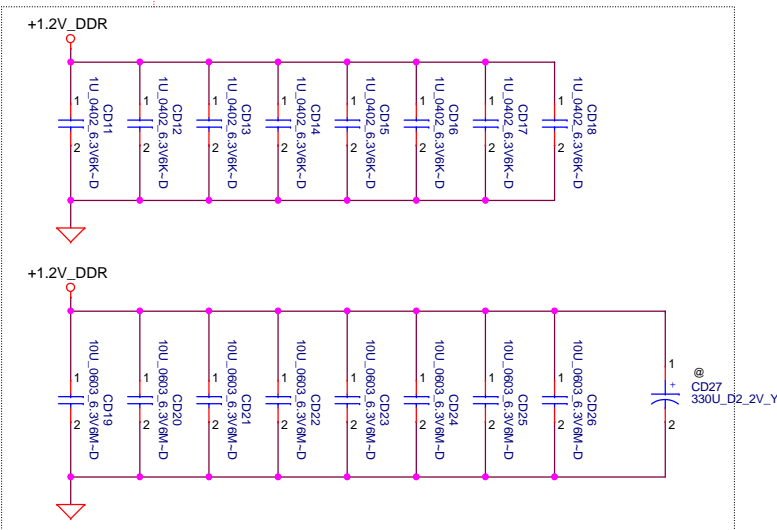
Layout Note:
Place near JDIMM1.258



Layout Note:
Place near JDIMM1.255



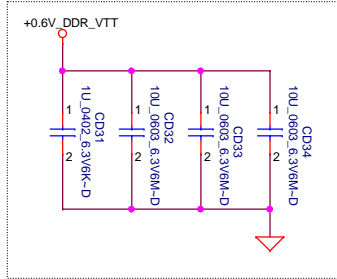
Layout Note:
Place near JDIMM1



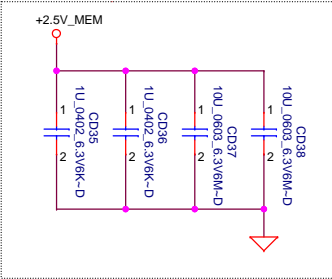
All VREF traces should have 10 mil trace width

Security Classification		Compal Secret Data		Compal Electronics, Inc.	
Issued Date	2015/01/30	Deciphered Date	2016/12/31	Title	DDR4 DIMMA RVS
THIS SHEET OF ENGINEERING DRAWING IS THE PROPRIETARY PROPERTY OF COMPAL ELECTRONICS, INC. AND CONTAINS CONFIDENTIAL AND TRADE SECRET INFORMATION. THIS SHEET MAY NOT BE TRANSFERRED FROM THE CUSTODY OF THE COMPETENT DIVISION OF R&D TO ANY OTHER DIVISION OR AUTHORIZED BY COMPAL ELECTRONICS, INC. NEITHER THIS SHEET NOR THE INFORMATION IT CONTAINS MAY BE USED OR EXPOSED TO ANY THIRD PARTY WITHOUT PRIOR WRITTEN CONSENT OF COMPAL ELECTRONICS, INC.				Document Number	Rev
				LA-D801P	A00
Date:		Tuesday, June 21, 2016		Sheet	20 of 61

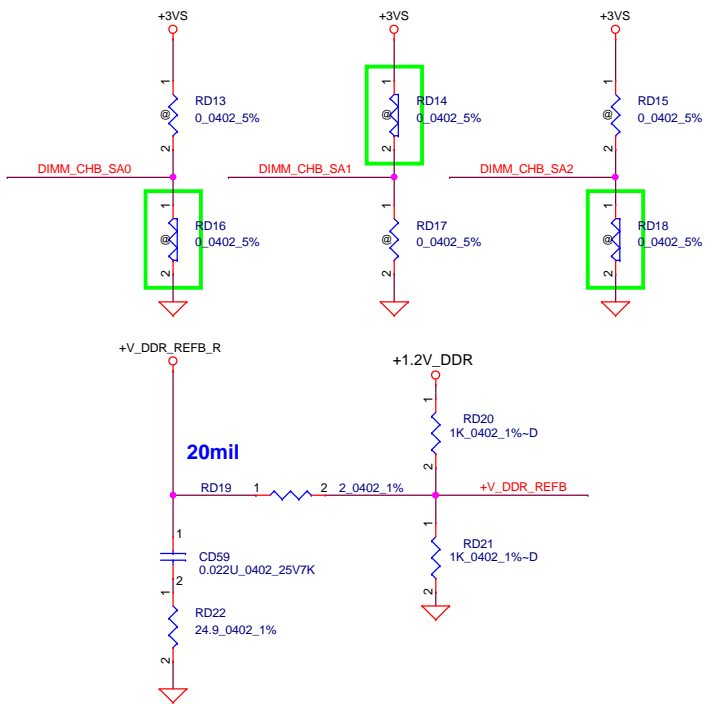
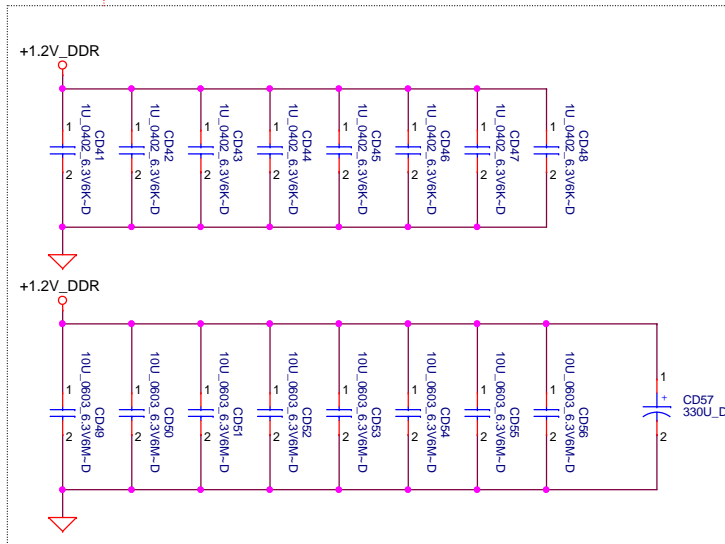
Layout Note:
Place near JDIMM2.258



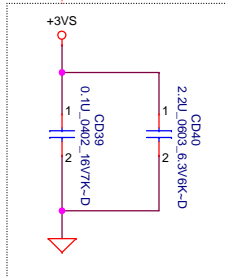
Layout Note:
Place near JDIMM2.257,259



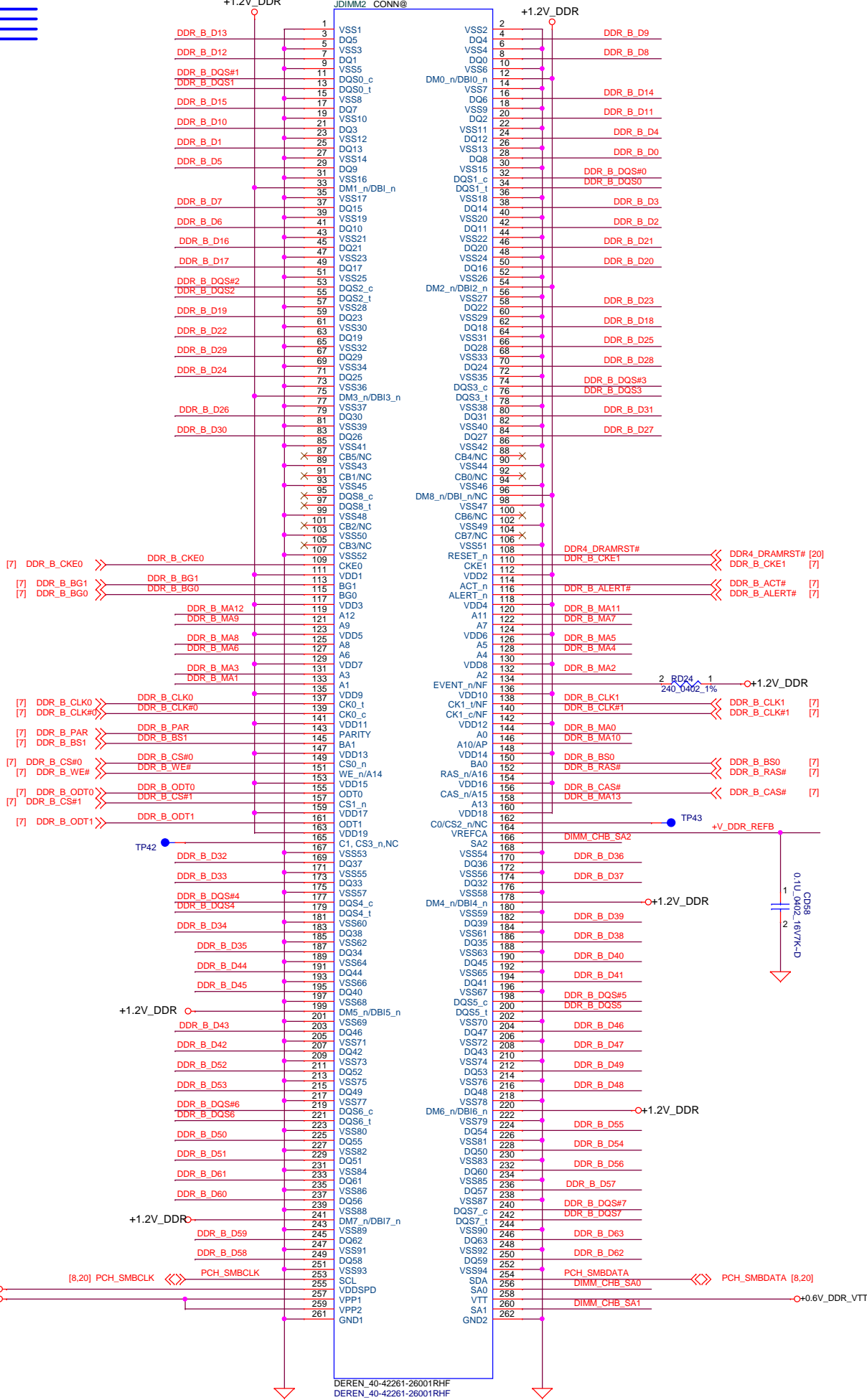
Layout Note:
Place near JDIMM2



Layout Note:
Place near JDIMM2.255



[7] DDR_B_D[0..63]
[7] DDR_B_MA[0..13]
[7] DDR_B_DQS[0..7]
[7] DDR_B_DQS[0..7]

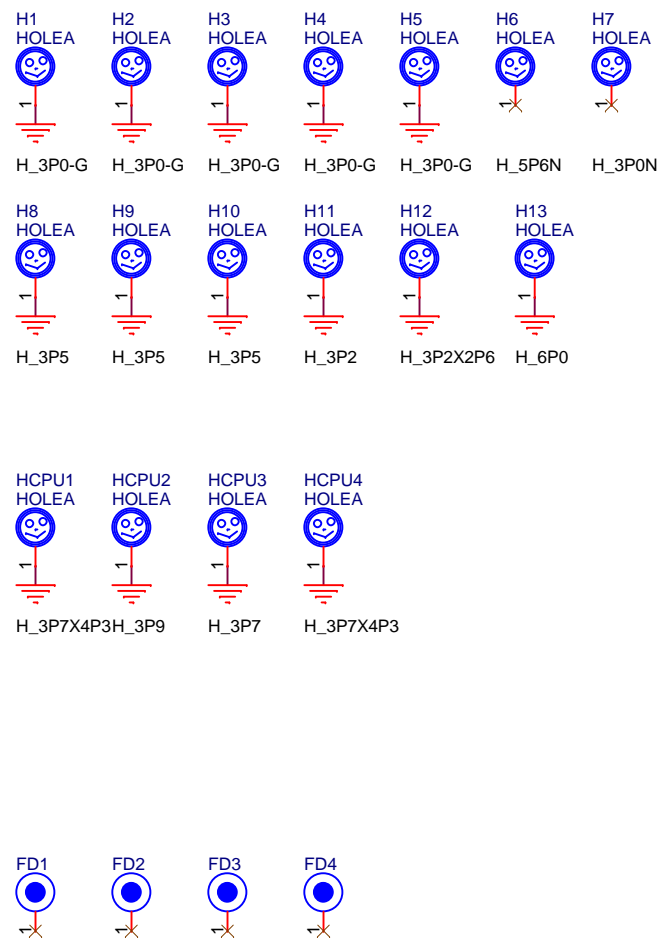


All VREF traces should
have 10 mil trace width

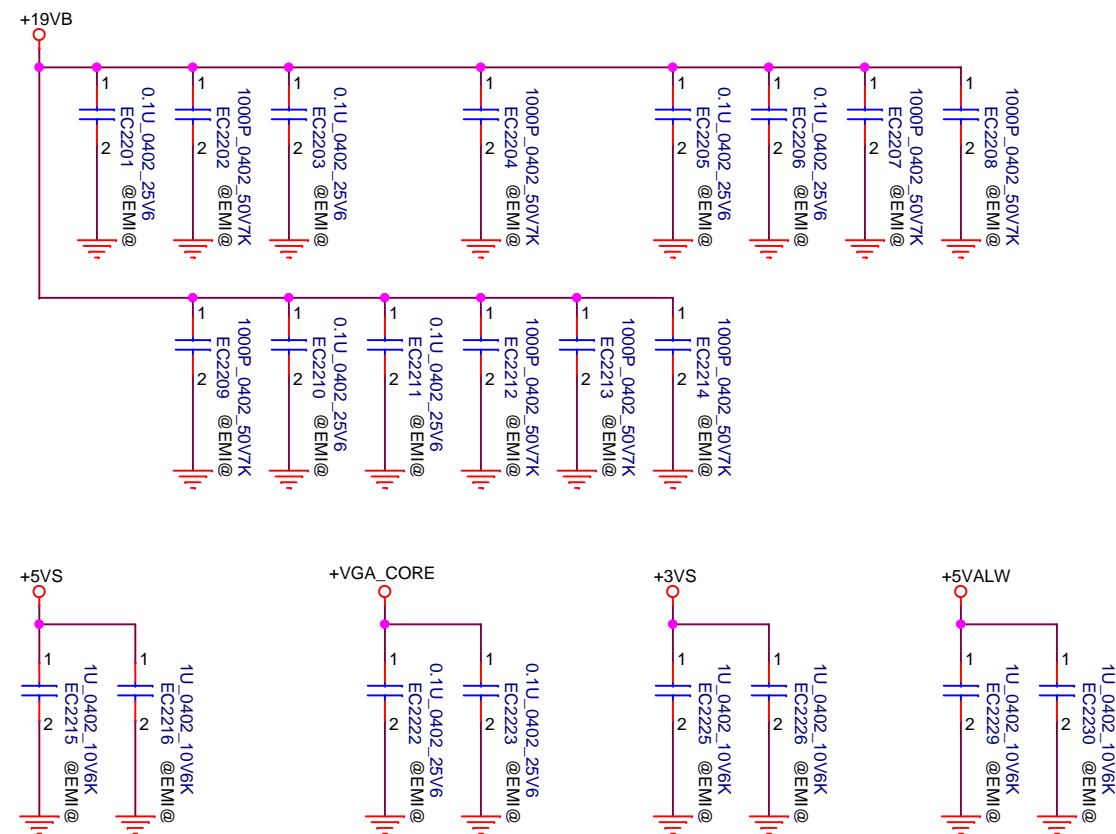
Security Classification	Compal Secret Data		Compal Electronics, Inc.	
Issued Date	2015/01/30	Deciphered Date	2016/12/31	Title
THIS SHEET OF ENGINEERING DRAWING IS THE PROPRIETARY PROPERTY OF COMPAL ELECTRONICS, INC. AND CONTAINS CONFIDENTIAL AND TRADE SECRET INFORMATION. THIS SHEET MAY NOT BE TRANSFERRED FROM THE CUSTODY OF THE COMPETENT DIVISION OF RESEARCH AND DEVELOPMENT AS AUTHORIZED BY COMPAL ELECTRONICS, INC. NEITHER THIS SHEET NOR THE INFORMATION IT CONTAINS MAY BE USED, REPRODUCED, COPIED, OR DISCLOSED TO ANY THIRD PARTY WITHOUT PRIOR WRITTEN CONSENT OF COMPAL ELECTRONICS, INC.				Document Number
WWW.AliSaler.Com				LA-D801P
Date: Tuesday, June 21, 2016				Rev A00
Sheet 21 of 61				

Main Func = Other

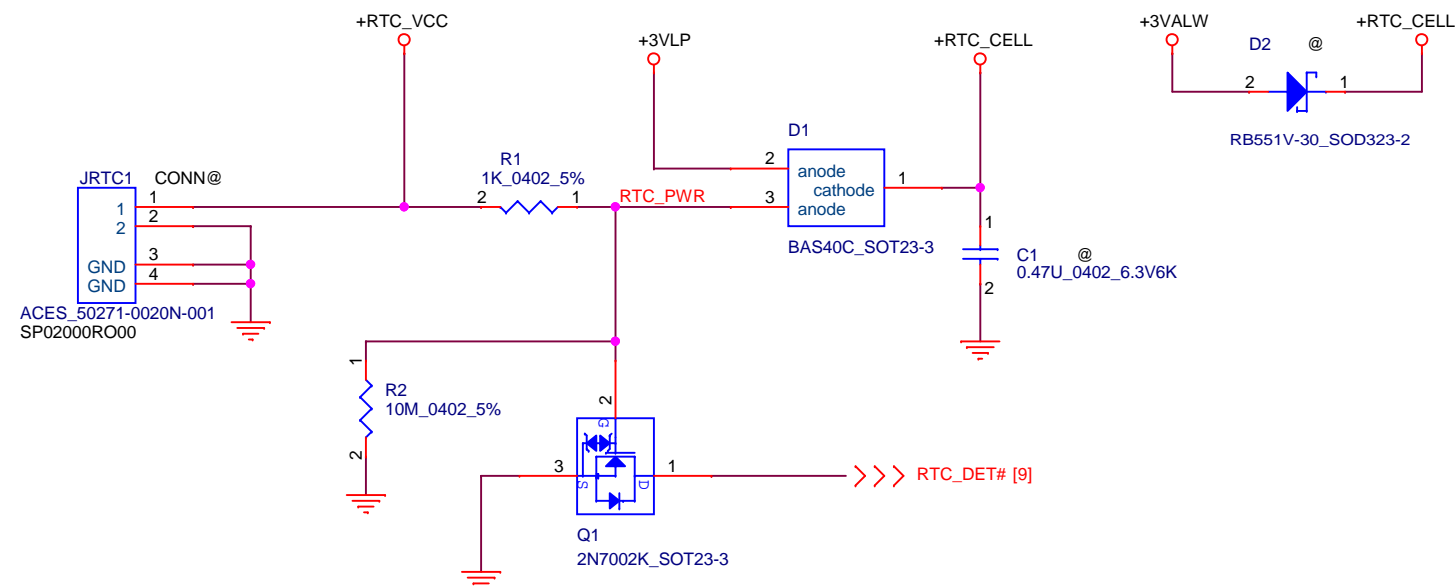
Screw hole/FD



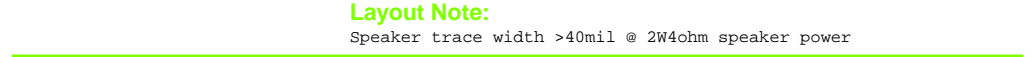
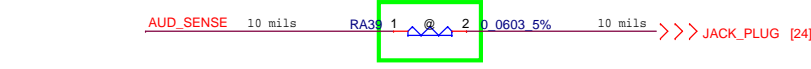
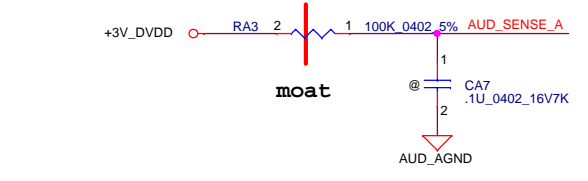
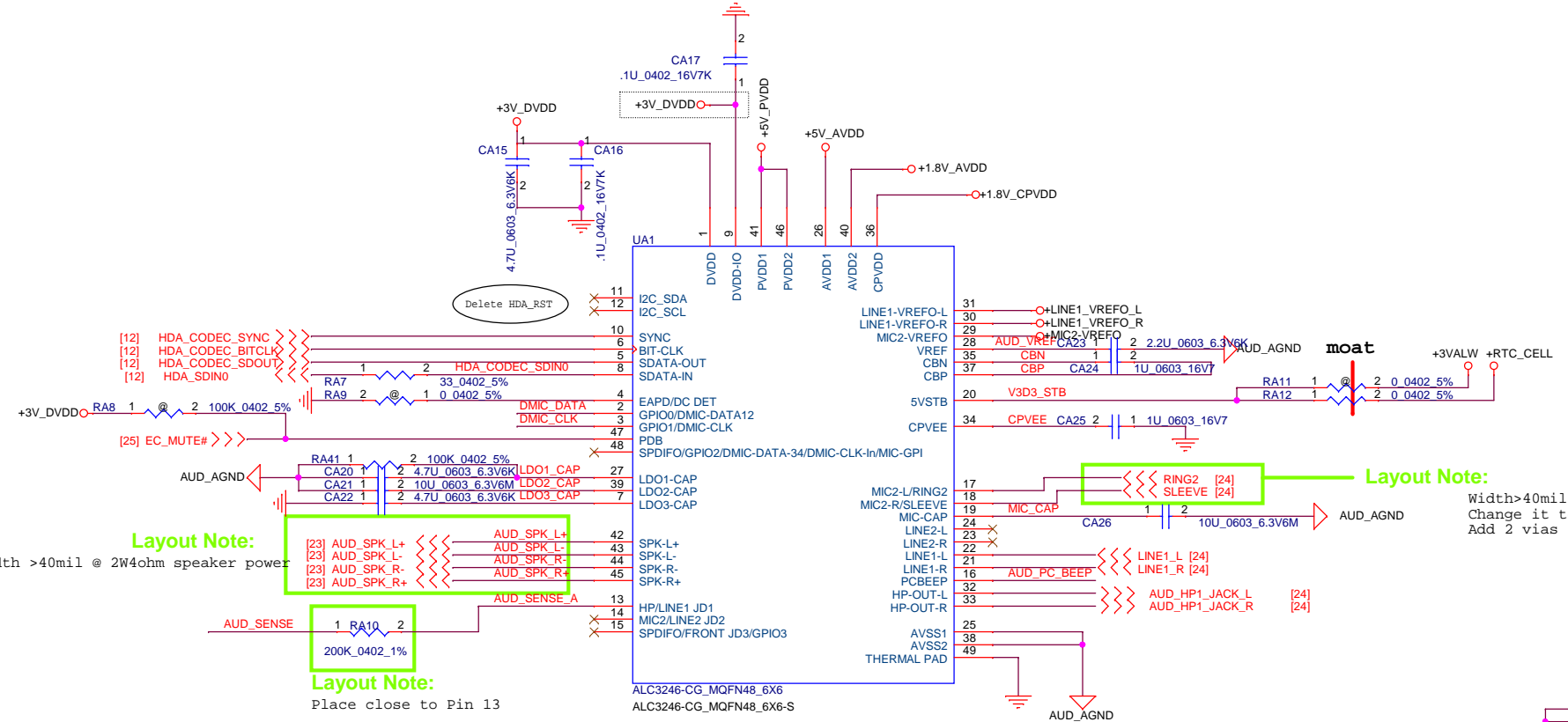
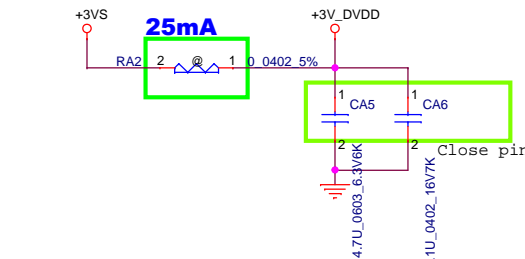
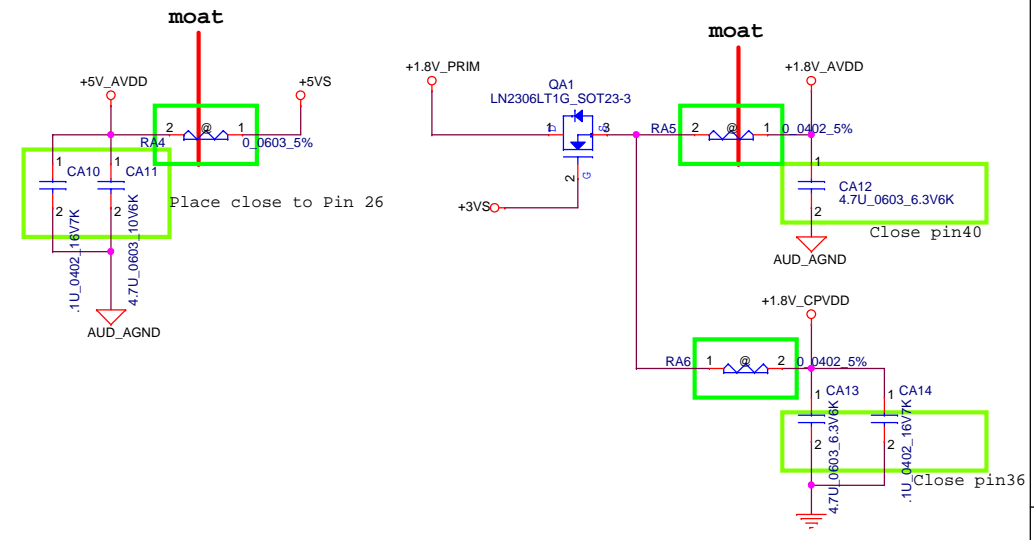
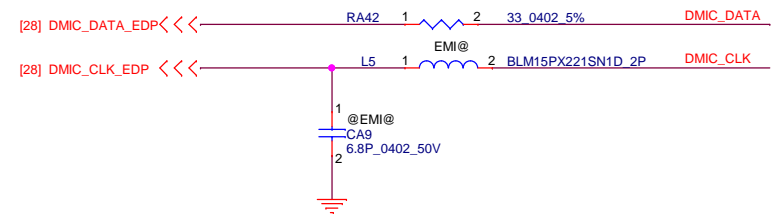
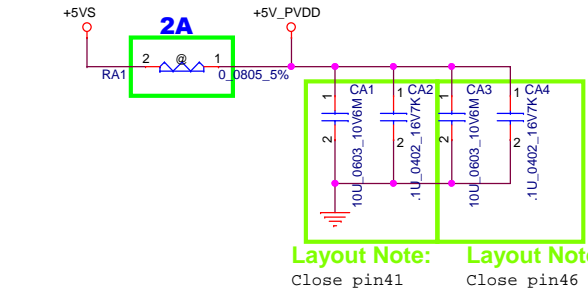
Mind the voltage rating of the caps.



Main Func = RTC

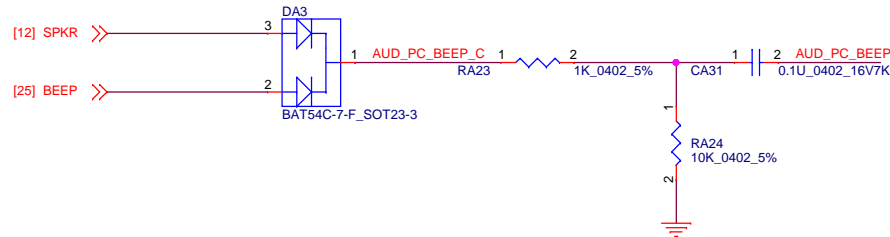
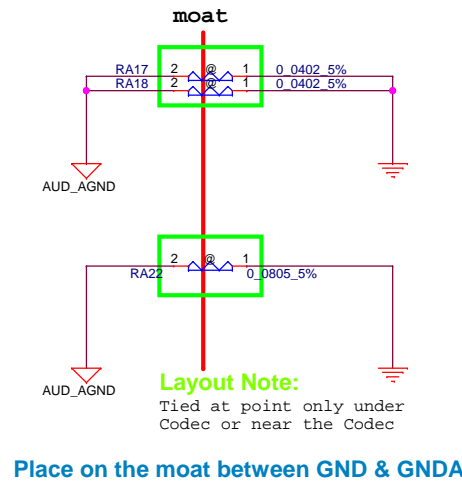
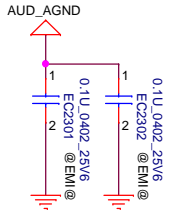


Security Classification		Compal Secret Data		Compal Electronics, Inc.		
Issued Date	2015/07/09	Deciphered Date	2016/07/31	Title		
THIS SHEET OF ENGINEERING DRAWING IS THE PROPRIETARY PROPERTY OF COMPAL ELECTRONICS, INC. AND CONTAINS CONFIDENTIAL AND TRADE SECRET INFORMATION. THIS SHEET MAY NOT BE TRANSFERRED FROM THE CUSTODY OF THE COMPETENT DIVISION OF R&D DEPARTMENT EXCEPT AS AUTHORIZED BY COMPAL ELECTRONICS, INC. NEITHER THIS SHEET NOR THE INFORMATION IT CONTAINS MAY BE USED BY OR DISCLOSED TO ANY THIRD PARTY WITHOUT PRIOR WRITTEN CONSENT OF COMPAL ELECTRONICS, INC.				Part Number		
				Document Number		
				Rev		
				LA-D801P		
Date: Tuesday, June 21, 2016				Sheet 22 of 61		

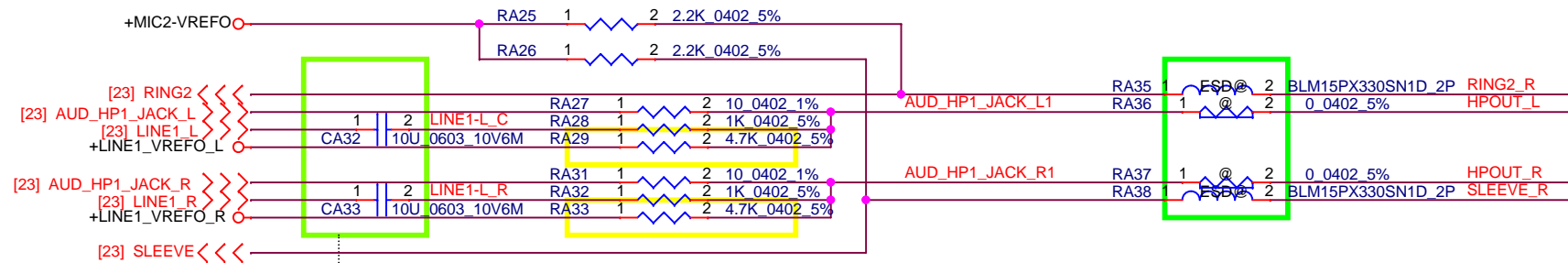


Speaker

CONN Pin	Net name
Pin1	SPK_R+
Pin2	SPK_R-
Pin3	SPK_L+
Pin4	SPK_L-



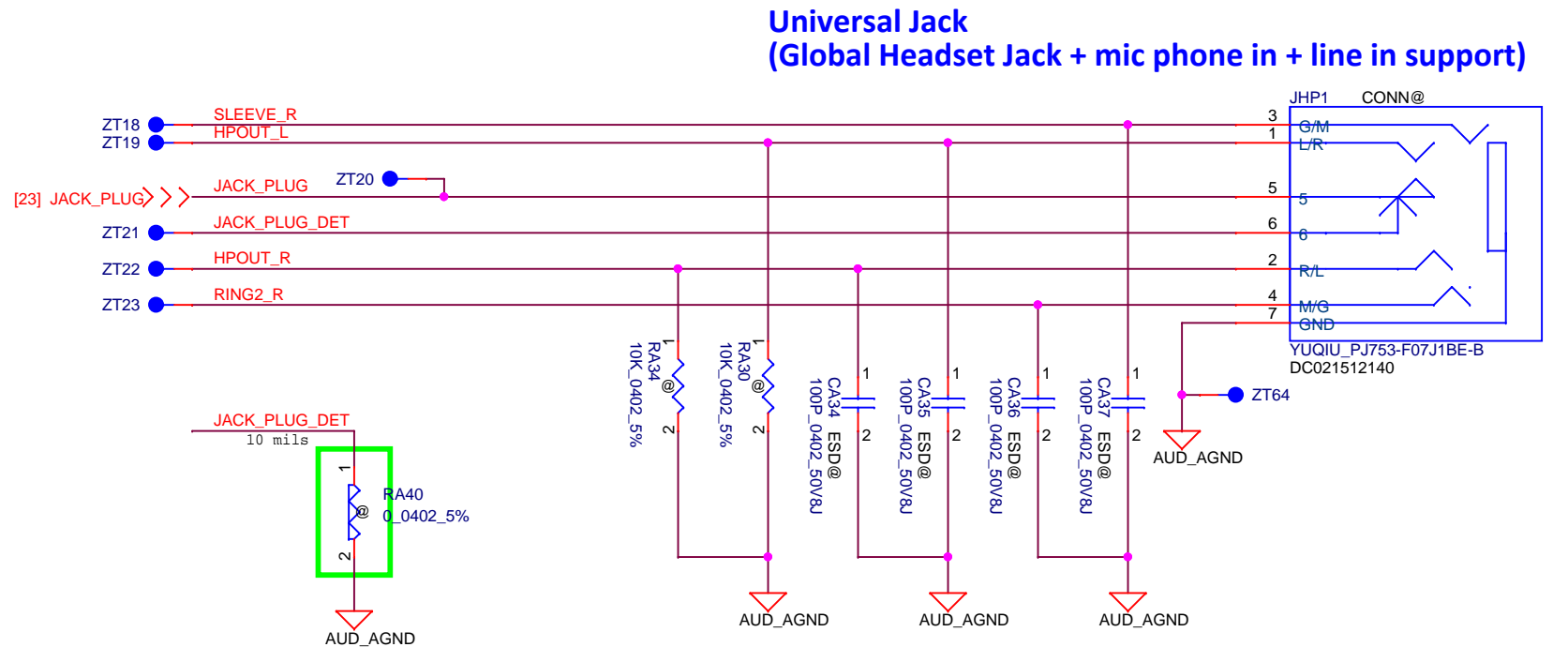
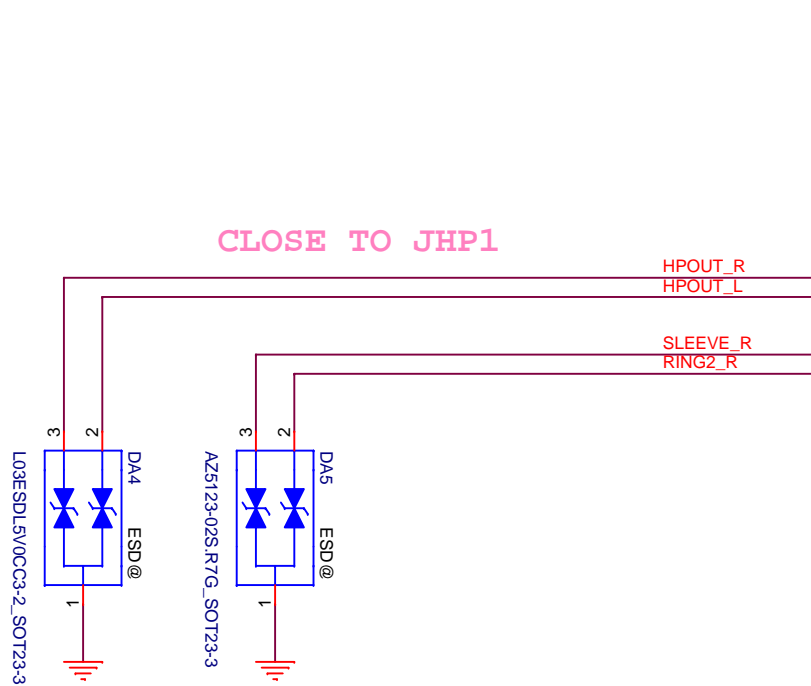
Main Func = Audio Jack



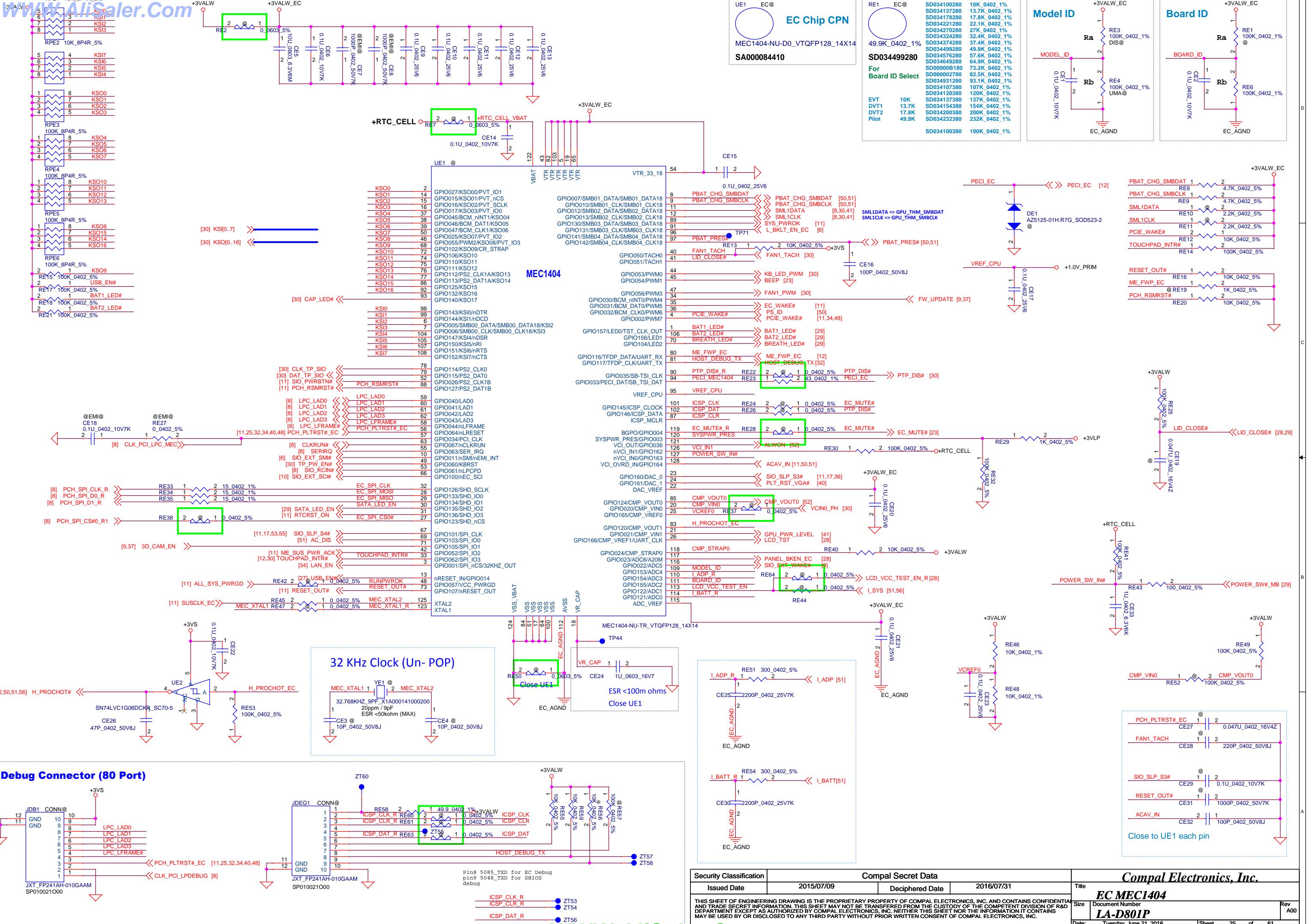
Layout Note:
Close to UA1

Universal Jack
(Global Headset Jack + mic phone in + line in support)

Main Func = Audio Jack

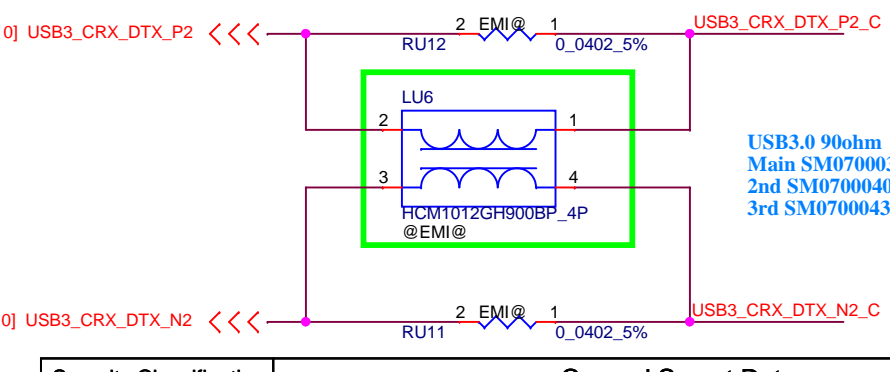
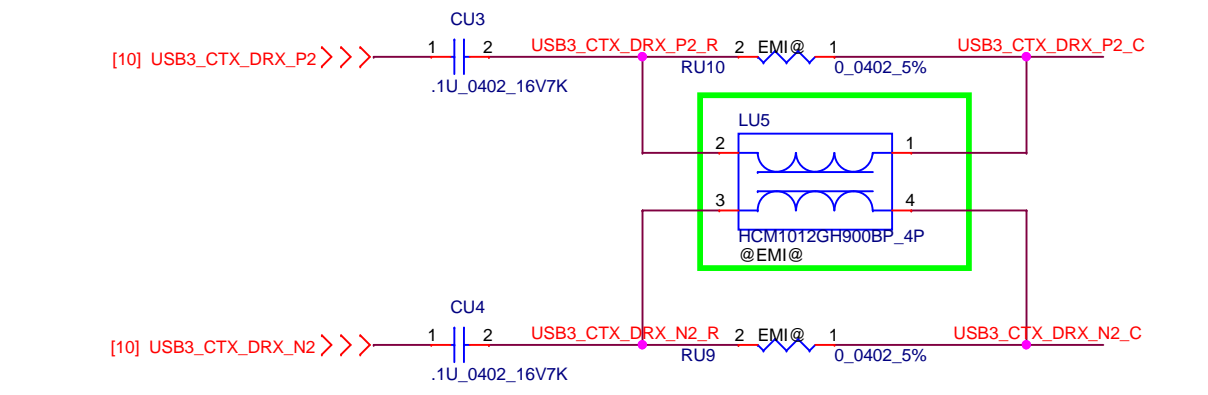
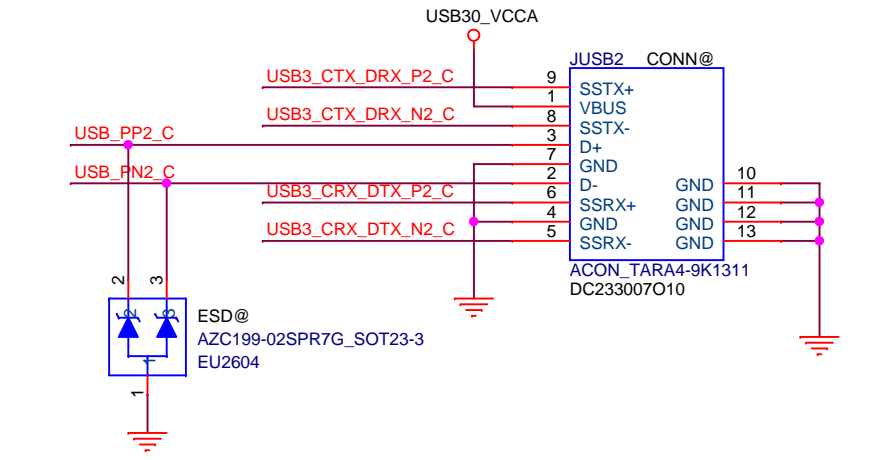
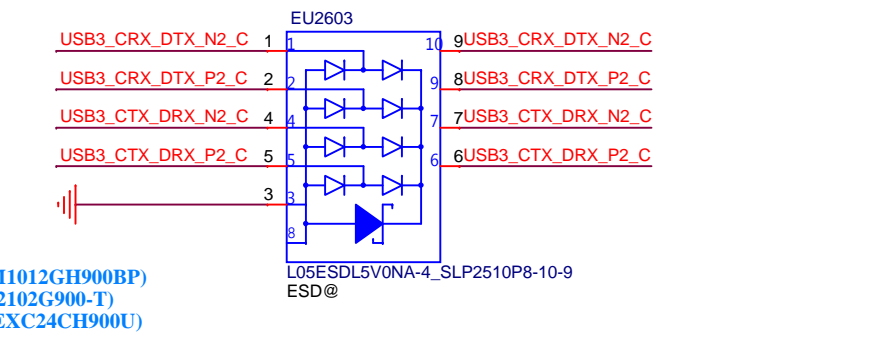
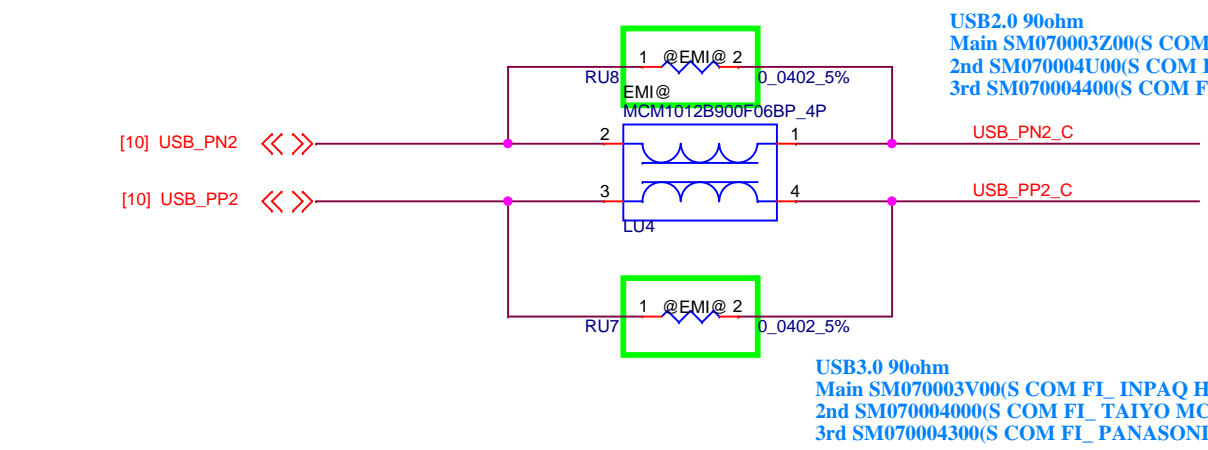
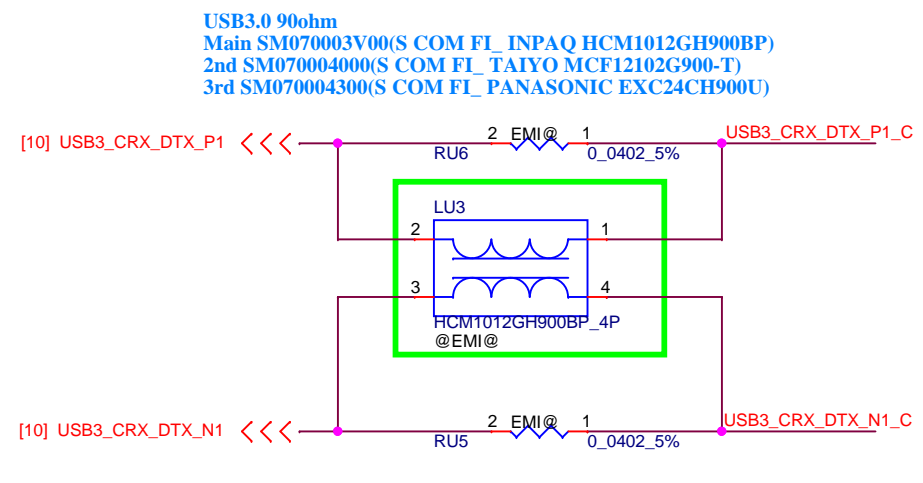
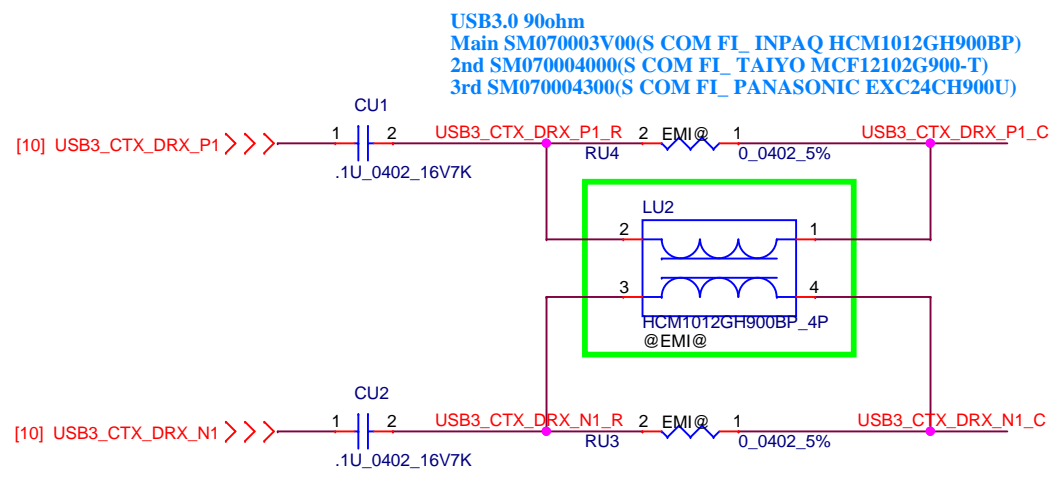
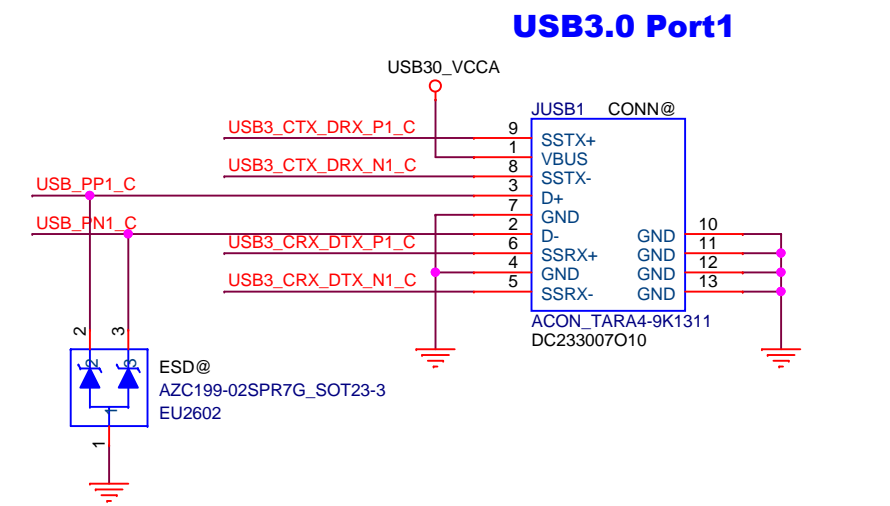
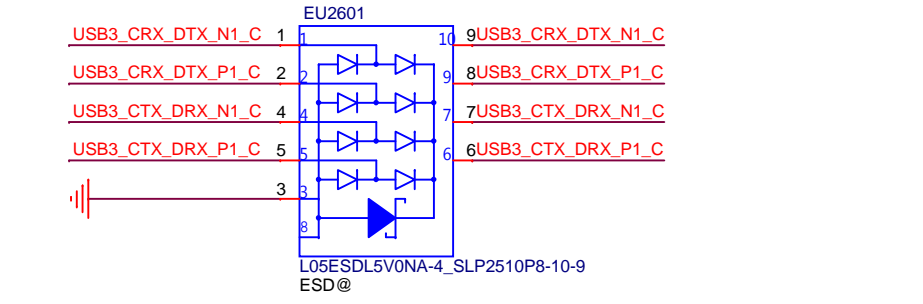
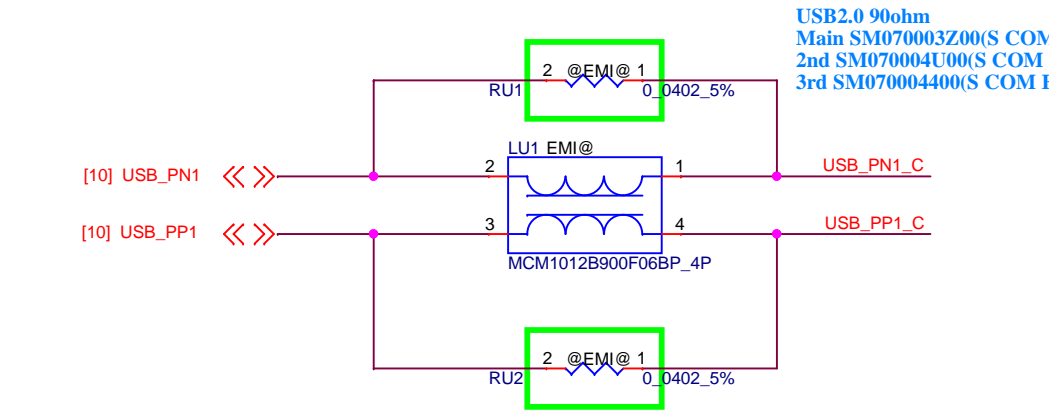


Security Classification	Compal Secret Data			Compal Electronics, Inc.	
Issued Date	2015/07/09	Deciphered Date	2016/07/31	Title	Audio JACK
THIS SHEET OF ENGINEERING DRAWING IS THE PROPRIETARY PROPERTY OF COMPAL ELECTRONICS, INC. AND CONTAINS CONFIDENTIAL AND TRADE SECRET INFORMATION. THIS SHEET MAY NOT BE TRANSFERRED FROM THE CUSTODY OF THE COMPETENT DIVISION OF R&D DEPARTMENT EXCEPT AS AUTHORIZED BY COMPAL ELECTRONICS, INC. NEITHER THIS SHEET NOR THE INFORMATION IT CONTAINS MAY BE USED BY OR DISCLOSED TO ANY THIRD PARTY WITHOUT PRIOR WRITTEN CONSENT OF COMPAL ELECTRONICS, INC.				Document Number	LA-D801P
				Date:	Tuesday, June 21, 2016
Sheet 24 of 61				Rev	A00



Security Classification		Compal Secret Data		Compal Electronics, Inc.	
Issued Date		Deciphered Date		Title	
2015/07/09		2016/07/31		EC MEC1404	
THIS SHEET OF ENGINEERING DRAWING IS THE PROPRIETARY PROPERTY OF COMPAL ELECTRONICS, INC. AND CONTAINS CONFIDENTIAL AND TRADE SECRET INFORMATION. THIS SHEET MAY NOT BE TRANSFERRED FROM THE CUSTODY OF THE COMPETENT DIVISION OF R&D DEPARTMENT EXCEPT AS AUTHORIZED BY COMPAL ELECTRONICS, INC. NEITHER THIS SHEET NOR THE INFORMATION IT CONTAINS MAY BE USED BY OR DISCLOSED TO ANY THIRD PARTY WITHOUT PRIOR WRITTEN CONSENT OF COMPAL ELECTRONICS, INC.		Size		Rev	
		Document Number		A00	
		LA-D801P			
Date:		Tuesday, June 21, 2016		Sheet	
		25		of 61	

Main Func = USB3.0 Port1

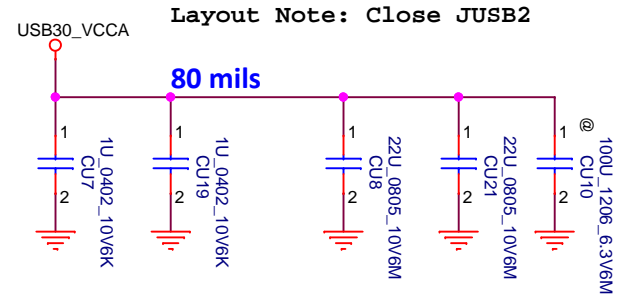
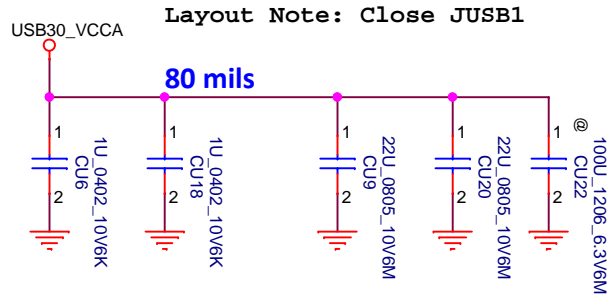
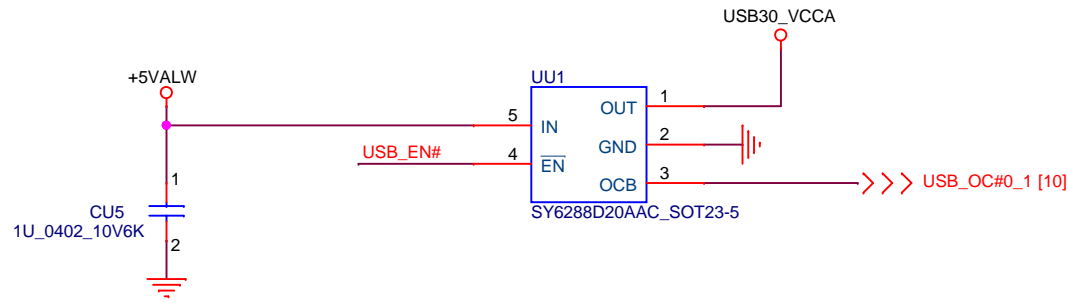


USB3.0 90ohm
Main SM070003V00(S COM FL_INPAQ HCM1012GH900BP)
2nd SM070004000(S COM FL_TAIYO MCF12102G900-T)
3rd SM070004300(S COM FL_PANASONIC EXC24CH900U)

Security Classification	Compal Secret Data			Compal Electronics, Inc.		
Issued Date	2015/07/09	Deciphered Date	2016/07/31	Title	USB3.0 CONN	
THIS SHEET OF ENGINEERING DRAWING IS THE PROPRIETARY PROPERTY OF COMPAL ELECTRONICS, INC. AND CONTAINS CONFIDENTIAL AND TRADE SECRET INFORMATION. THIS SHEET MAY NOT BE TRANSFERRED FROM THE CUSTODY OF THE COMPETENT DIVISION OF R&D DEPARTMENT EXCEPT AS AUTHORIZED BY COMPAL ELECTRONICS, INC. NEITHER THIS SHEET NOR THE INFORMATION IT CONTAINS MAY BE USED BY OR DISCLOSED TO ANY THIRD PARTY WITHOUT PRIOR WRITTEN CONSENT OF COMPAL ELECTRONICS, INC.				Document Number	LA-D801P	Rev A00
				Date:	Tuesday, June 21, 2016	Sheet 26 of 61

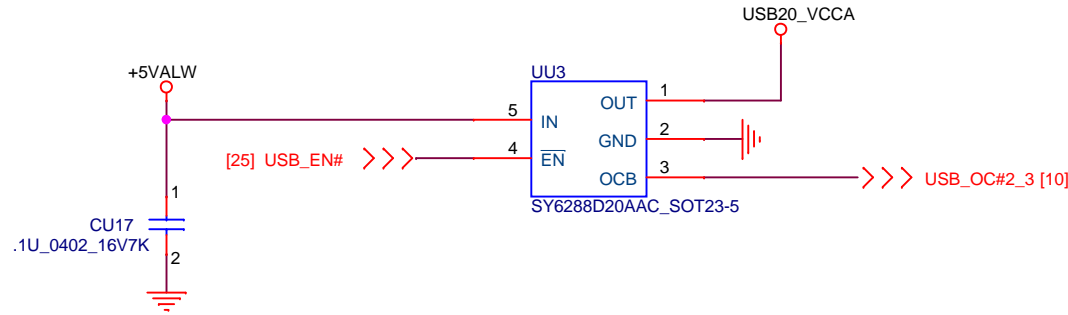
Main Func = USB3.0 Port1/Port2

SY6288D Support 2A

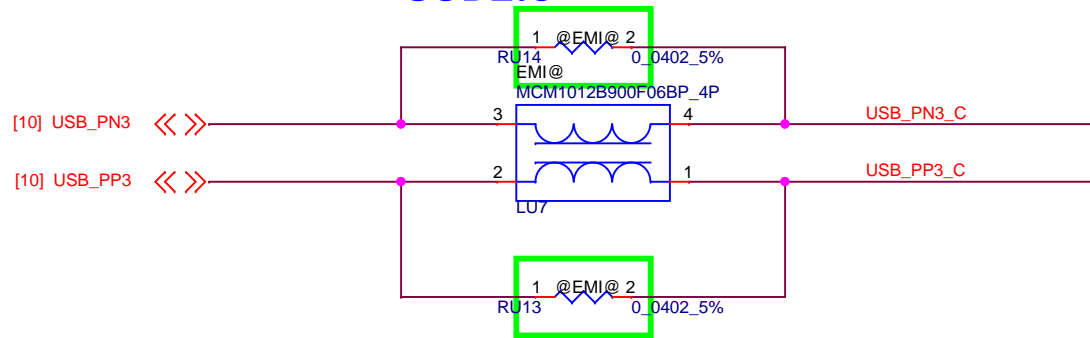


Main Func = USB3.0 Port3

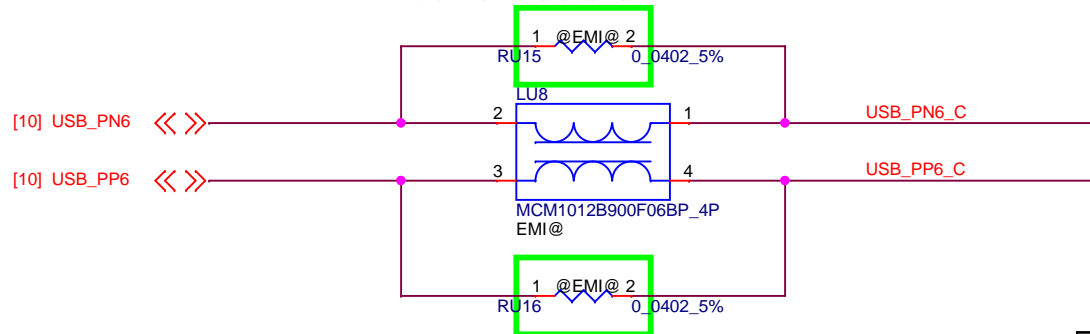
SY6288D Support 2A



USB2.0

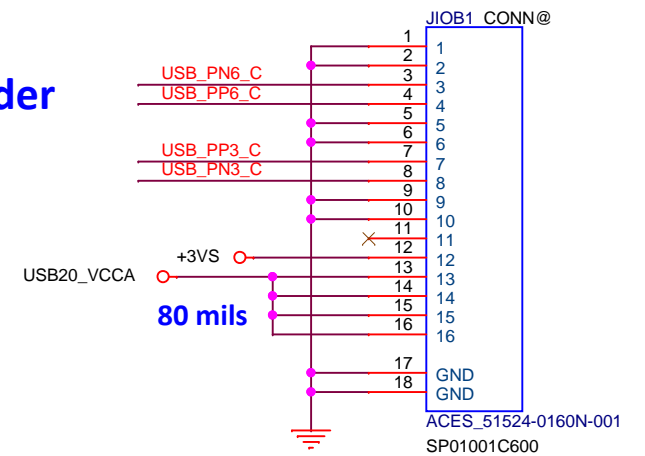


CardReader



I/O Board Connector

CardReader
USB2.0

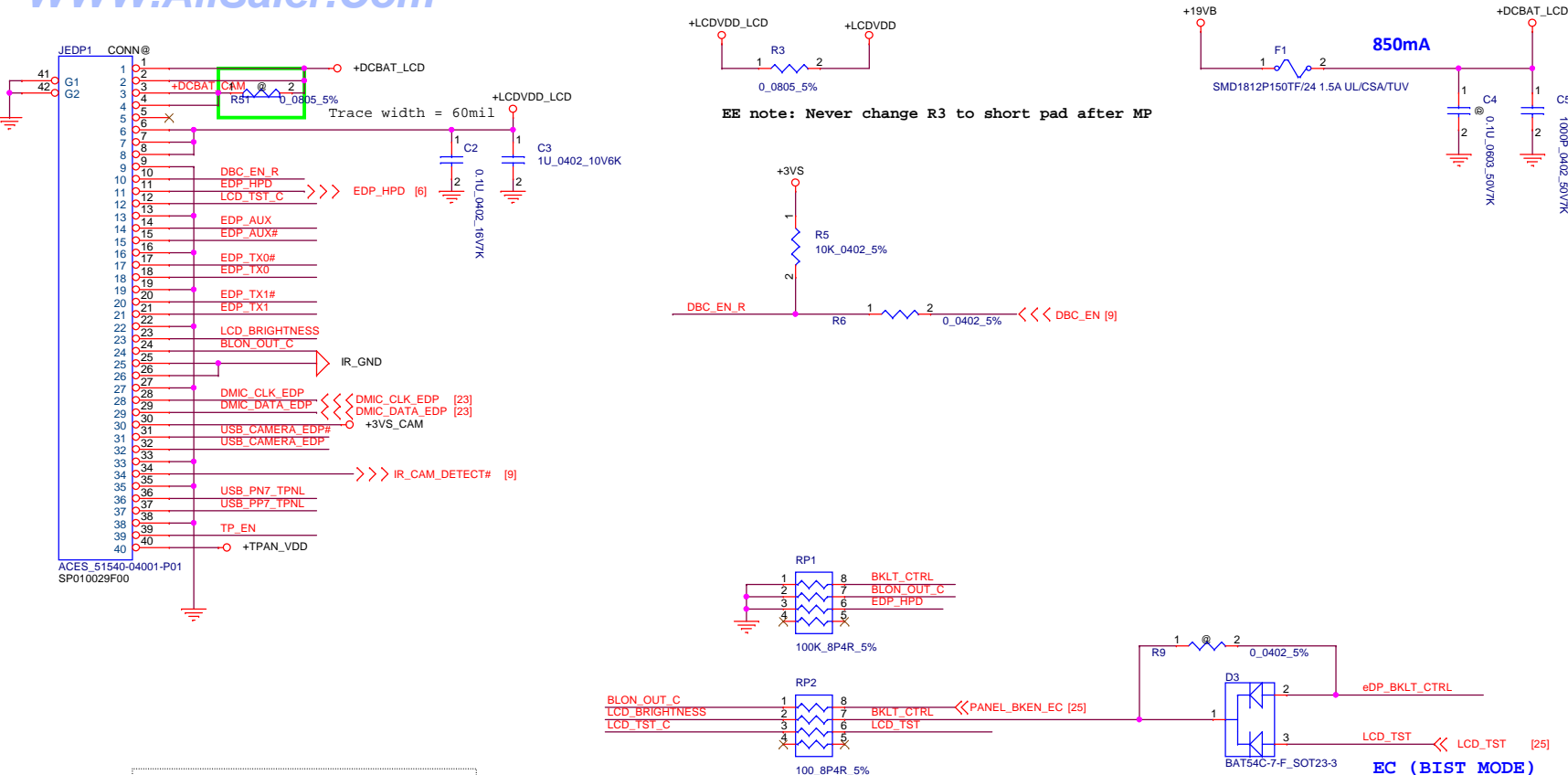


Security Classification	Compal Secret Data			Compal Electronics, Inc.		
Issued Date	2015/07/09	Deciphered Date	2016/07/31	Title	USB Power SW/IO Board	
THIS SHEET OF ENGINEERING DRAWING IS THE PROPRIETARY PROPERTY OF COMPAL ELECTRONICS, INC. AND CONTAINS CONFIDENTIAL AND TRADE SECRET INFORMATION. THIS SHEET MAY NOT BE TRANSFERRED FROM THE CUSTODY OF THE COMPETENT DIVISION OF R&D DEPARTMENT EXCEPT AS AUTHORIZED BY COMPAL ELECTRONICS, INC. NEITHER THIS SHEET NOR THE INFORMATION IT CONTAINS MAY BE USED BY OR DISCLOSED TO ANY THIRD PARTY WITHOUT PRIOR WRITTEN CONSENT OF COMPAL ELECTRONICS, INC.				Document Number	LA-D801P	Rev A00
				Date:	Tuesday, June 21, 2016	Sheet 27 of 61

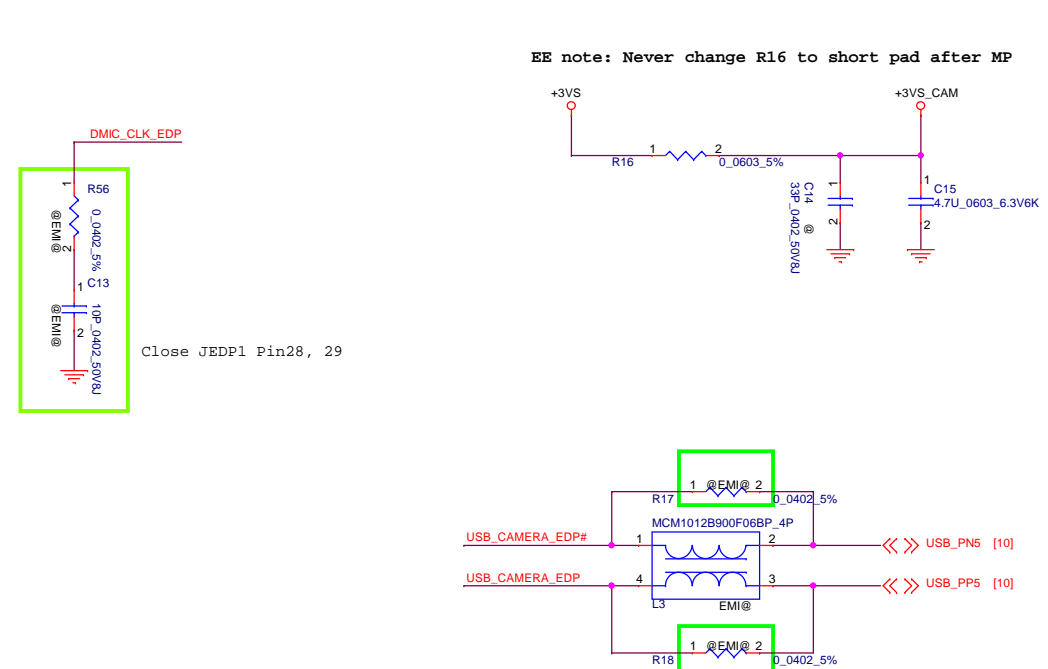
Main Func = LCD

WWW.AliSaler.Com

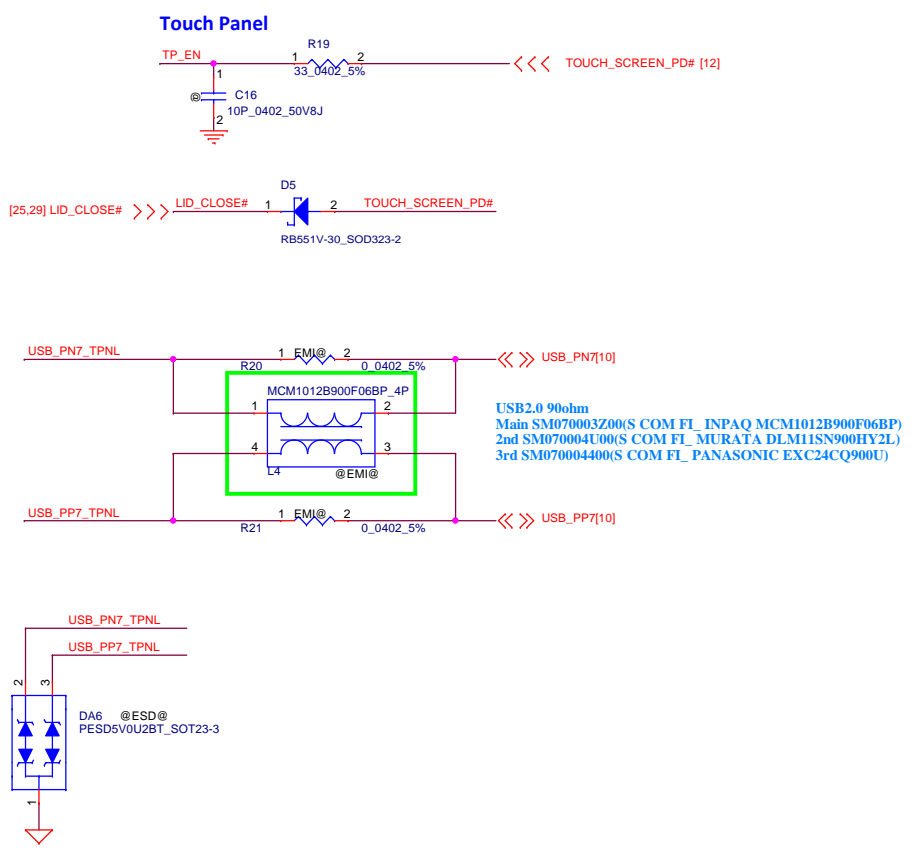
INVERTER POWER



Main Func = CAM



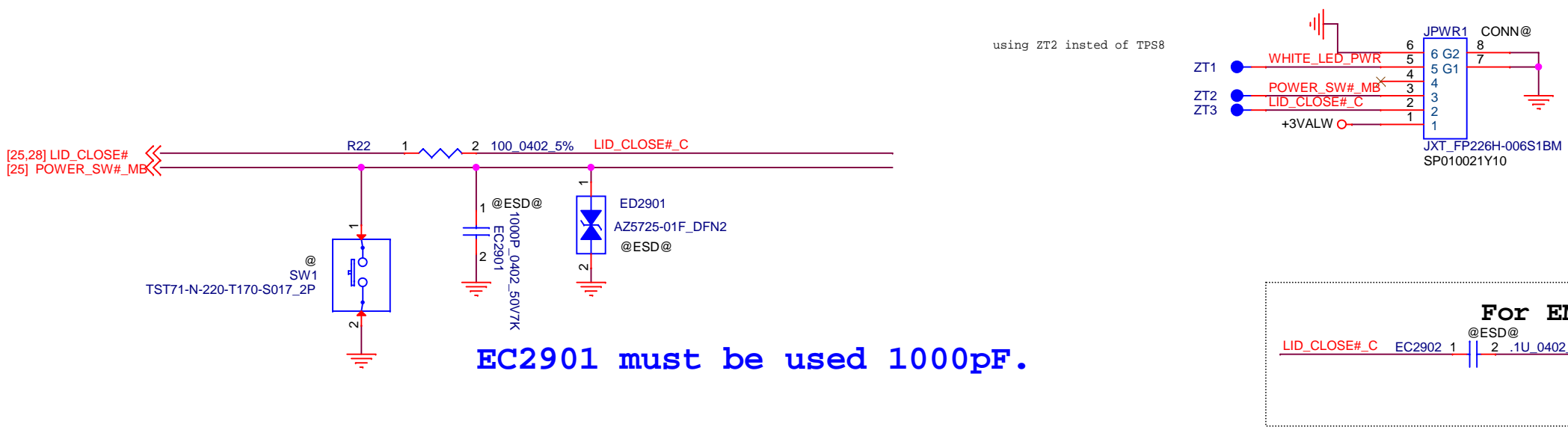
Main Func = TS



Security Classification		Compal Secret Data		Compal Electronics, Inc.	
Issued Date	2015/07/09	Deciphered Date	2016/07/31	Title	LCD/Cam/MIC/T.Panel
THIS SHEET OF ENGINEERING DRAWING IS THE PROPRIETARY PROPERTY OF COMPAL ELECTRONICS, INC. AND CONTAINS CONFIDENTIAL AND TRADE SECRET INFORMATION. THIS SHEET MAY NOT BE TRANSFERRED FROM THE CUSTODY OF THE COMPETENT DIVISION OF R&D DEPARTMENT EXCEPT AS AUTHORIZED BY COMPAL ELECTRONICS, INC. NEITHER THIS SHEET NOR THE INFORMATION IT CONTAINS MAY BE USED BY OR DISCLOSED TO ANY THIRD PARTY WITHOUT PRIOR WRITTEN CONSENT OF COMPAL ELECTRONICS, INC.				Size	Document Number
				LA-D801P	Rev A00
				Date:	Tuesday, June 21, 2016
				Sheet	28 of 61

WWW.AliSaler.Com

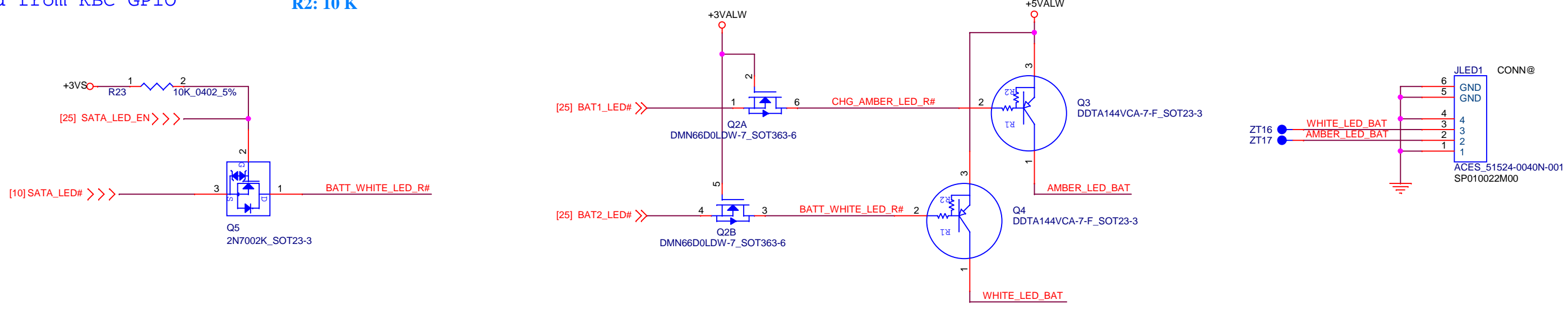
Main Func = Power BTN



Main Func = Battery LED

Low actived from KBC GPIO

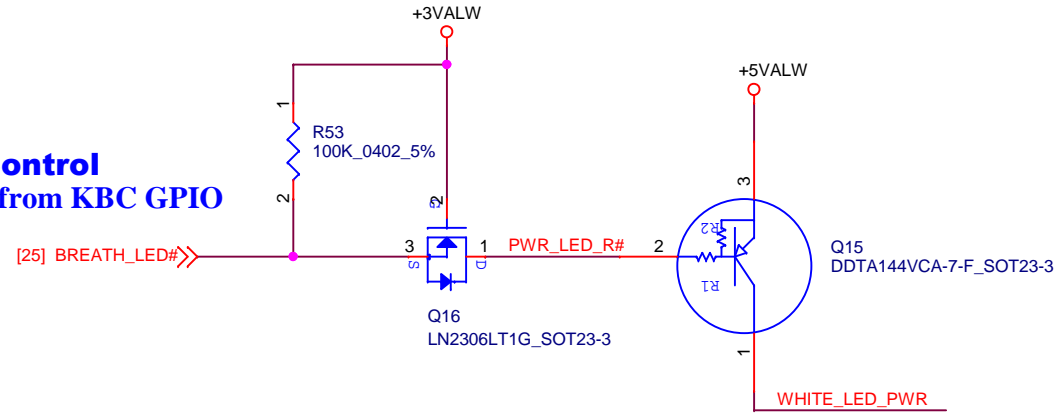
BJT
R1: 47 K
R2: 10 K



Main Func = PWR LED

Low actived from KBC GPIO

PWR LED Control
LOW actived from KBC GPIO

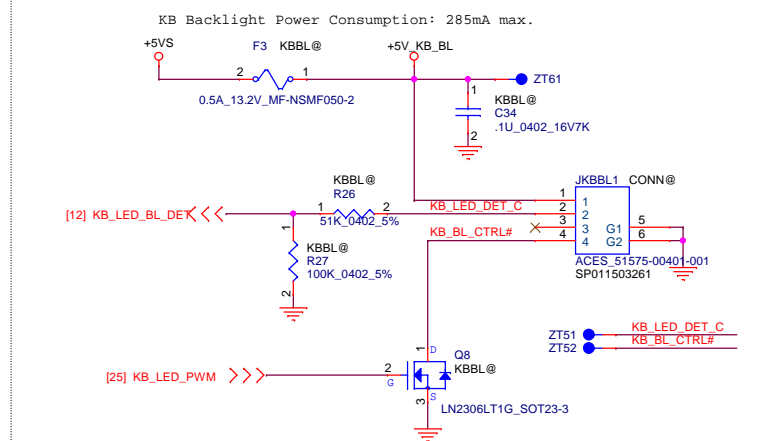
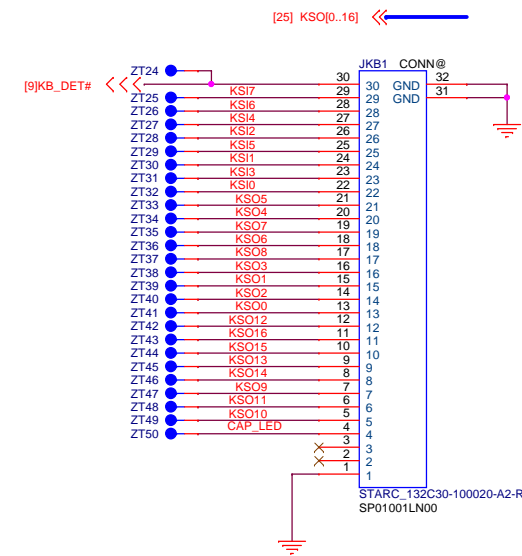


Security Classification	Compal Secret Data			Compal Electronics, Inc.		
Issued Date	2015/07/09	Deciphered Date	2016/07/31	Title	LED Board/Power Button	
THIS SHEET OF ENGINEERING DRAWING IS THE PROPRIETARY PROPERTY OF COMPAL ELECTRONICS, INC. AND CONTAINS CONFIDENTIAL AND TRADE SECRET INFORMATION. THIS SHEET MAY NOT BE TRANSFERRED FROM THE CUSTODY OF THE COMPETENT DIVISION OF R&D DEPARTMENT EXCEPT AS AUTHORIZED BY COMPAL ELECTRONICS, INC. NEITHER THIS SHEET NOR THE INFORMATION IT CONTAINS MAY BE USED BY OR DISCLOSED TO ANY THIRD PARTY WITHOUT PRIOR WRITTEN CONSENT OF COMPAL ELECTRONICS, INC.				Document Number	LA-D801P	Rev A00
Date: Tuesday, June 21, 2016				Sheet	29	of 61

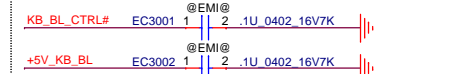
Main Func = KB

WWW.AliSaler.Com

Keyboard Backlight (Reserved)

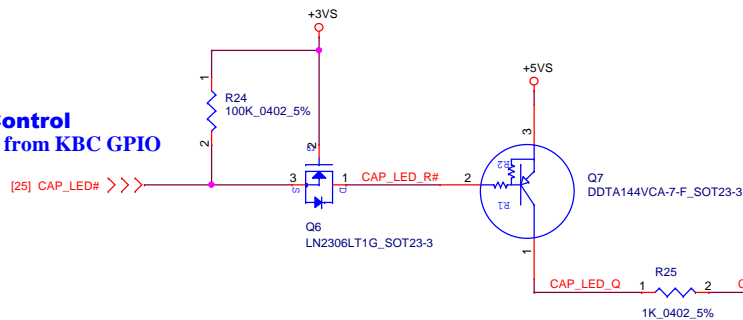


For EMI Reserved



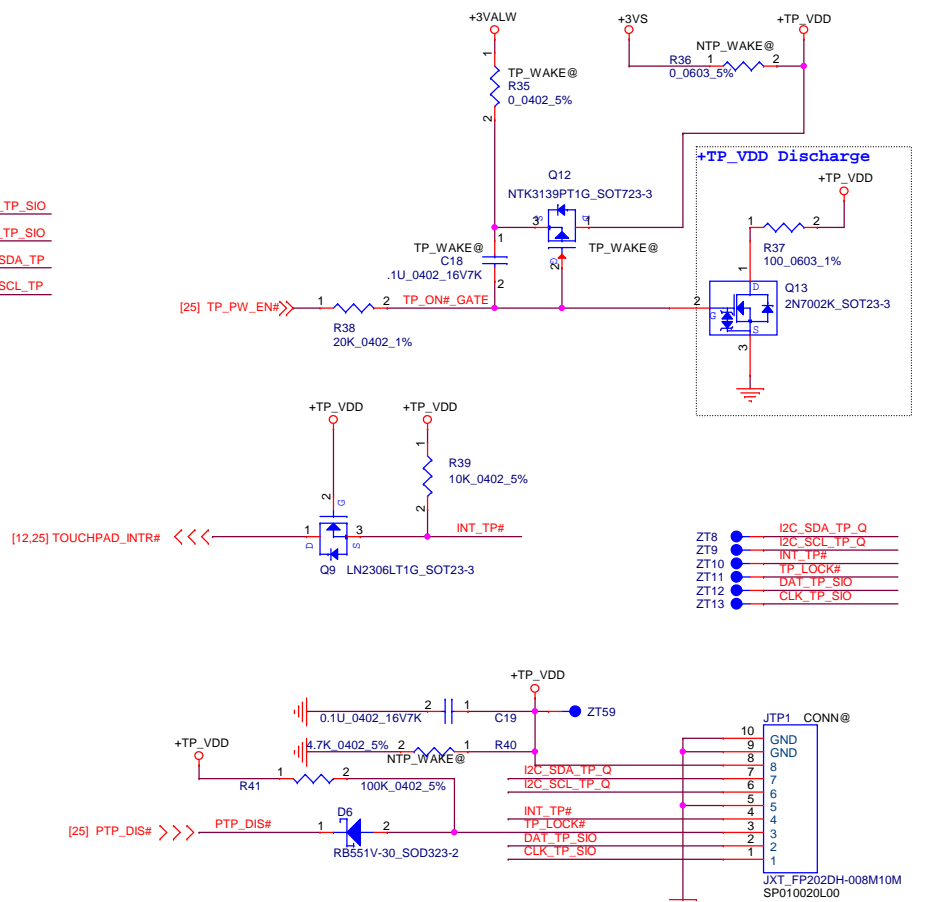
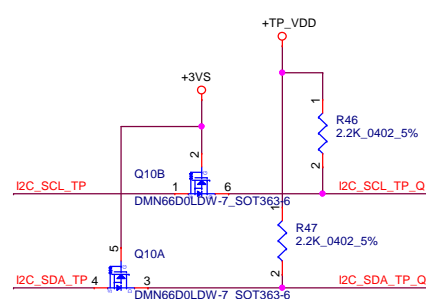
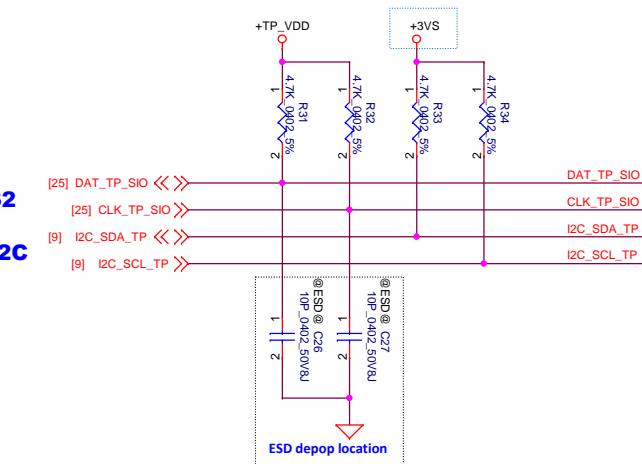
CAP LED Control

LOW acted from KBC GPIO

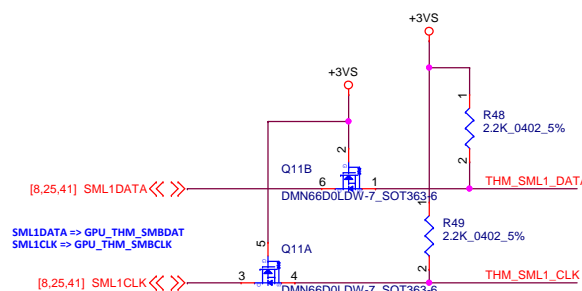


Main Func = TPAD

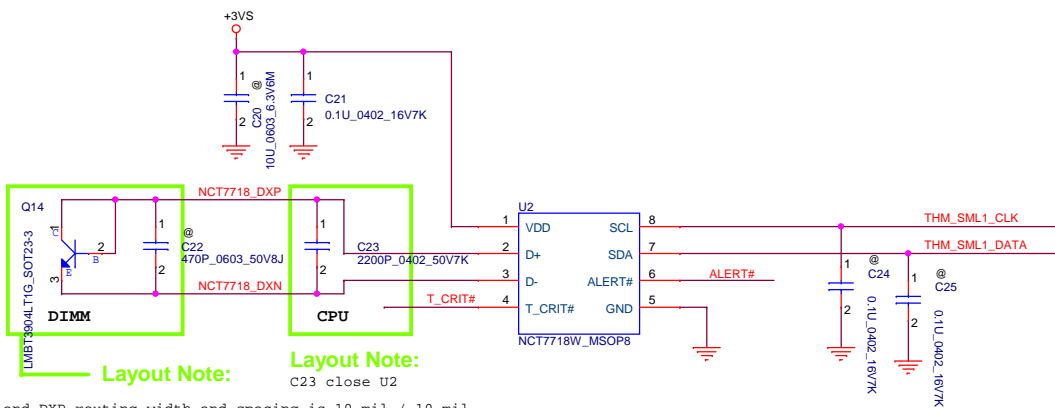
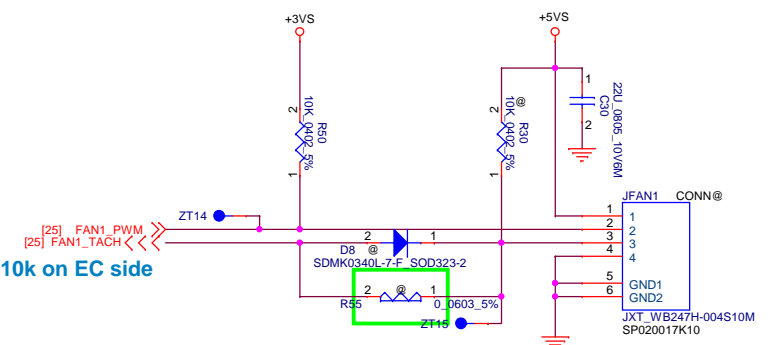
EC/PS2
PCH/I2C



Main Func = Thermal



"FAN1_FB" PU 10k on EC side

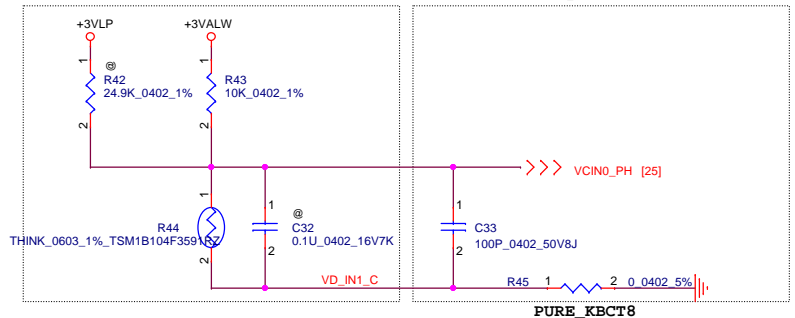


Layout Note: DYN and DXP routing width and spacing is 10 mil / 10 mil.

TEMPERATURE (°C)	T_CRIT#				
	2KΩ	7.5KΩ	10.5KΩ	14KΩ	18.7KΩ
ALERT#	2KΩ	77	87	97	107
	7.5KΩ	79	89	99	109
	10.5KΩ	81	91	101	111
	14KΩ	83	93	103	113
	18.7KΩ	85	95	105	115

Close to Thermal sensor

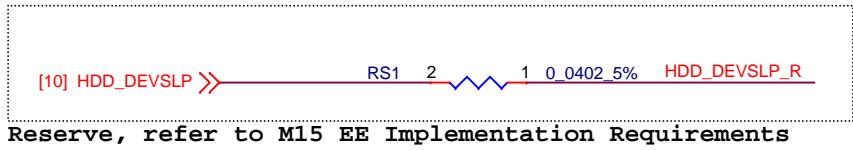
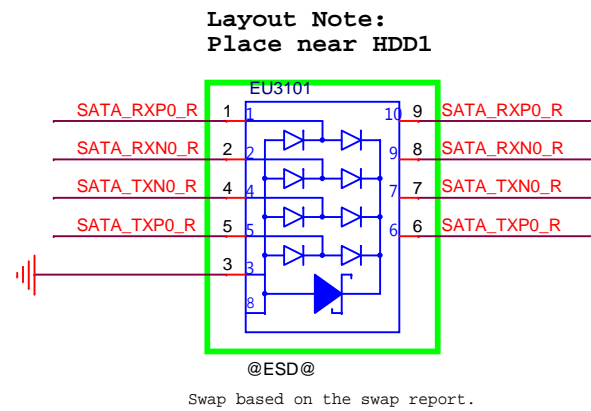
Close to KBC
VD_IN1 for system thermal sensor



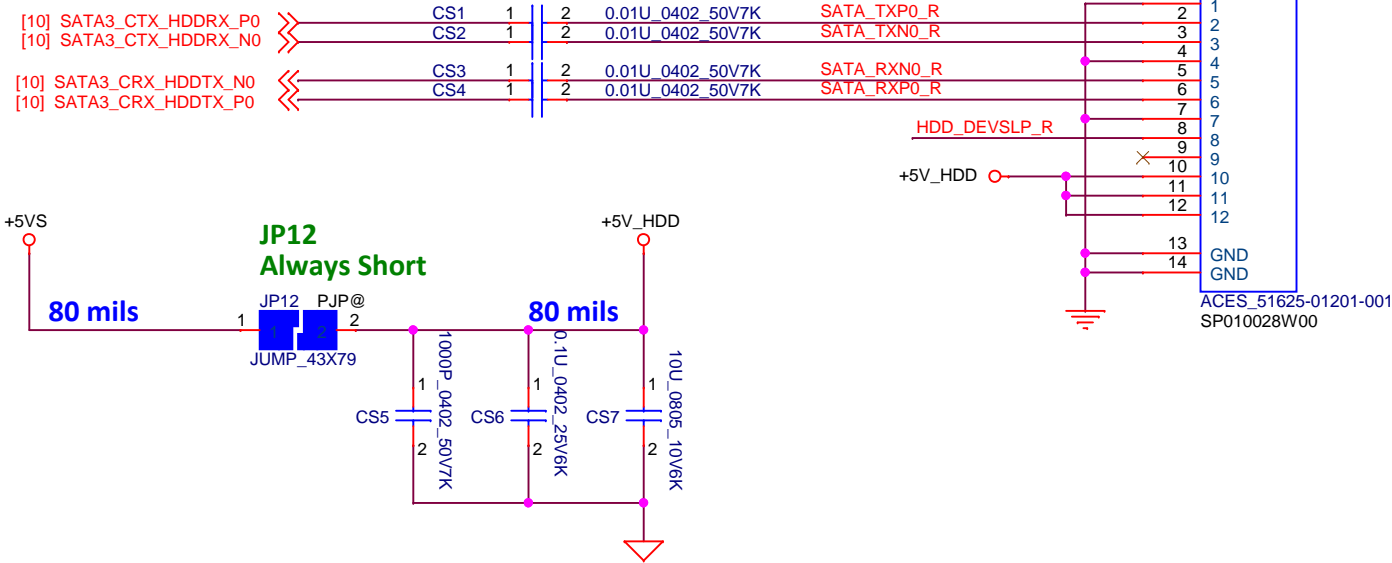
Security Classification	Compal Secret Data		Title	
Issued Date	2015/07/09	Deciphered Date	2016/07/31	Keyboard/Touch Pad/Thermal/FAN
THIS SHEET OF ENGINEERING DRAWING IS THE PROPRIETARY PROPERTY OF COMPAL ELECTRONICS, INC. AND CONTAINS CONFIDENTIAL AND TRADE SECRET INFORMATION. THIS SHEET MAY NOT BE TRANSFERRED FROM THE CUSTODY OF THE COMPETENT DIVISION OF R&D DEPARTMENT EXCEPT AS AUTHORIZED BY COMPAL ELECTRONICS, INC. NEITHER THIS SHEET NOR THE INFORMATION IT CONTAINS MAY BE USED BY OR DISCLOSED TO ANY THIRD PARTY WITHOUT PRIOR WRITTEN CONSENT OF COMPAL ELECTRONICS, INC.				Rev A00
Size	Document Number	Date	Sheet	of
LA-D801P	LA-D801P	Tuesday, June 21, 2016	30	61

WWW.AliSaler.Com

SATA HDD Connector

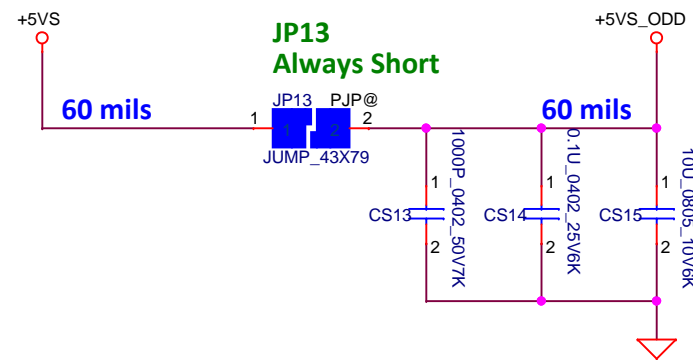


SOC TX
SOC RX

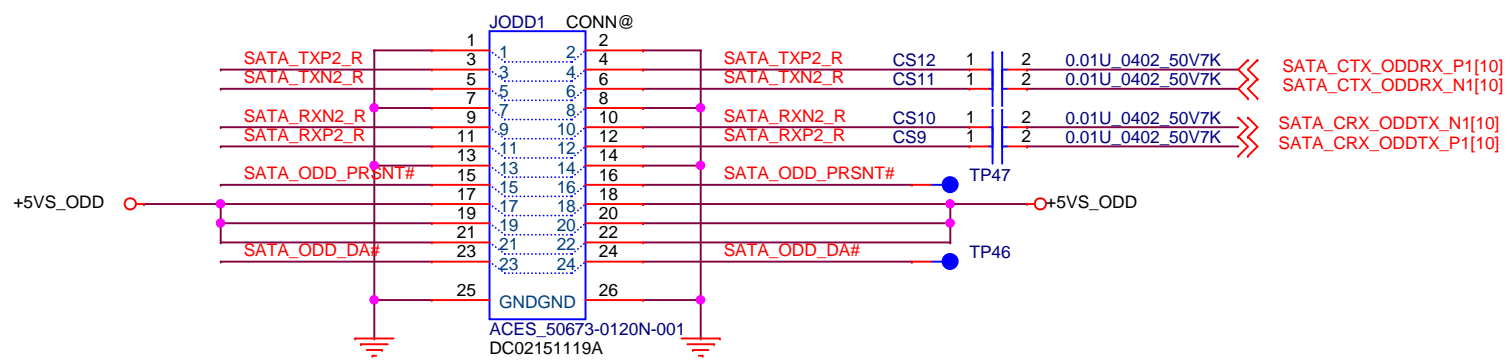


CONN		FFC
GND	S1	1
A+	S2	2
A-	S3	3
GND	S4	4
B-	S5	5
B+	S6	6
GND	S7	7
GND	P1	
GND	P2	
GND	P3	
5V	P4	10
5V	P5	11
5V	P6	12
GND	P7	
GND	P8	

ODD ZiF Connector

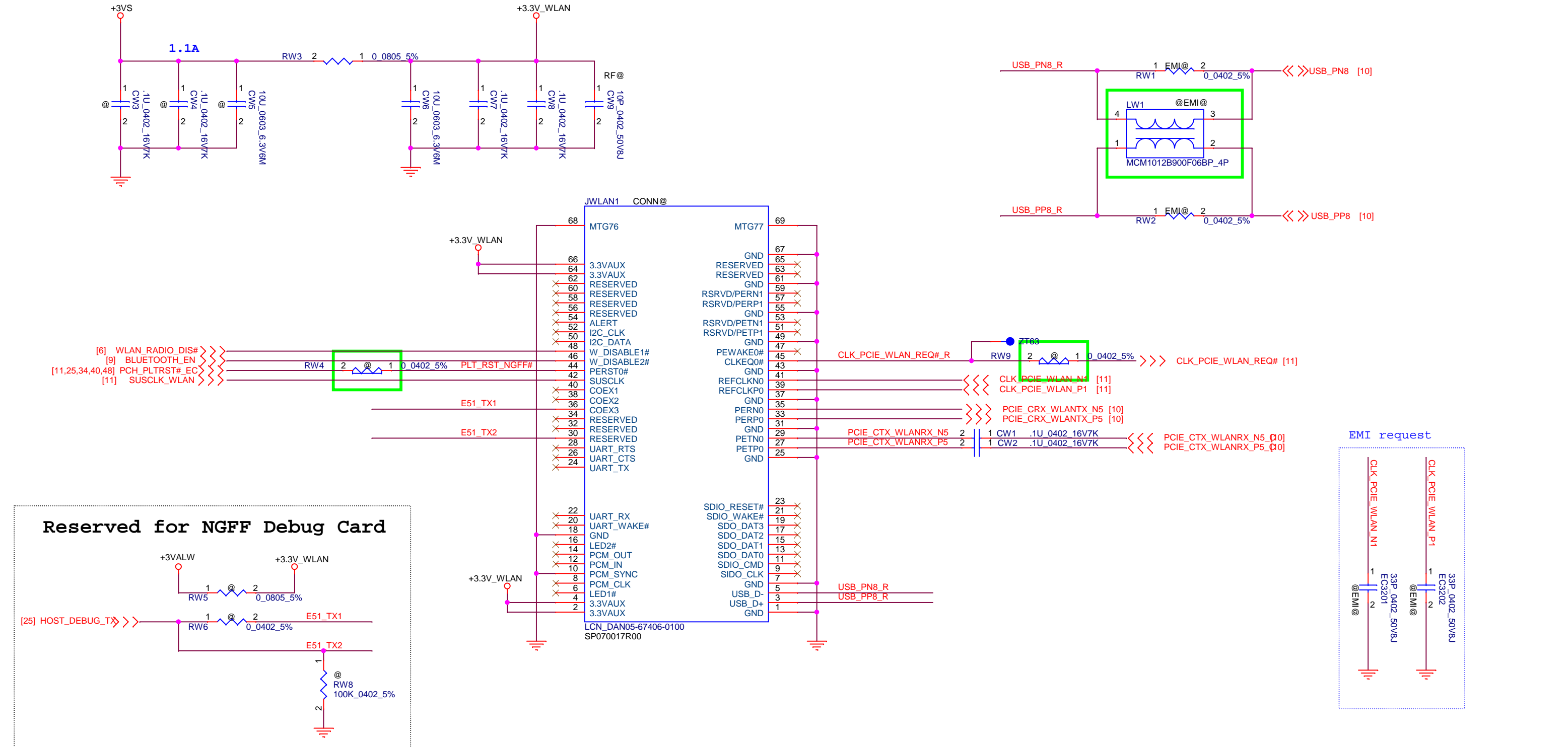


SOC TX
SOC RX



Pin	Signal
1	GND
2	A+
3	A-
4	GND
5	B-
6	B+
7	GND
8	DP
9	+5V
10	+5V
11	MD
12	GND
13	GND

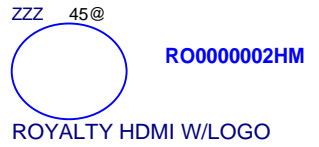
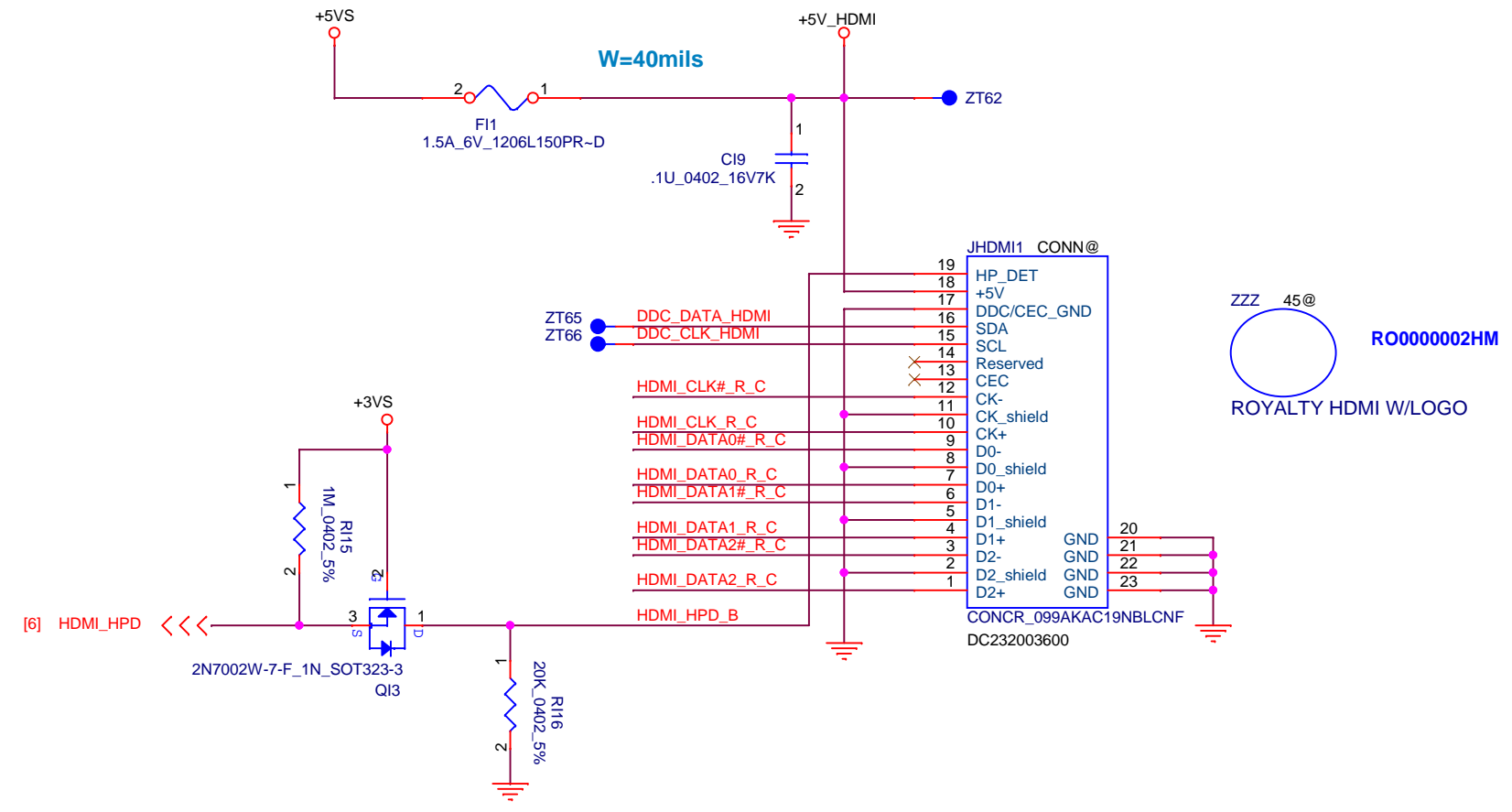
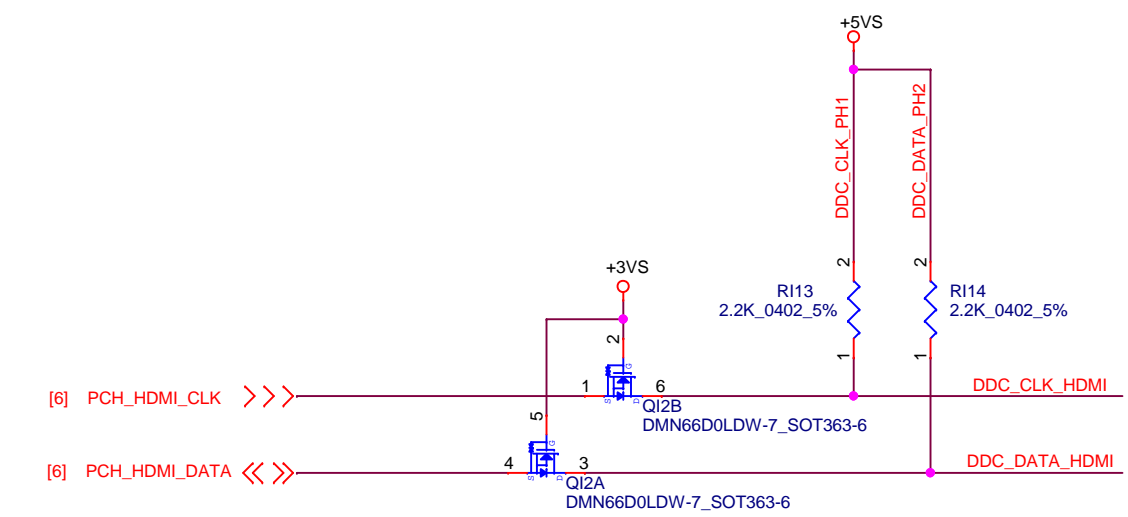
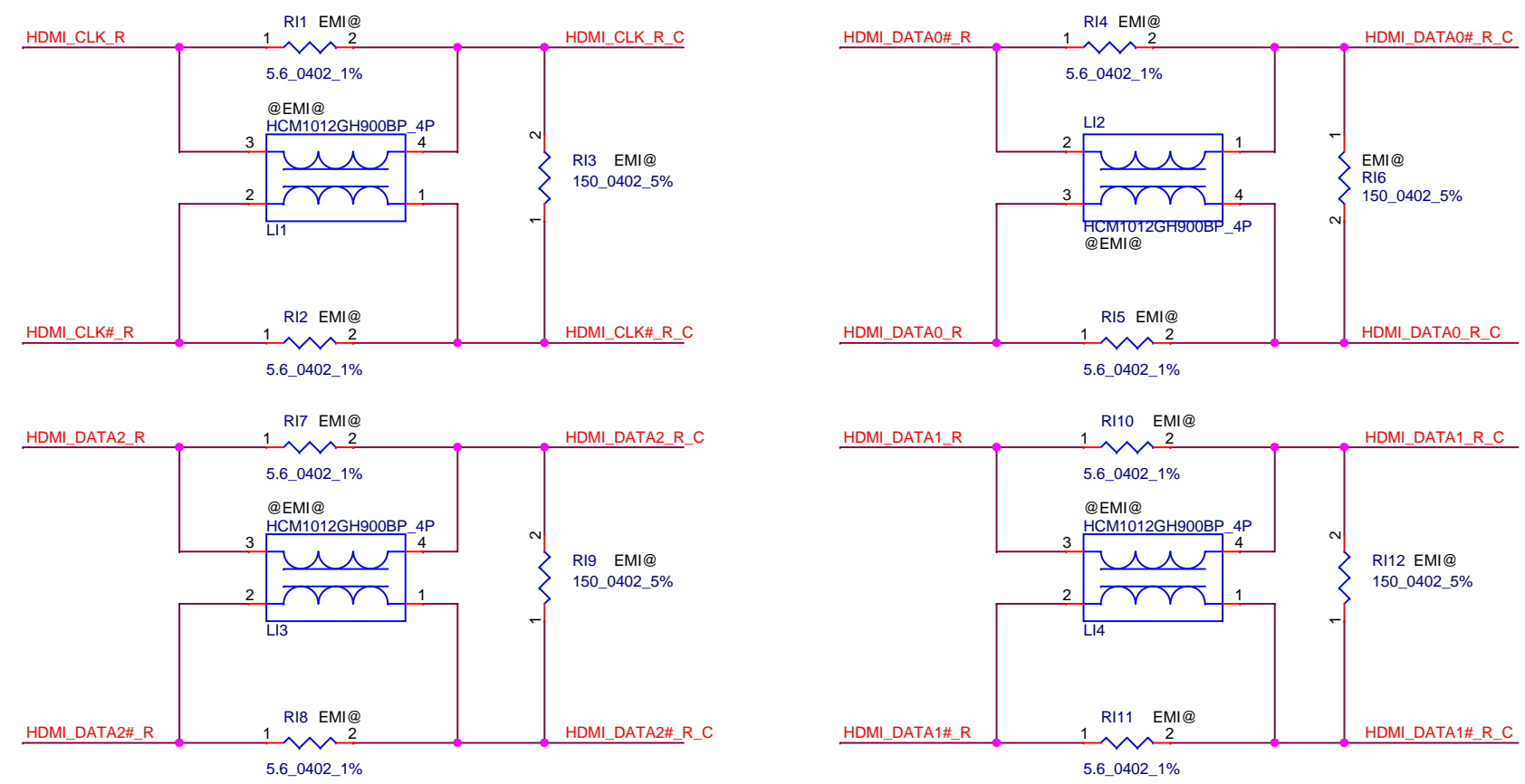
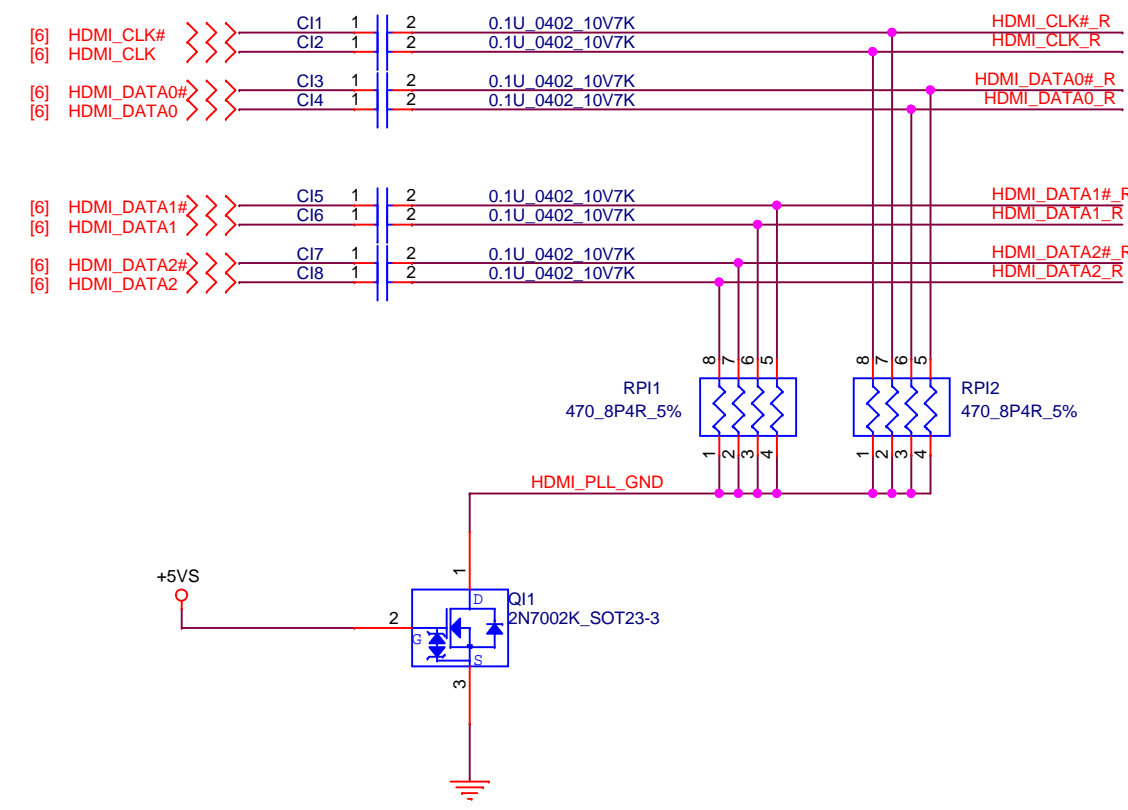
Main Func = WLAN A Key CONN



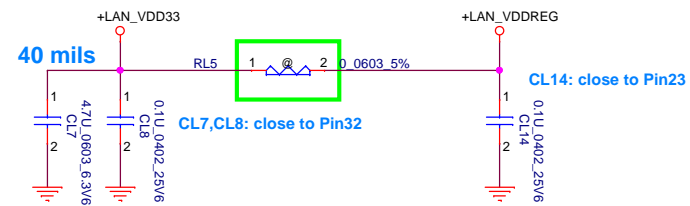
Support: Intel Dual Band Wireless-AC 3160

Security Classification	Compal Secret Data			Compal Electronics, Inc.	
Issued Date	2015/07/09	Deciphered Date	2016/07/31	Title	NGFF WLAN CONN
THIS SHEET OF ENGINEERING DRAWING IS THE PROPRIETARY PROPERTY OF COMPAL ELECTRONICS, INC. AND CONTAINS CONFIDENTIAL AND TRADE SECRET INFORMATION. THIS SHEET MAY NOT BE TRANSFERRED FROM THE CUSTODY OF THE COMPETENT DIVISION OF R&D DEPARTMENT EXCEPT AS AUTHORIZED BY COMPAL ELECTRONICS, INC. NEITHER THIS SHEET NOR THE INFORMATION IT CONTAINS MAY BE USED BY OR DISCLOSED TO ANY THIRD PARTY WITHOUT PRIOR WRITTEN CONSENT OF COMPAL ELECTRONICS, INC.				Document Number	LA-D801P
				Rev	A00
				Date:	Tuesday, June 21, 2016
				Sheet	32 of 61

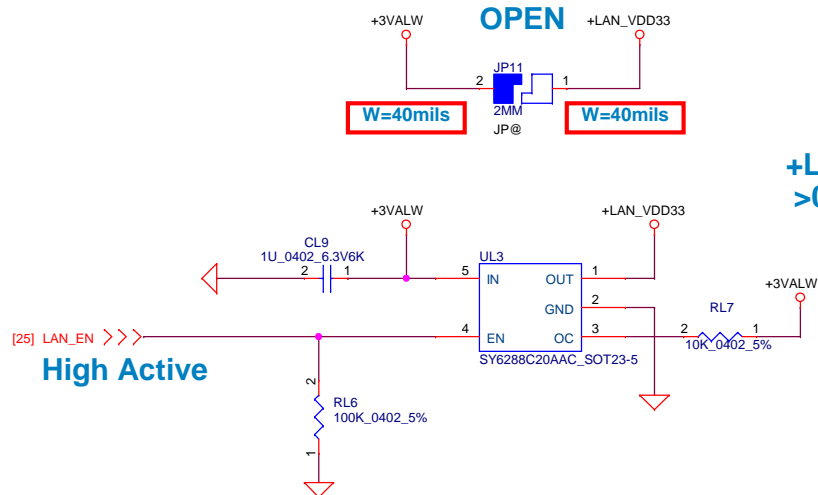
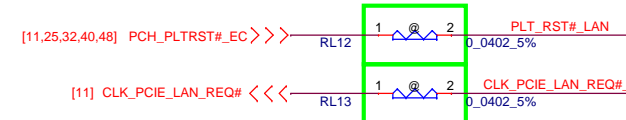
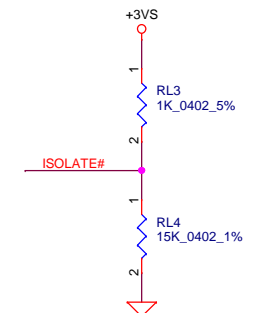
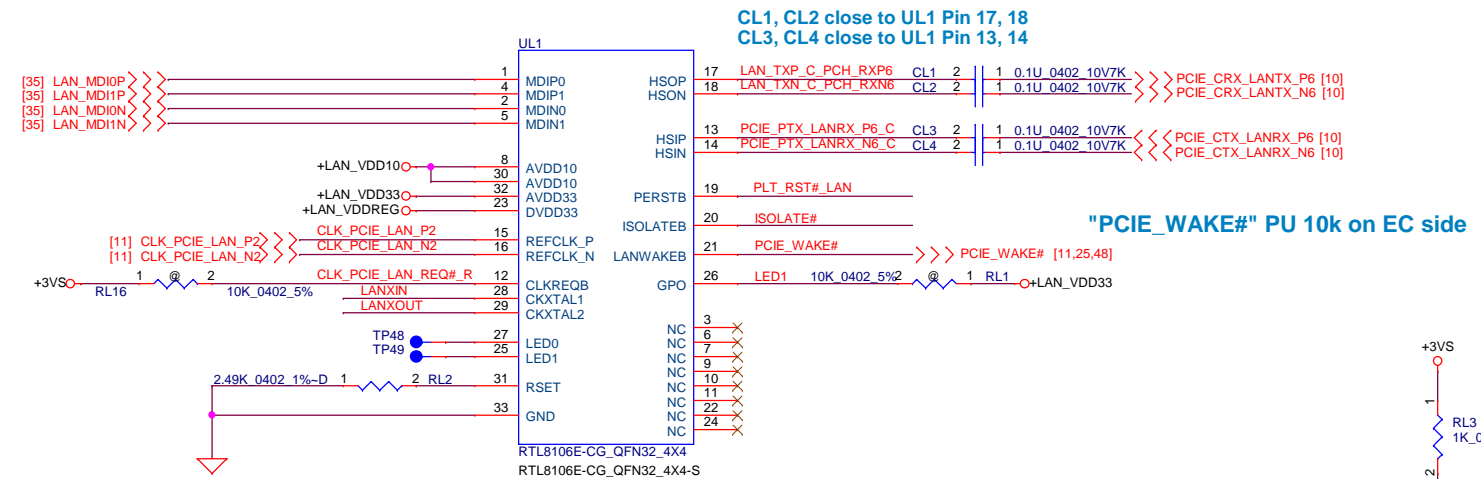
Main Func = HDMI



Security Classification		Compal Secret Data		Compal Electronics, Inc.	
Issued Date	2015/07/09	Deciphered Date	2016/07/31	Title	
THIS SHEET OF ENGINEERING DRAWING IS THE PROPRIETARY PROPERTY OF COMPAL ELECTRONICS, INC. AND CONTAINS CONFIDENTIAL AND TRADE SECRET INFORMATION. THIS SHEET MAY NOT BE TRANSFERRED FROM THE CUSTODY OF THE COMPETENT DIVISION OF R&D DEPARTMENT EXCEPT AS AUTHORIZED BY COMPAL ELECTRONICS, INC. NEITHER THIS SHEET NOR THE INFORMATION IT CONTAINS MAY BE USED BY OR DISCLOSED TO ANY THIRD PARTY WITHOUT PRIOR WRITTEN CONSENT OF COMPAL ELECTRONICS, INC.				Document Number	Rev
LA-D801P				LA-D801P	A00
Date: Tuesday, June 21, 2016		Sheet 33 of 61			

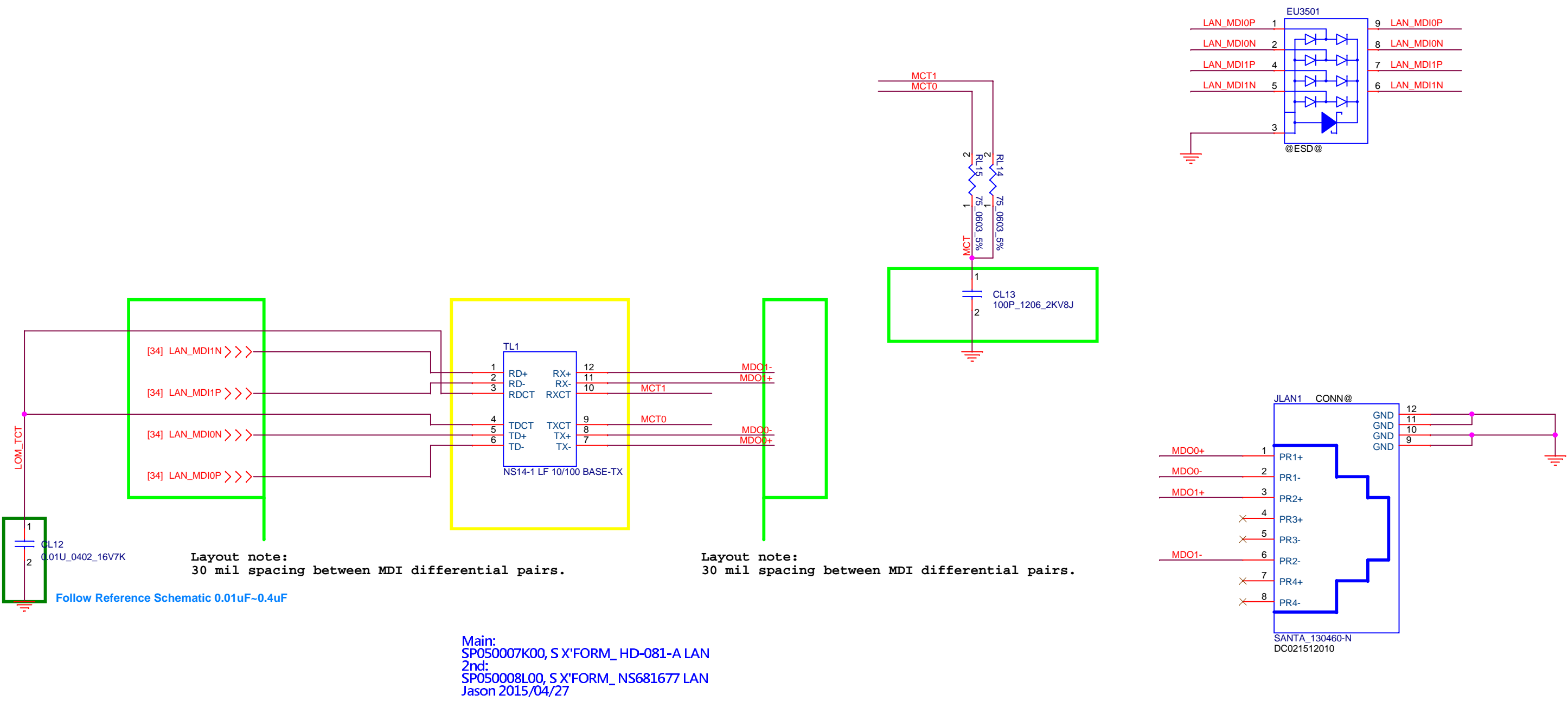


RTL8111GUS-CG	RTL8111G-CGT	RTL8106EUS-CG	RTL8106E-CG
			SA000065Y00
SWR mode	LDO mode	SWR mode	LDO mode
10/100/1000M	10/100/1000M	10/100M	10/100M

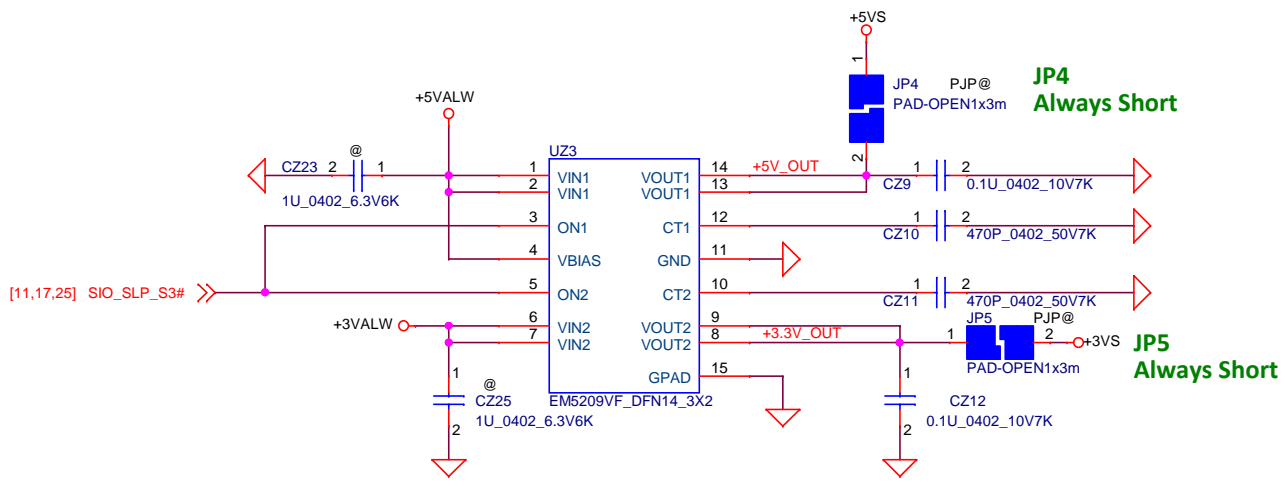


+LAN_VDD33 Rising time (10%~90%) need >0.5mS and <100mS.

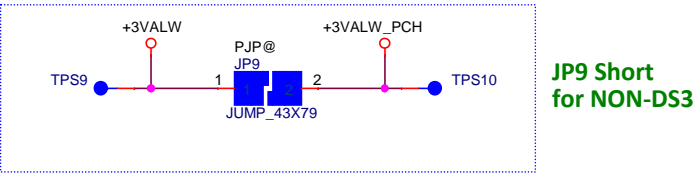
LAN TransFormer 10/100M



+5VS/+3VS for System



+3VALW_PCH for System



JP9 Short
for NON-DS3

PROPRIETARY NOTE: THIS SHEET OF ENGINEERING DRAWING AND SPECIFICATIONS CONTAINS CONFIDENTIAL TRADE SECRET AND OTHER PROPRIETARY INFORMATION OF DELL INC. ("DELL") THIS DOCUMENT MAY NOT BE TRANSFERRED OR COPIED WITHOUT THE EXPRESS WRITTEN AUTHORIZATION OF DELL. IN ADDITION, NEITHER THIS SHEET NOR THE INFORMATION IT CONTAINS WAY BE USED BY OR DISCLOSED TO ANY THIRD PARTY WITHOUT DELL'S EXPRESS WRITTEN CONSENT.

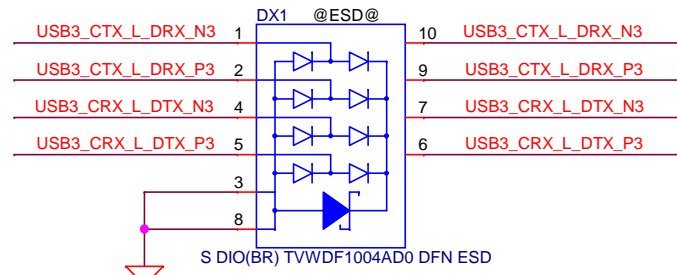
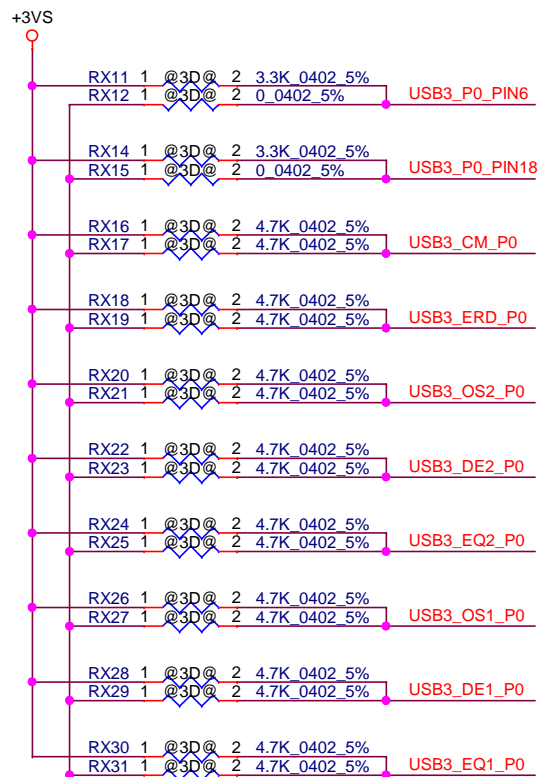
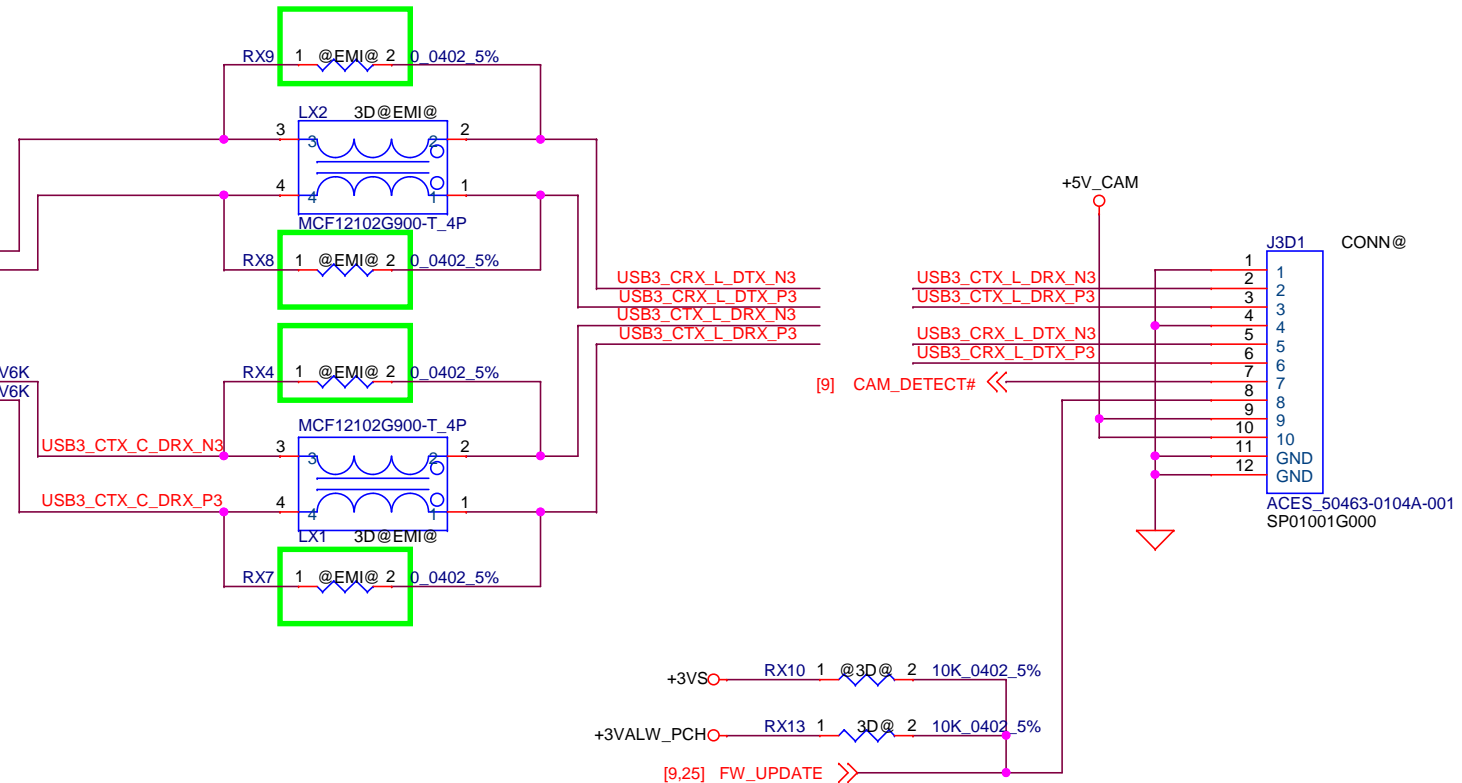
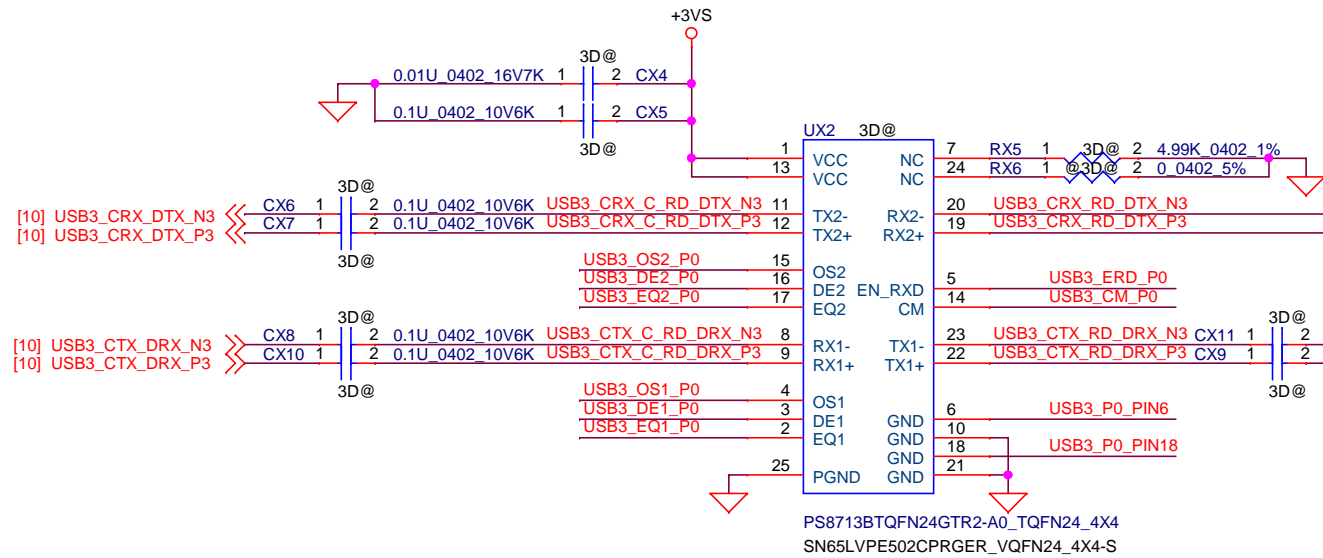
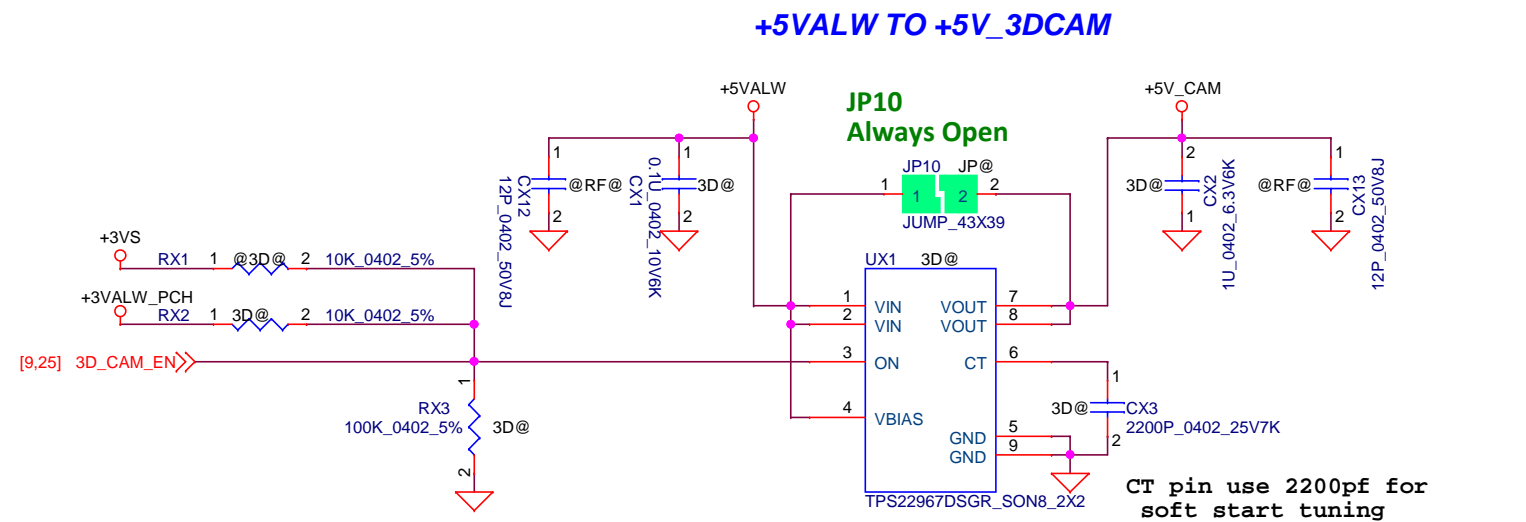


DELL CONFIDENTIAL/PROPRIETARY

Compal Electronics, Inc.

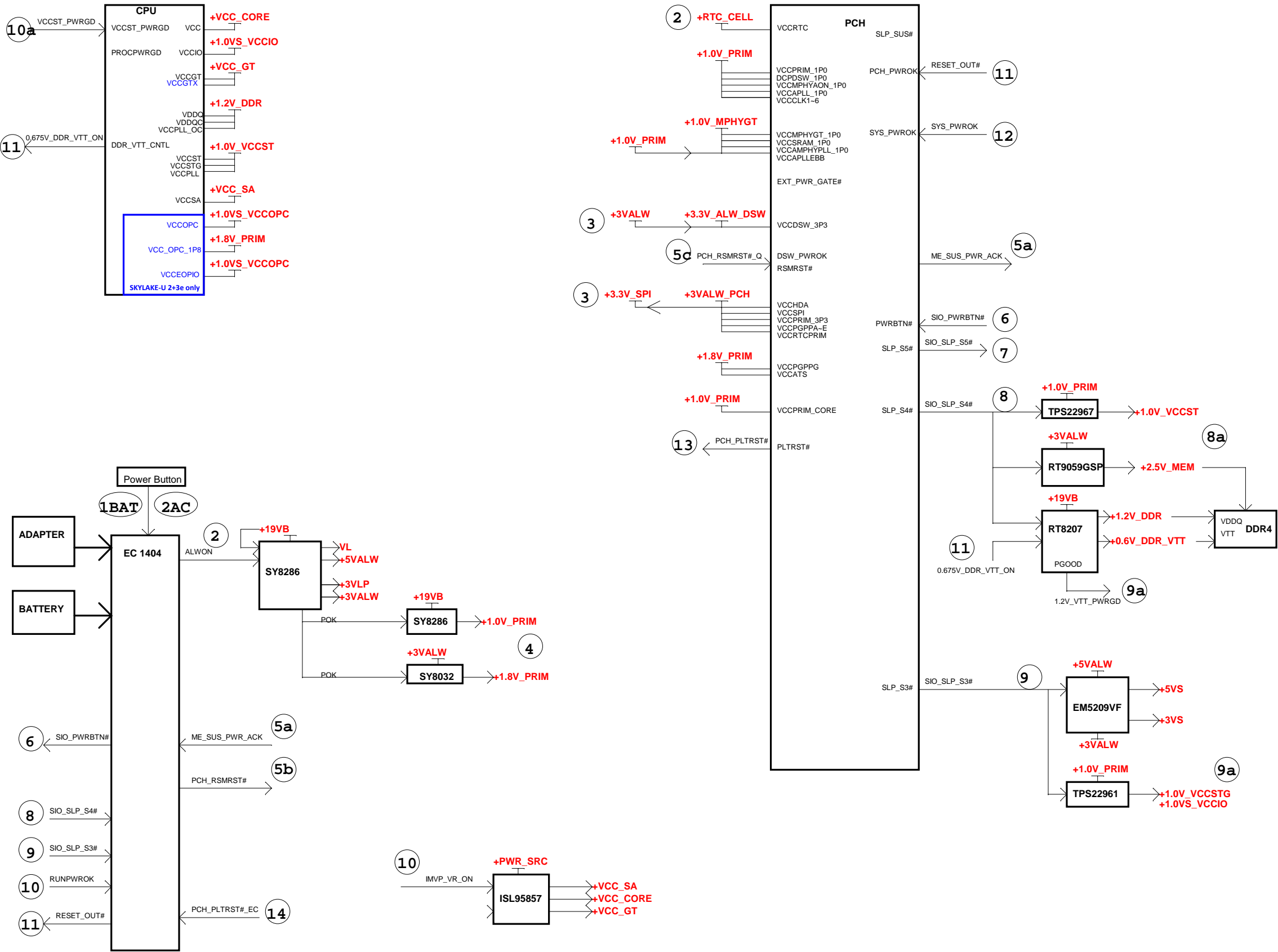
Title				
DC to DC				
Size	Document Number			Rev
	LA-D805P			A00
Date:	Tuesday, June 21, 2016	Sheet	36 of 61	

Pin	Function	Spec	schematic netname	3Vs	GND
1	VDD	VCC	Same		
2	B_EQ0	EQ1	LL: 9.5dB (default) LH: 13dB HL: 4.5dB HH: 7.7 dB	USB3_EQ1_P0	RI23 @ RI32 @
3	DE0	DE1	LL: 3.5dB (default) LH: no DE HL: 2.7dB HH: 5 dB	USB3_DE1_P0	RI26 @ RI35 @
4	EQ1	OS1	LL: 9.5dB LH: 13dB HL: 4.5dB HH: 7.7 dB	USB3_OS1_P0	RI22 @ RI40 @
5	PD#	EN_RXD	it can be left open	USB3_ERD_P0	RI44 @ RI48 @
6	B_DE1	GND	LL: 3.5dB (default) LH: no DE HL: 2.7dB HH: 5 dB	USB3_P0_PIN6	RI53 @ RI49 @
7	REXT	NC	4.99K		RI56 4.99K
8	B_inn	RX1-	Same		
9	B_inn	RX1+	Same		
10	GND	GND	Same		
11	A_OUTn	TX2-	Same		
12	A_OUTp	TX2+	Same		
13	VDD	VCC	Same		
14	TST/NC	CM	4.7K ohm resistor for performance adjustment	USB3_CM_P0	RI42 @ RI46 @
15	A_EQ1	OS2	LL: 9.5 dB (default) LH: 13 dB	USB3_OS2_P0	RI19 @ RI87 @
16	A_DE0	DE2	LL: 3.5dB (default) LH: no DE HL: 2.7dB HH: 5 dB	USB3_DE2_P0	RI20 @ RI31 @
17	A_EQ0	EQ2	LL: 9.5 dB (default) LH: 13 dB	USB3_EQ2_P0	RI21 @ RI36 @
18	A_DE1	GND	LL: 3.5dB (default) LH: no DE HL: 2.7dB HH: 5 dB	USB3_P0_PIN18	RI52 @ RI50 @
19	A_inn	RX2+	Same		
20	A_inn	RX2-	Same		
21	GND	GND	Same		
22	B_OUTp	TX1+	Same		
23	B_OUTn	TX1-	Same		
24	I2C_EN	NC	this pin can be NC or connected to GND	NC	RI57 @



Security Classification	Compal Secret Data			Compal Electronics, Inc.	
Issued Date	2015/07/09	Deciphered Date	2016/07/31	Title	3D CAMERA
THIS SHEET OF ENGINEERING DRAWING IS THE PROPRIETARY PROPERTY OF COMPAL ELECTRONICS, INC. AND CONTAINS CONFIDENTIAL AND TRADE SECRET INFORMATION. THIS SHEET MAY NOT BE TRANSFERRED FROM THE CUSTODY OF THE COMPETENT DIVISION OF R&D DEPARTMENT EXCEPT AS AUTHORIZED BY COMPAL ELECTRONICS, INC. NEITHER THIS SHEET NOR THE INFORMATION IT CONTAINS MAY BE USED BY OR DISCLOSED TO ANY THIRD PARTY WITHOUT PRIOR WRITTEN CONSENT OF COMPAL ELECTRONICS, INC.				Document Number	LA-D801P
WWW.AliSaler.Com				Date:	Tuesday, June 21, 2016
				Sheet	37 of 61

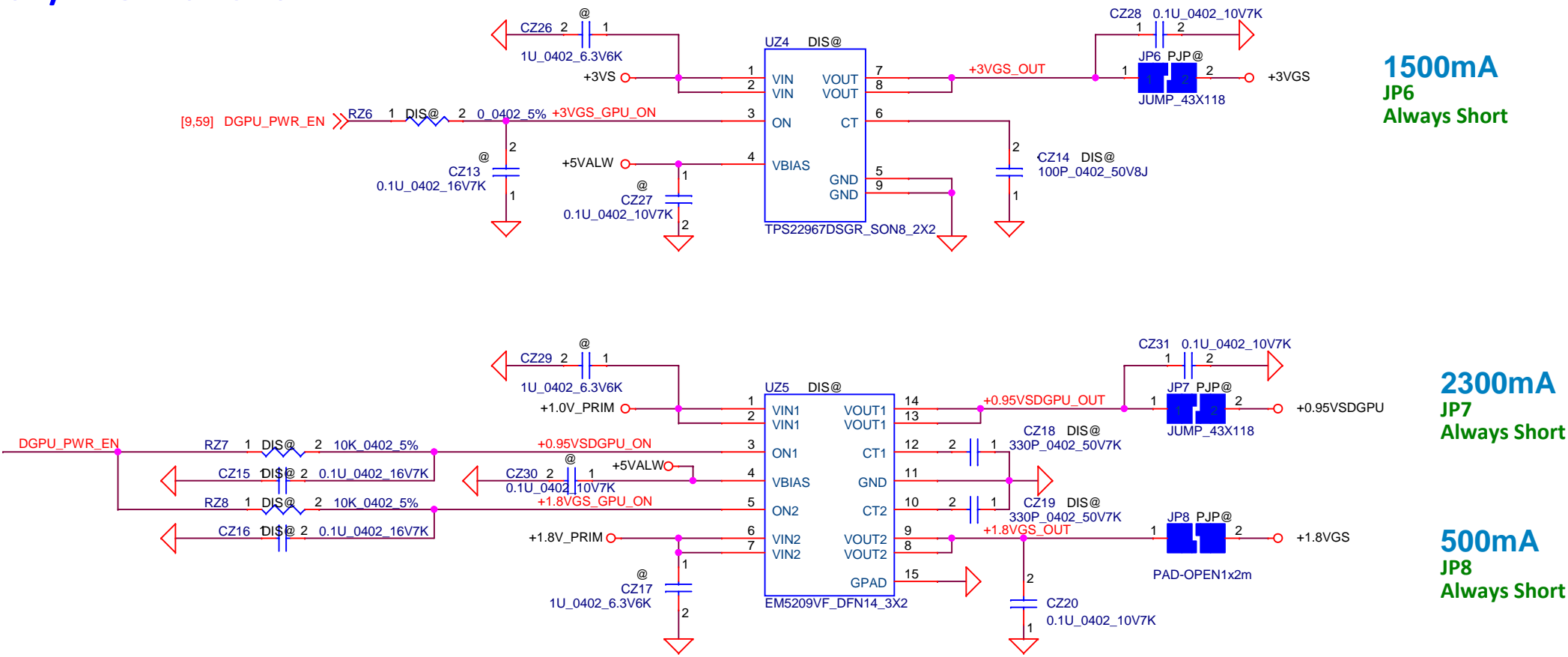
Timing Diagram for S5 to S0 mode



DELL CONFIDENTIAL/PROPRIETARY

Compal Electronics, Inc.			
Power Sequence			
Rev	A00		
Doc Number	LA-D801P		
Date	Tuesday, June 21, 2016		
Sheet	38	of	61

+3V/+0.95V/+1.8V for GPU



UV1

SA000098V1L

M1_70_G5@

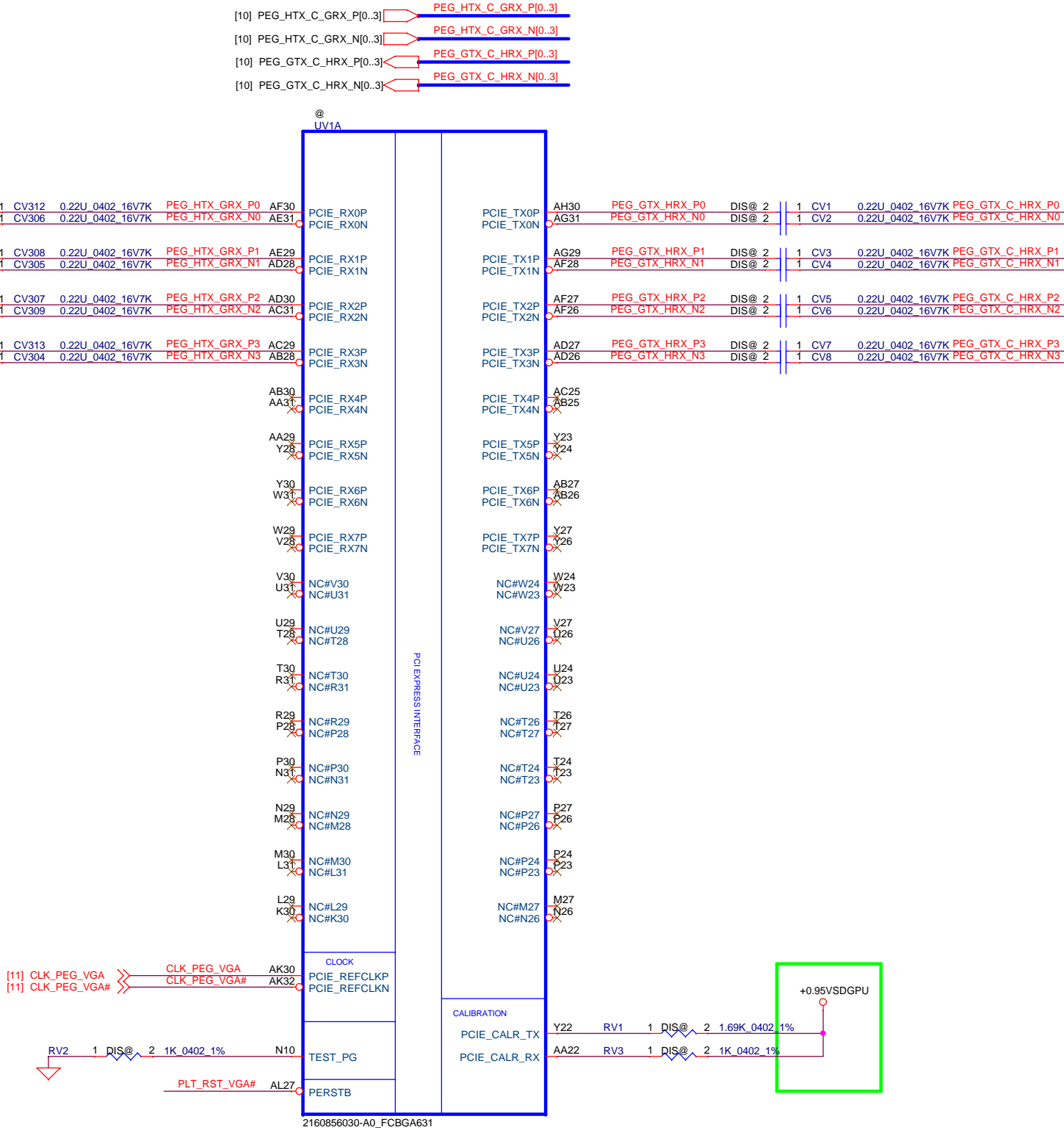
S IC 216-0889-018 A0 R16M-M1-70 A31!

UV1

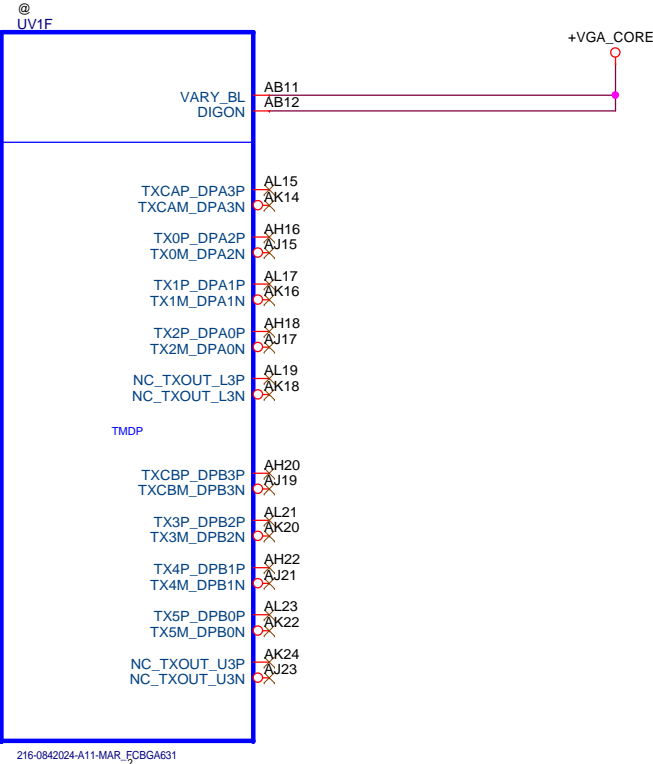
SA000098V2L

M1_70_D3@

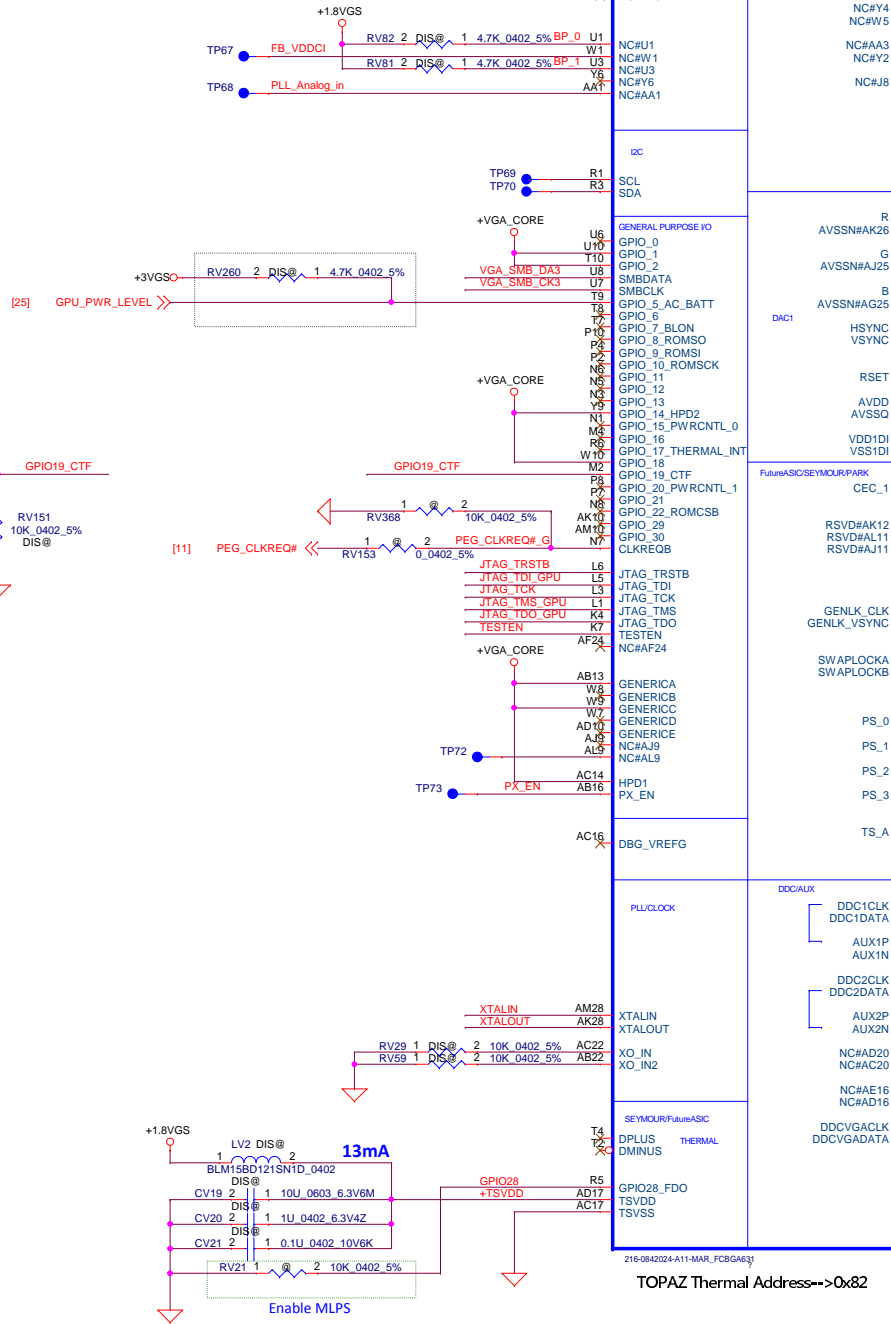
S IC 216-0864-032 A0 R16M-M1-70 0FD



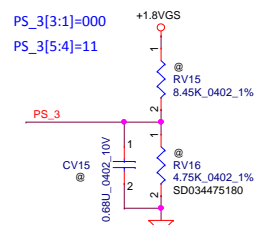
No Use GPU Display Port output



Security Classification		Compal Secret Data		Compal Electronics, Inc.	
Issued Date	2015/07/09	Deciphered Date	2016/07/31	Title	MESO_(1/5)_PCIE/DP
THIS SHEET OF ENGINEERING DRAWING IS THE PROPRIETARY PROPERTY OF COMPAL ELECTRONICS, INC. AND CONTAINS CONFIDENTIAL AND TRADE SECRET INFORMATION. THIS SHEET MAY NOT BE TRANSFERRED FROM THE CUSTODY OF THE COMPETENT DIVISION OF R&D DEPARTMENT EXCEPT AS AUTHORIZED BY COMPAL ELECTRONICS, INC. NEITHER THIS SHEET NOR THE INFORMATION IT CONTAINS MAY BE USED BY OR DISCLOSED TO ANY THIRD PARTY WITHOUT PRIOR WRITTEN CONSENT OF COMPAL ELECTRONICS, INC.				Size Custom	Document Number LA-D801P
				Date: Tuesday, June 21, 2016	Rev A00
				Sheet 40	of 61



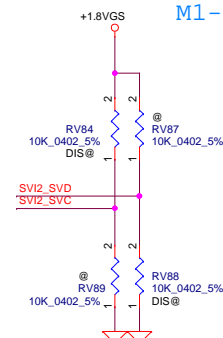
Capacitor Divider Lookup Lable	
Cap (nF)	Bitd [5:4]
680nF	00
82nF	01
10nF	10
NC	11



Strap Name :

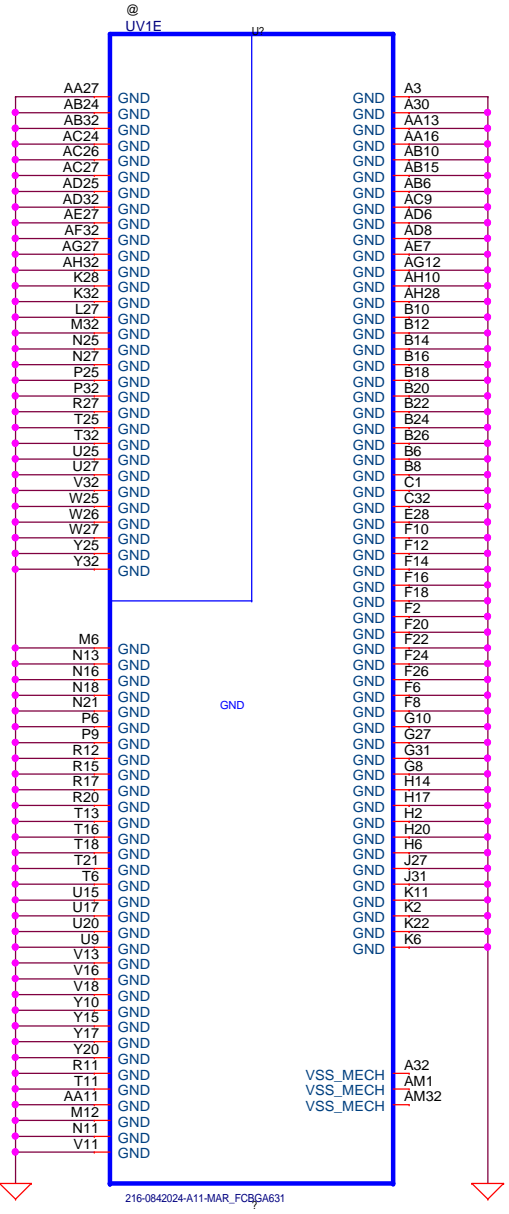
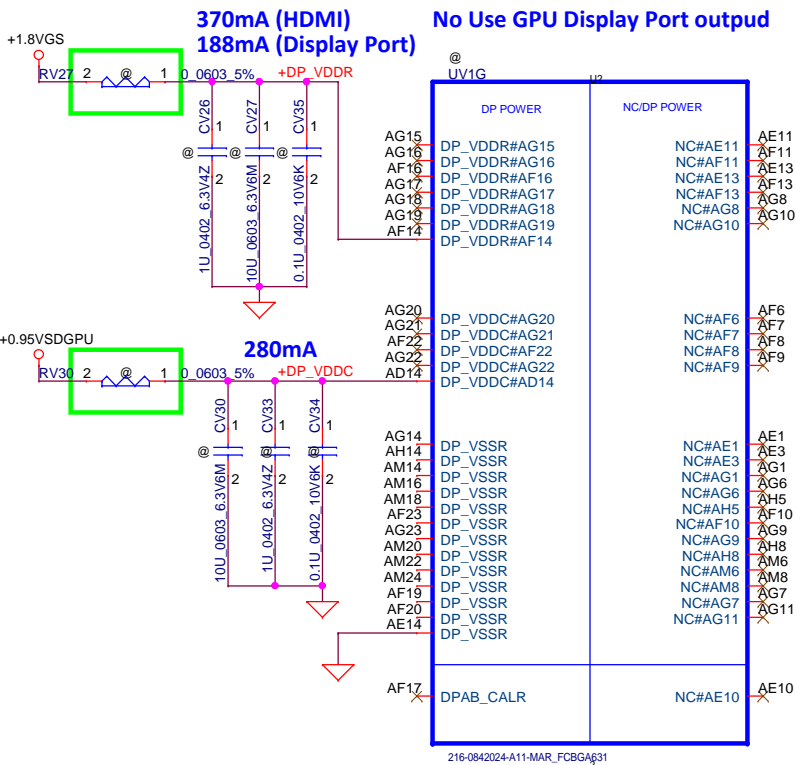
- PS_3[1] BOARD_CONFIG[0] (Memory ID)
- PS_3[2] BOARD_CONFIG[1] (Memory ID)
- PS_3[3] BOARD_CONFIG[2] (Memory ID)
- PS_3[4] AUD_PORT_CONN_PINSTRAP[1]
- PS_3[5] AUD_PORT_CONN_PINSTRAP[2]

VRAM Type
Need reference
X76 Schematic



SVC	SVD	Voltage Selected (V)
0	0	1.1
0	1	1.0
1	0	0.9
1	1	0.8

Security Classification		Compal Secret Data		Compal Electronics, Inc.	
Issued Date	2015/07/09	Deciphered Date	2016/07/31	Title	MESO_(2/5)_MSIC
THIS SHEET OF ENGINEERING DRAWING IS THE PROPRIETARY PROPERTY OF COMPAL ELECTRONICS, INC. AND CONTAINS CONFIDENTIAL AND TRADE SECRET INFORMATION. THIS SHEET MAY NOT BE TRANSFERRED FROM THE CUSTODY OF THE COMPETENT DIVISION OF R&D DEPARTMENT EXCEPT AS AUTHORIZED BY COMPAL ELECTRONICS, INC. NEITHER THIS SHEET NOR THE INFORMATION IT CONTAINS MAY BE USED BY OR DISCLOSED TO ANY THIRD PARTY WITHOUT PRIOR WRITTEN CONSENT OF COMPAL ELECTRONICS, INC.				Docu	Rev
				ment	Aw
				Date:	Tuesday, June 21, 2016
				Sheet	41 of 61



Security Classification		Compal Secret Data		Title		Compal Electronics, Inc.	
Issued Date	2015/07/09	Deciphered Date	2016/07/31	Size	Document Number	Custom	Rev
THIS SHEET OF ENGINEERING DRAWING IS THE PROPRIETARY PROPERTY OF COMPAL ELECTRONICS, INC. AND CONTAINS CONFIDENTIAL AND TRADE SECRET INFORMATION. THIS SHEET MAY NOT BE TRANSFERRED FROM THE CUSTODY OF THE COMPETENT DIVISION OF R&D DEPARTMENT EXCEPT AS AUTHORIZED BY COMPAL ELECTRONICS, INC. NEITHER THIS SHEET NOR THE INFORMATION IT CONTAINS MAY BE USED BY OR DISCLOSED TO ANY THIRD PARTY WITHOUT PRIOR WRITTEN CONSENT OF COMPAL ELECTRONICS, INC.				LA-D801P			A00
Date: Tuesday, June 21, 2016				Sheet	42	of	61

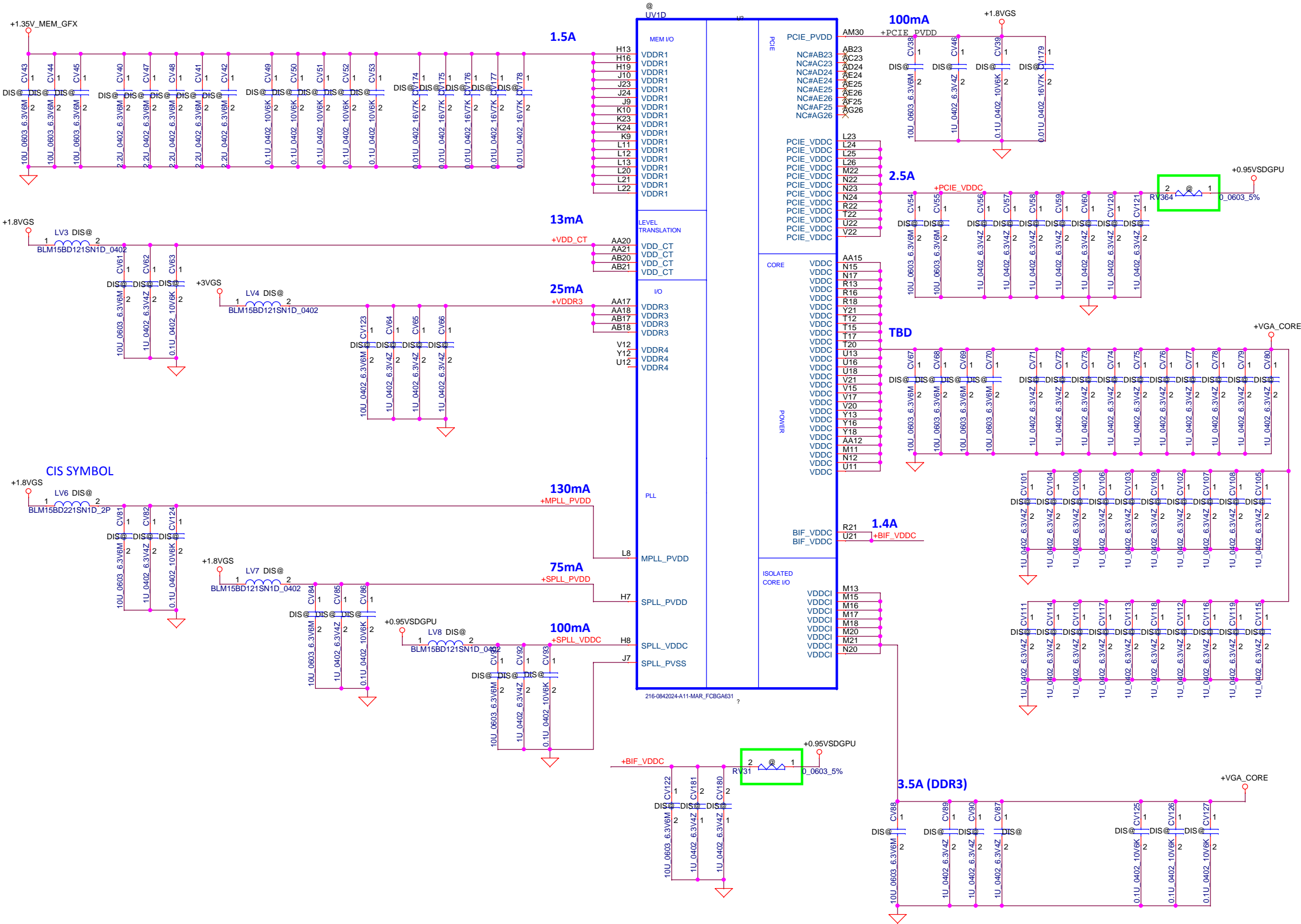
+VGA_CORE		10uF	1uF	0.1uF
VDDC	TBD	4	30	0
VDDCI	3.5A	1	3	3

+0.95VSDGPU		10uF	1uF	0.1uF
PCIE_VDDC	2.5A	2	7	0
BIF_VDDC	1.4A	1	2	0
SPLL_VDDC	100mA	1	1	1

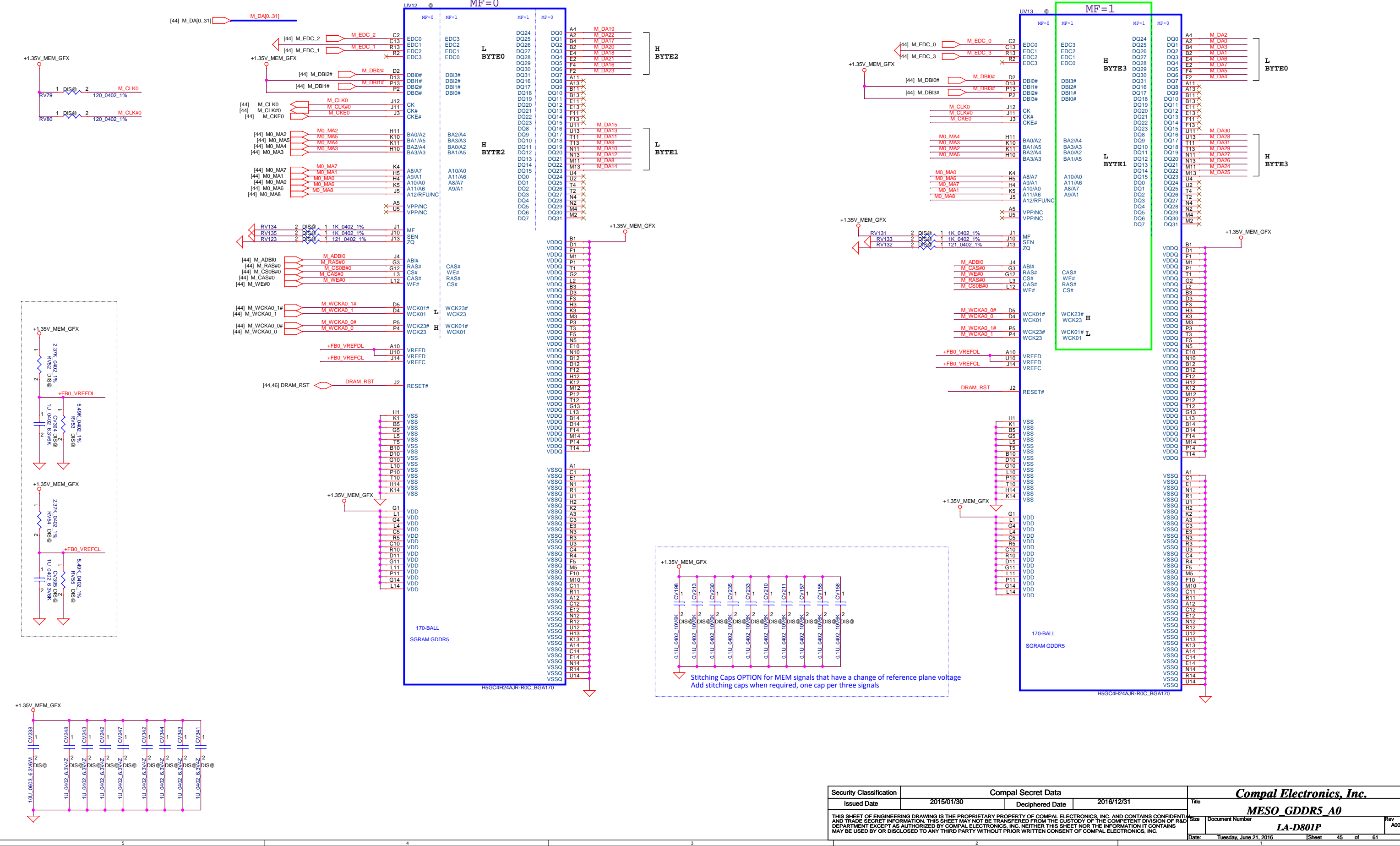
+1.35V_MEM_GFX	10uF	2.2uF	0.1uF	0.01uF
VDDR1	1.5A	3	5	5

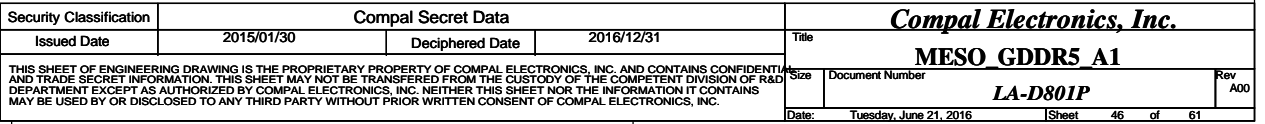
+1.8VGS		10uF	1uF	0.1uF
PCIE_PVDD	100mA	1	1	1
MPLL_PVDD	130mA	1	1	1
SPLL_PVDD	75mA	1	1	1
VDDR4	(300mA)	0	0	0
VDD_CT	13mA	1	1	1
+TSVDD	13mA	1	1	1
+DP_VDDR	0	0	0	0
+DP_VDDC	0	0	0	0

+3VGS		10uF	1uF	0.1uF
VDDR3	25mA	1	3	0



Security Classification		Compal Secret Data		Title		Compal Electronics, Inc.	
Issued Date	2015/07/09	Deciphered Date	2016/07/31	Size	Document Number	Rev	A00
THIS SHEET OF ENGINEERING DRAWING IS THE PROPRIETARY PROPERTY OF COMPAL ELECTRONICS, INC. AND CONTAINS CONFIDENTIAL AND TRADE SECRET INFORMATION. THIS SHEET MAY NOT BE TRANSFERRED FROM THE CUSTODY OF THE COMPETENT DIVISION OF R&D DEPARTMENT EXCEPT AS AUTHORIZED BY COMPAL ELECTRONICS, INC. NEITHER THIS SHEET NOR THE INFORMATION IT CONTAINS MAY BE USED BY OR DISCLOSED TO ANY THIRD PARTY WITHOUT PRIOR WRITTEN CONSENT OF COMPAL ELECTRONICS, INC.				Custom	LA-D801P		
				Date:	Tuesday, June 21, 2016	Sheet	43 of 61





1. All the ASIC supplies must reach their respective nominal voltages within 20 ms of the start of the ramp-up sequence, though a shorter ramp-up duration is preferred. The maximum slew rate on all rails is 50 mV/μs.
2. It is recommended that the 3.3-V rail ramp up first.
3. It is recommended that the 0.95-V rail reach at least 90% of its nominal value no later than 2 ms from the start of VDDC ramping up.
4. The power rails that are shared with other components on the system should be gated for the dGPU so that when the dGPU is powered down (for example AMD PowerXpress? idle state), all the power rails are removed from the dGPU. The gate circuits must meet the slew rate requirement (such as ? 50 mV/μs).
5. VDDC and VDD_CT should not ramp up simultaneously. For example, VDDC should reach 90% before VDD_CT starts to ramp up (or vice versa).
6. For power down, reversing the ramp-up sequence is recommended.

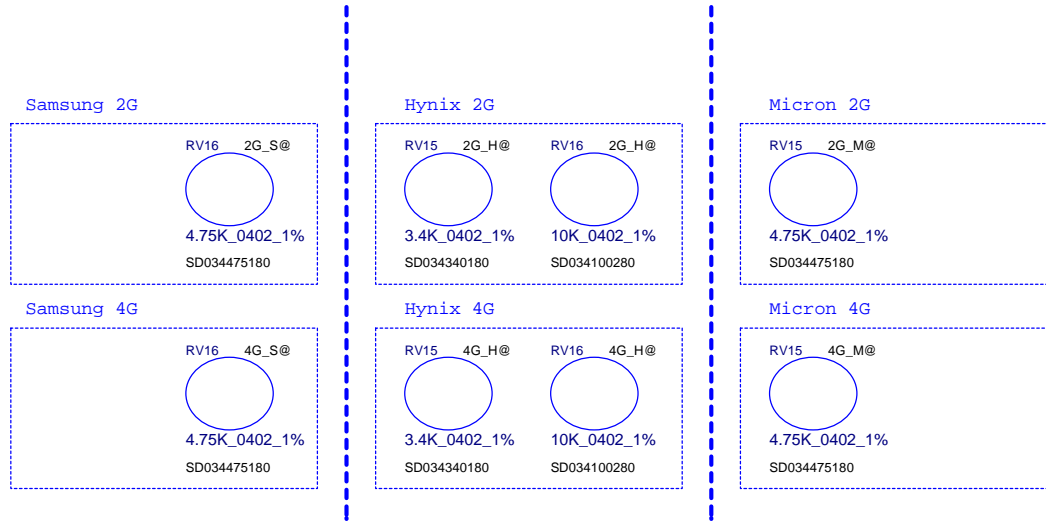
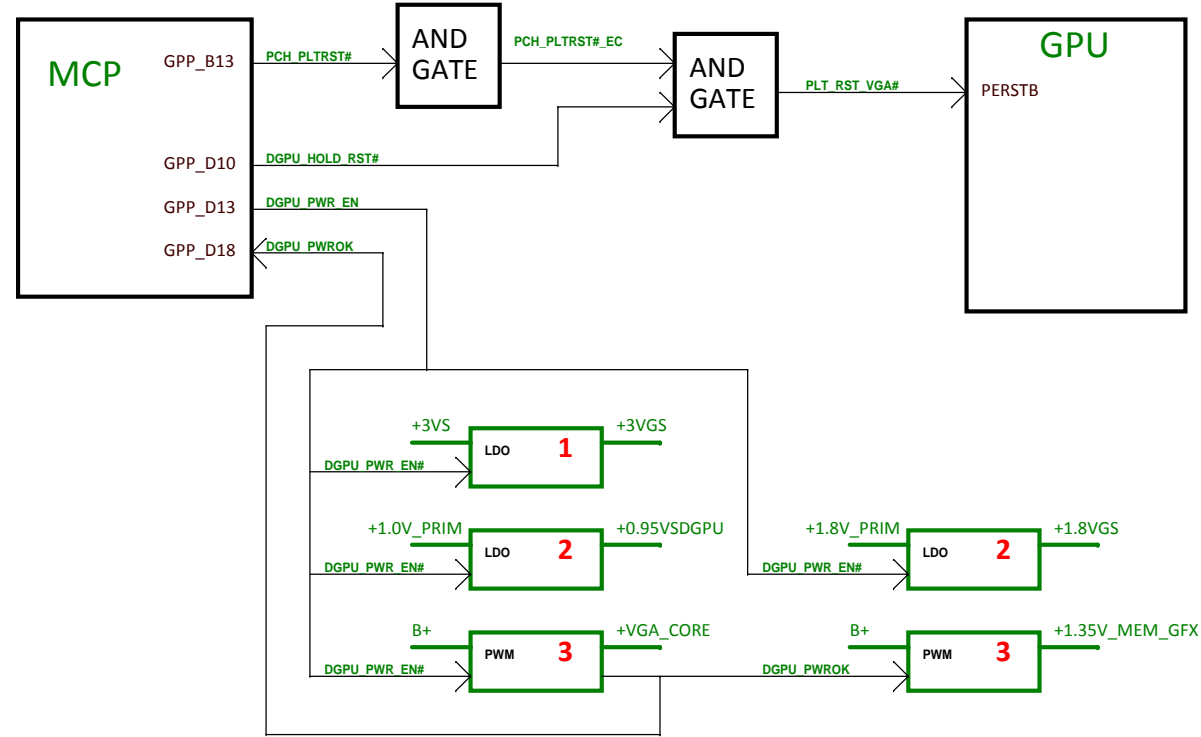
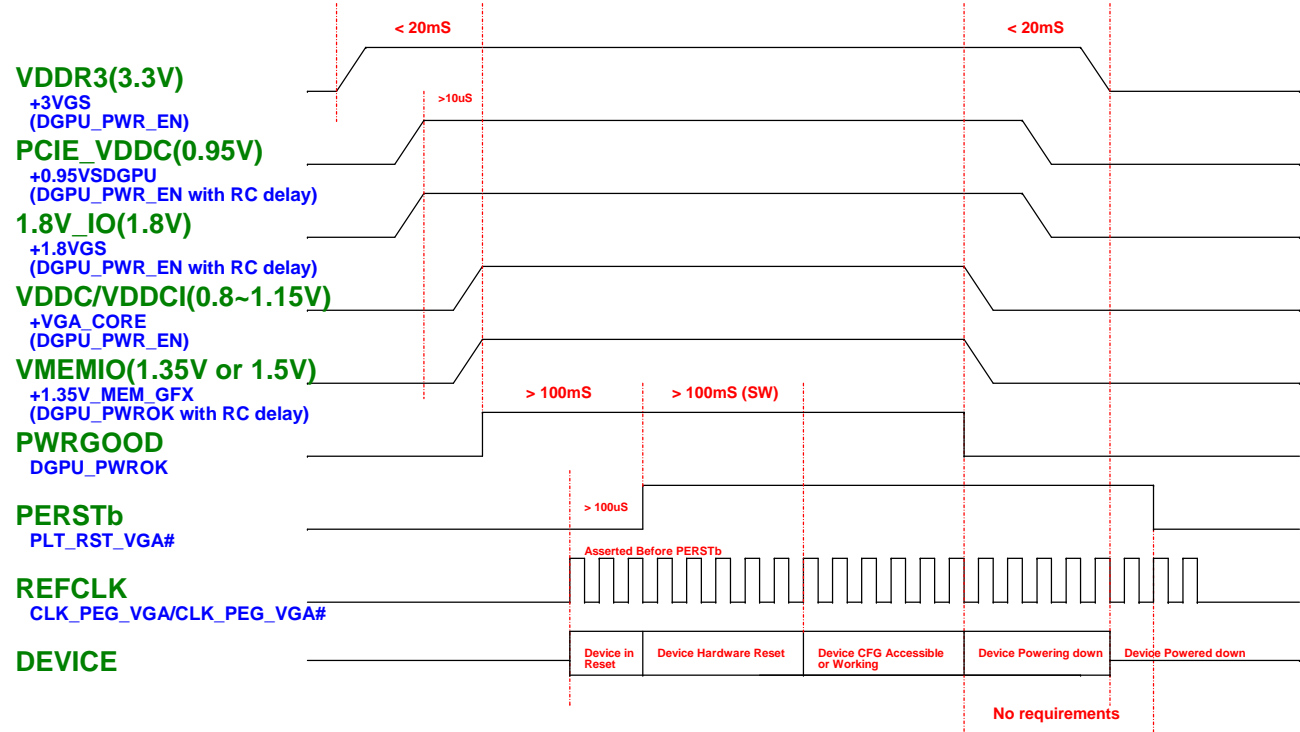


Table 3–21 Resistor Divider Lookup T.

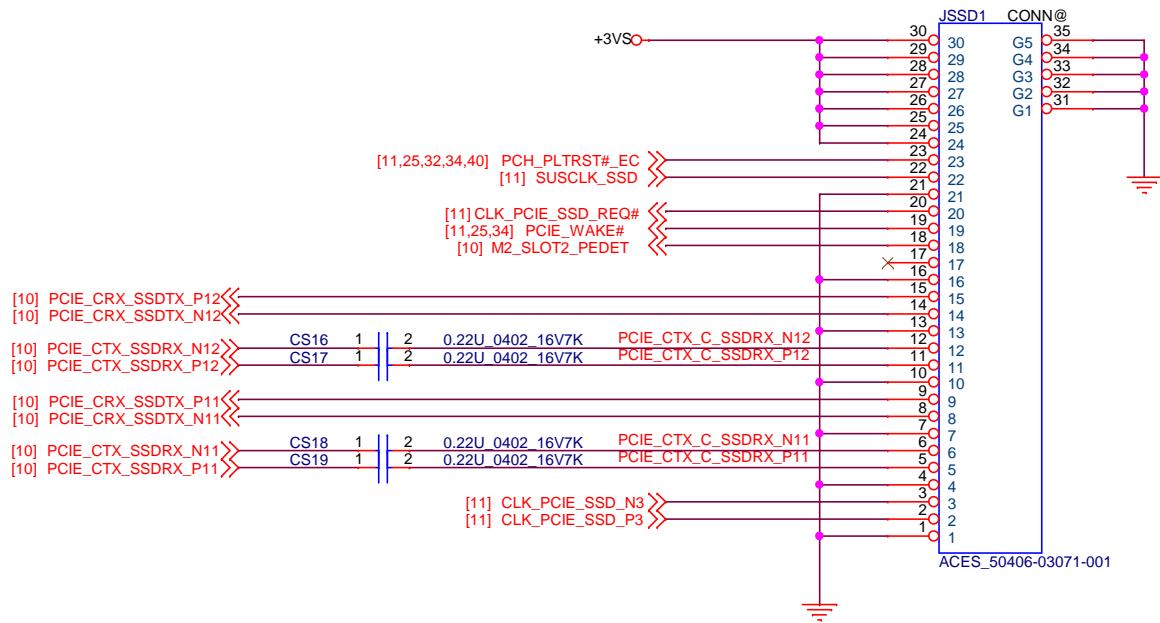
R_pu (Ω)	R_pd (Ω)	Bits [3:1]
NC	4750	000
8450	2000	001
4530	2000	010
6980	4990	011
4530	4990	100
3240	5620	101
3400	10000	110
4750	NC	111

Note: 0402 1% resistors are required.

For AMD R16M-M1-70 VRAM Only

Memory ID	4Gb R3 P/N	Vendor	Configuration	Size
000	SA00009TT1L	SAMSUNG	S IC D5 128M32 K4G41325FE-HC28 FBGA A31!	2GB
110	SA00008HQ1L	Hynix	S IC D5 128M32/3G H5GC4H24AJR-R0C A31!	2GB
111	SA00009E31L	Micron	S IC D5 128M32 EDW4032BABG-70-F-R A31!	2GB

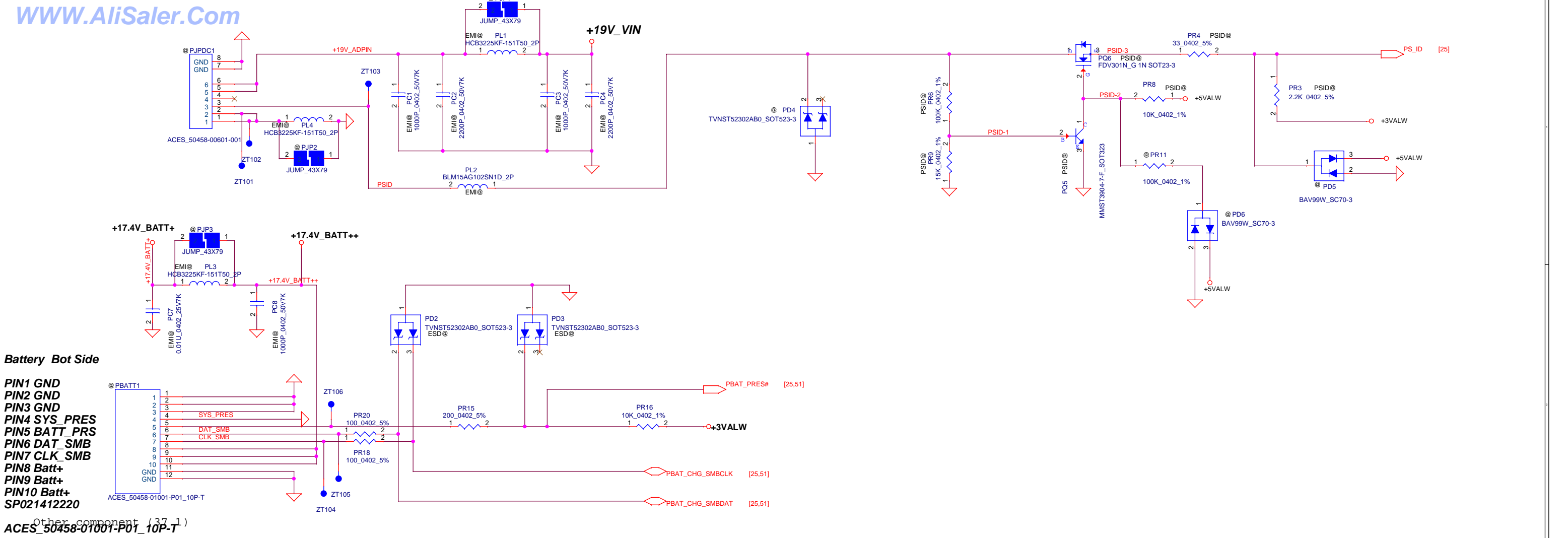
Memory ID	8Gb R3 P/N	Vendor	Configuration	Size
000	SA000092D1L	SAMSUNG	S IC D5 256M32 K4G80325FB-HC28 FBGA A31!	4GB
110	SA00009U11L	Hynix	S IC D5 256M32 H5GC8H24MJR-R0C BGA A31!	4GB
111	SA00009TV1L	Micron	S IC D5 256M32 MT51J256M32HF-70:A A31!	4GB



"M2_SLOT2_PEDET" PU 10k on DB

PEDET	Module Type
0	SATA
1	PCIE

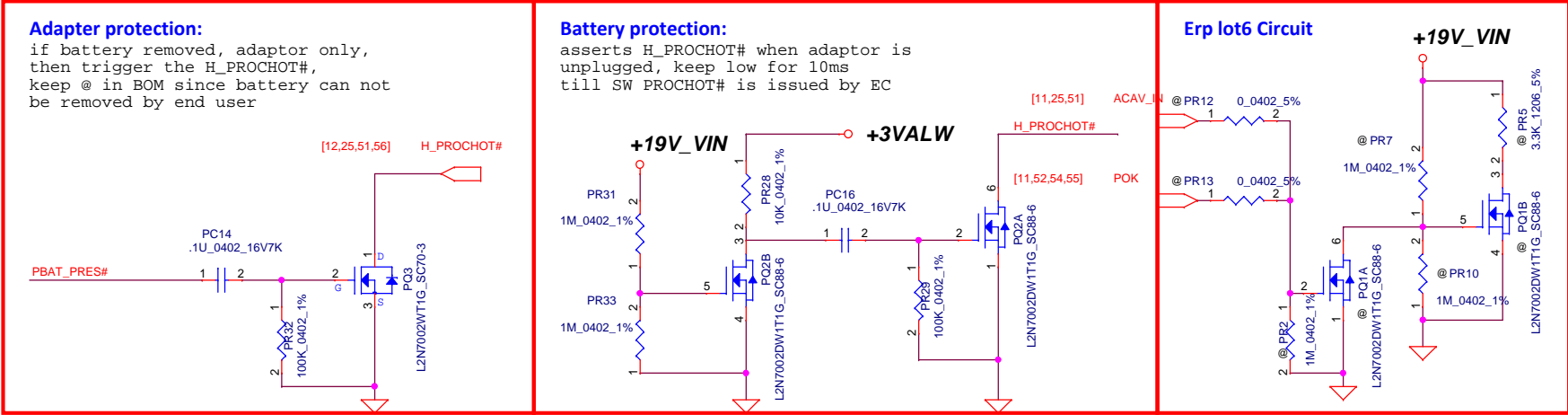
1	Design Change					
2	Item	Date	Page	Part reference	change description	Reason
3	Based on LA-D801P_0106					
4	1	2016/1/8	20	CD29	Change CD29 Pin1 Net from "H_DRAMRST#" to "DDR4_DRAMRST#"	Modify DDR4_DRAMRST# Sequence
5	2	2016/1/8	20, 21	CD27,CD57	Change CD27,CD57 Footprint	Material change, D7 H1.1 --> D2 H1.9
6	3	2016/1/8	22	H8,H9,H10,H11,H13	Modify H8,H9,H10,H11, Add H13	ME change
7	4	2016/1/8	22	TP27,TP28,TP29	Add TP27,TP28,TP29	CPU Test point
8	5	2016/1/14	22	U1,C17,R57	Change U1,C17, Add R57	Change to Stand Part
9	6	2016/1/20	9	JWDB1,RC190,RC191	Add JWDB1,RC190,RC191	Add Wm?Debug
10	7	2016/2/2	39	CZ20	Change CZ20 Pin1 Net from "+1.8VGS" to "+1.8VGS_OUT"	Layout
11	8	2016/2/2	18	L1,L2	Change L1,L2 Footprint	Material change, sourcer request
12	9	2016/2/2	30	F3	Change F3 Footprint	Material change, sourcer request
13	10	2016/2/2	18	CC61	Change CC61 Pin1 Net from "+3.3V_HDA" to "+3VALW_PCH"	follow RF test result
14	11	2016/2/2	18	CC82	Change CC82 Pin1 Net from "+1.0V_APLL" to "+1.0V_PRIM"	follow RF test result
15	12	2016/2/2	48	JSSD1	Swap SSD Pin define and cancel "SSD_DEVSLP"	For cable wiring methods
16	13	2016/3/4	35	JLAN1	JLAN1.9 --> LANGND1 JLAN1.10 --> LANGND1 JLAN1.11 --> LANGND2 JLAN1.12 --> LANGND2	HI-POT modify
					CL13.2 --> LANGND2	
17	14	2016/3/8	25, 28	UE1.113,RE64,D4.3	UE1.113 add 0 ohm then connect to D4.3	Modify LCD BITS Sequence
18	15	2016/3/10	33	RP12,LL2	HDMI_CLK#_R --> HDMI_CLK_R HDMI_DATA0#_R --> HDMI_DATA0_R HDMI_DATA0#_R_C --> HDMI_DATA0_R_C	HDMI signal Layout modify, EMI request
19	16	2016/3/16	17, 36, 39	CZ21,CZ22,CZ23,CZ24,CZ25,CZ26,CZ27,CZ28,CZ29,CZ30,CZ31	Add Capacitance close to Vin, Vbias, Vout, CT	Load Switch common design
20	17	2016/3/16	9	RC190,RC191	Add RC190,RC191 connect to GPP_A22	VRAM ID
21	18	2016/3/18	35	JLAN1	JLAN1.9 --> GND JLAN1.10 --> GND JLAN1.11 --> GND JLAN1.12 --> GND CL13.2 --> GND	HI-POT modify
22	19	2016/3/21	11, 17	DZ4,DZ5,RZ9,RC192	Reserve DZ4,DZ5,RZ9,RC192	Speed up SLP_S3# & SLP_S3# power down sequence
23	20	2016/3/22	29	JPWR1	Change JPWR1 Footprint	ME request
24	21	2016/3/22	48	JSSD1	PCIE_CRX_SSDTX_P12 --> PCIE_CRX_SSDTX_P11 PCIE_CRX_SSDTX_N12 --> PCIE_CRX_SSDTX_N11 PCIE_CTX_SSDRX_N12 --> PCIE_CTX_SSDRX_N11 PCIE_CTX_SSDRX_P12 --> PCIE_CTX_SSDRX_P11 PCIE_CTX_C_SSDRX_N12 --> PCIE_CTX_C_SSDRX_N11 PCIE_CTX_C_SSDRX_P12 --> PCIE_CTX_C_SSDRX_P11	For cable wiring methods
25	22	2016/3/22	20	CD29	Change CD29 BOM Config to @	SAMMANG DRAM issue
26	DVT2					
27	23	2016/4/22	25	UE1.30	Change LED control signal net name from "SATA_LED#_R" to "SATA_LED_EN"	EC request
28	24	2016/4/22	29	JPWR1	Change Footprint	ME request
29	25	2016/4/25	22	H6	Φ5 --> Φ5.6	ME request
30	26	2016/4/25	24	RA36,RA37	Change footprint from Bead to Resistance	EMI request
31	27	2016/4/25	45	UV3,UV4,UV5,UV6	Change footprint from "MT41J128M16TT-093_FBGGA_96P_A39" to "MT41J256M16LY-091G-N_FBGGA_96P"	DFB request, LA-D805P only
32	28	2016/5/3	29	JPWR1	Change Footprint, E-T_6915K-Q06N-00L --> JXT_FP226H-006S1BEM	ME request
33	29	2016/5/3	12	CC89	Add "1pF_0402" on "HDA_RST#"	RF request
34	Pilot					
35	30	2016/5/5	14	L2	Change Footprint, BLM15BD601SNID --> LQGH5HS4N7502D	RF request
36	31	2016/5/9		RA1,RA22,RW3,R51	Change Footprint from "R_0805" to "R0805_0ohm"	Change to Short PAD
37				RA4,RA39,RC17,RC161,RC1	Change Footprint from "R_0603" to "R0603_0ohm"	
38				RA2,RA5,RA17,RA18,RA6,F	Change Footprint from "R_0402" to "R0402_0ohm"	
39	32	2016/5/10		RB45,RE22,RE28,RE37,RE38	Change Footprint from "R_0402" to "R0402_0ohm"	Change to Short PAD
40	33	2016/5/20		LW1,L4	Change Footprint from "INPAQ_MCM1012B900F06BP_4P" to "INPAQ_MCM1012B900F06BP_4P"	Close solder mask
41	34	2016/5/20		LU2,LU3,LU5,LU6	Change Footprint from "INPAQ_HCM1012GH900BP_4P" to "INPAQ_HCM1012GH900BP_4P-NP"	Close solder mask
42	35	2016/5/20		RU1,RU2,RX4,RX7,RU7,RX	Change Footprint from "R_0402" to "R0402-NPM"	Close solder mask
43	36	2016/5/20	30	JKB1	Change Footprint from "ACES_50699-03041-P01_30P" to "STARC_132C30-100020-A2-R_30P"	DFB request
44	37	2016/5/30	11	RC81	Del RC81	For Layout optimally
45	38	2016/6/13	33	LI1,LI2,LI3,LI4	Change Footprint from "INPAQ_HCM1012GH900BP_4P" to "INPAQ_HCM1012GH900BP_4P-NP"	Close solder mask
46	39	2016/6/15	7	CC90	Add CC90	Reserve for fine-tune +0.6V_DDR_VTT sequence
47	40	2016/6/15		RC75,RE45	Change Footprint from "R0402_0ohm" to "R_0402"	Change to 0 Ohm
48	41	2016/6/15		RW3	Change Footprint from "R0805_0ohm" to "R_0805"	Reserve for BT lose issue
49	42	2016/6/15		RW5	Change Footprint from "R_0402" to "R_0805"	



Battery Bot Side

- PIN1 GND
- PIN2 GND
- PIN3 GND
- PIN4 SYS_PRES
- PIN5 BATT_PRS
- PIN6 DAT_SMB
- PIN7 CLK_SMB
- PIN8 Batt+
- PIN9 Batt+
- PIN10 Batt+
- SP021412220

Other component (37-1)
ACES_50458-01001-P01_10P-T

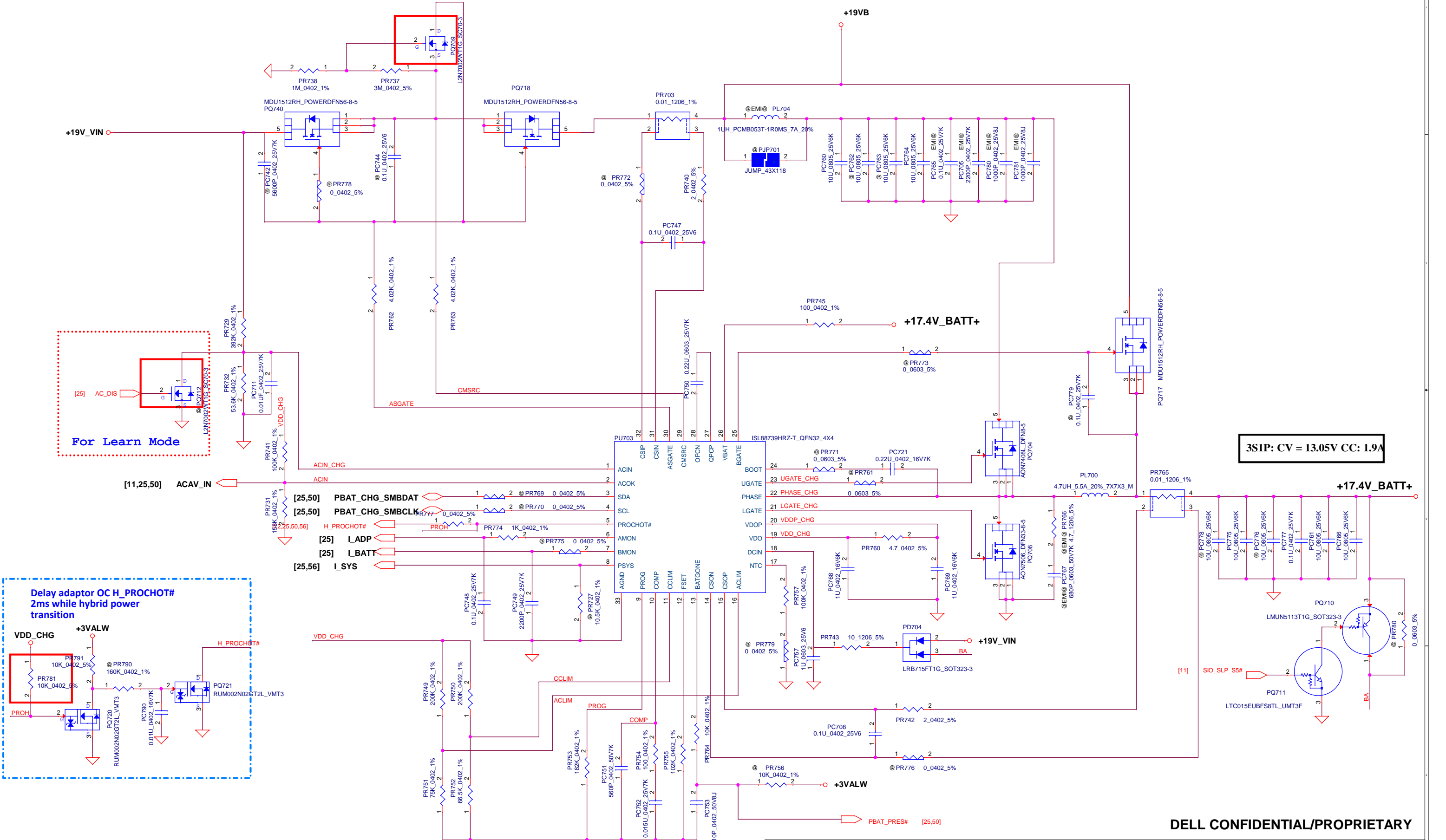


DELL CONFIDENTIAL/PROPRIETARY

Security Classification		Compal Secret Data		Title	
Issued Date	2015/03/23	Deciphered Date	2014/12/15	Compal Electronics, Inc.	
THIS SHEET OF ENGINEERING DRAWING IS THE PROPRIETARY PROPERTY OF COMPAL ELECTRONICS, INC. AND CONTAINS CONFIDENTIAL AND TRADE SECRET INFORMATION. THIS SHEET MAY NOT BE TRANSFERRED FROM THE CUSTODY OF THE COMPETENT DIVISION OF R&D DEPARTMENT EXCEPT AS AUTHORIZED BY COMPAL ELECTRONICS, INC. NEITHER THIS SHEET NOR THE INFORMATION IT CONTAINS MAY BE USED BY OR DISCLOSED TO ANY THIRD PARTY WITHOUT PRIOR WRITTEN CONSENT OF COMPAL ELECTRONICS, INC.				PWR_DCIN/BATT CONN/OTP	
Size	Document Number	Rev		X00	
Date:	Tuesday, June 21, 2016	Sheet	50	of	61

Iada=0~3.33A(65W)
Iada=0~2.30A(45W)

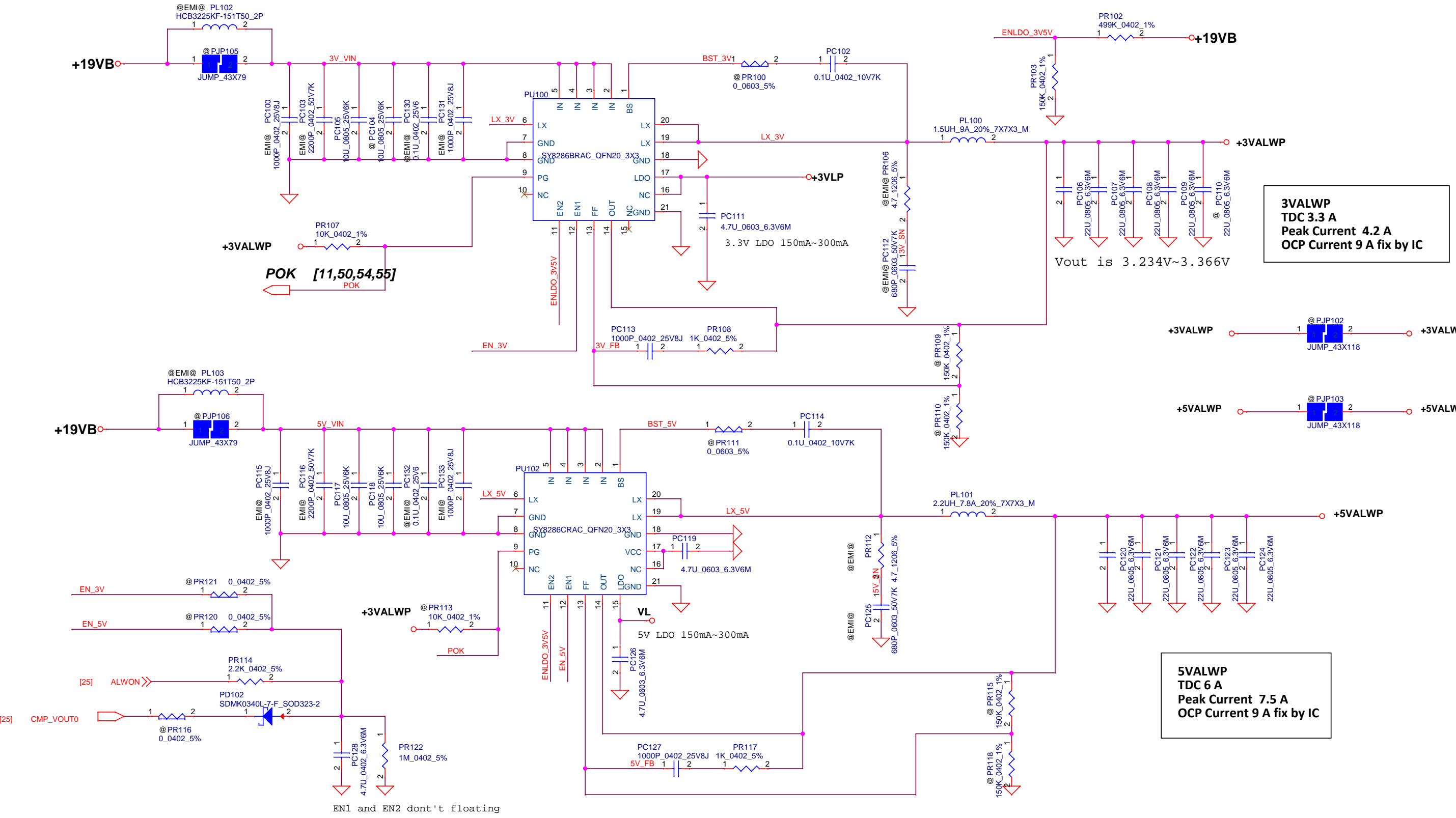
$ADP_I = 32 \cdot I_{adapter} \cdot R_{sense}$



3S1P: CV = 13.05V CC: 1.9A

DELL CONFIDENTIAL/PROPRIETARY

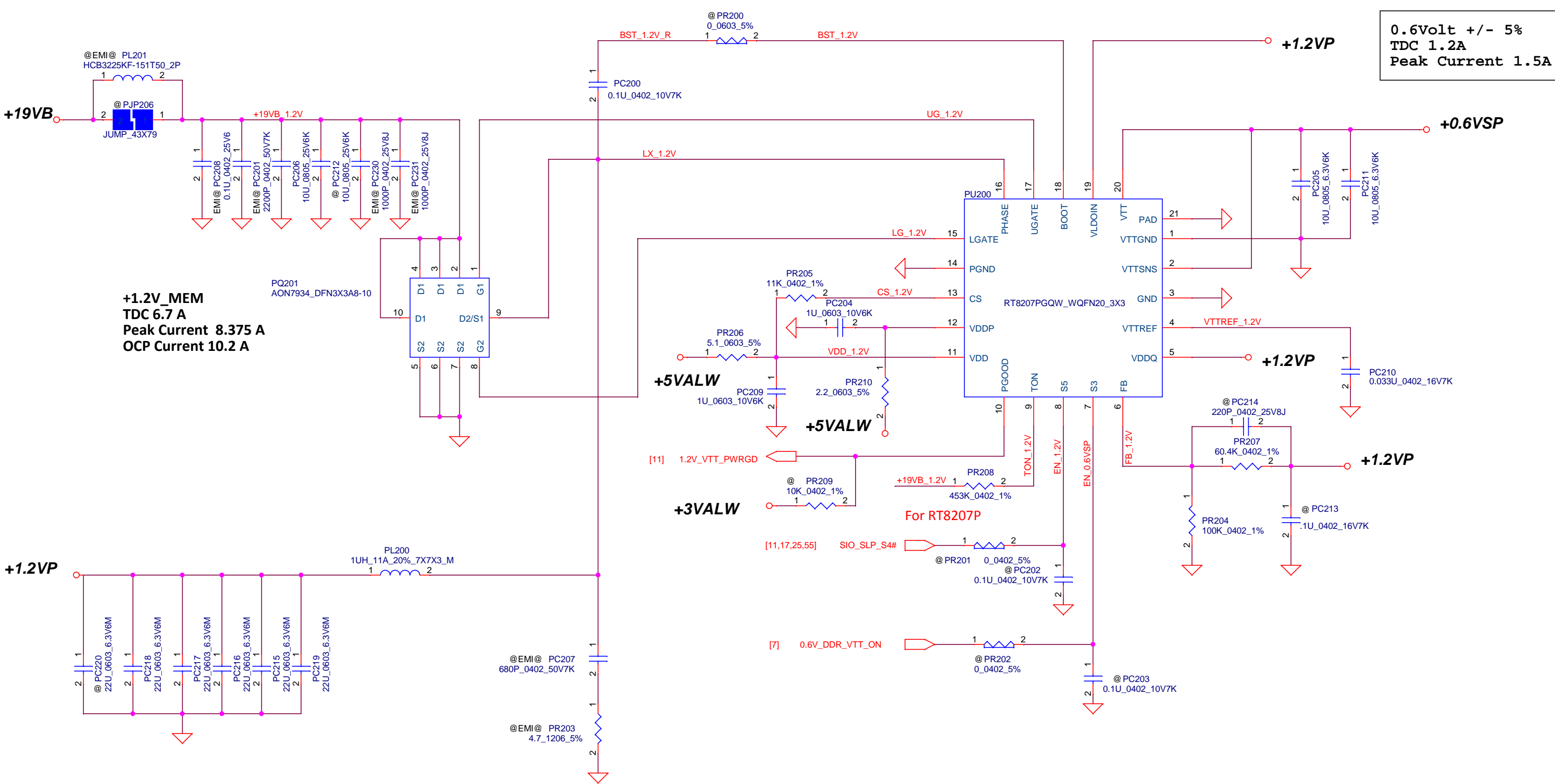
Security Classification		Compal Secret Data		Compal Electronics, Inc.	
Issued Date	2015/03/23	Deciphered Date	2014/12/15	Title	PWR_CHARGER
THIS SHEET OF ENGINEERING DRAWING IS THE PROPRIETARY PROPERTY OF COMPAL ELECTRONICS, INC. AND CONTAINS CONFIDENTIAL AND TRADE SECRET INFORMATION. THIS SHEET MAY NOT BE TRANSFERRED FROM THE CUSTODY OF THE COMPETENT DIVISION OF R&D DEPARTMENT EXCEPT AS AUTHORIZED BY COMPAL ELECTRONICS, INC. NEITHER THIS SHEET NOR THE INFORMATION IT CONTAINS MAY BE USED BY OR DISCLOSED TO ANY THIRD PARTY WITHOUT PRIOR WRITTEN CONSENT OF COMPAL ELECTRONICS, INC.				Size	Document Number
				Date	Tuesday, June 21, 2016
				Sheet	51 of 61



DELL CONFIDENTIAL/PROPRIETARY

Compal Electronics, Inc.			
Title PWR_3.3VALWP/5VALWP			
Size	Document Number	Rev	
	LA-D801P	X00	
Date:	Tuesday, June 21, 2016	Sheet	52 of 61

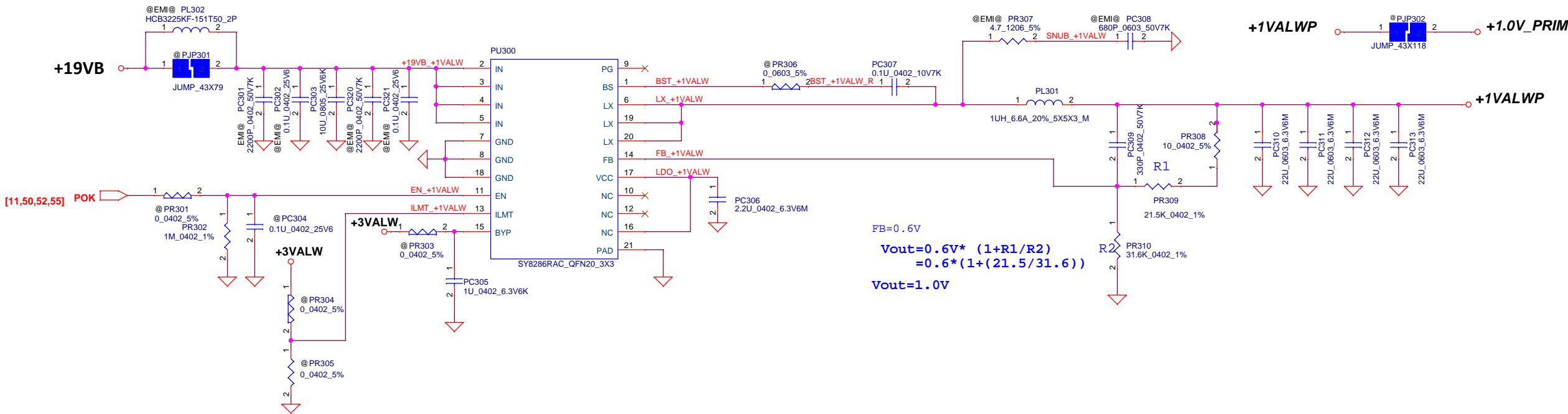
THIS SHEET OF ENGINEERING DRAWING IS THE PROPRIETARY PROPERTY OF COMPAL ELECTRONICS, INC. AND CONTAINS AND TRADE SECRET INFORMATION. THIS SHEET MAY NOT BE TRANSFERRED FROM THE CUSTODY OF THE COMPETENT DIVISION DEPARTMENT EXCEPT AS AUTHORIZED BY COMPAL ELECTRONICS, INC. NEITHER THIS SHEET NOR THE INFORMATION IT CONTAINS MAY BE USED BY OR DISCLOSED TO ANY THIRD PARTY WITHOUT PRIOR WRITTEN CONSENT OF COMPAL ELECTRONICS, INC.



Mode	S3	S5	+1.2V_MEN	+V_DDR_REF	+0.6V_P
S5	L	L	off	off	off
S3	L	H	on	on	off
S0	H	H	on	on	on

DELL CONFIDENTIAL/PROPRIETARY

Security Classification		Compal Secret Data		Title	
Issued Date	2015/03/23	Deciphered Date	2014/12/15	PWR_+1.2V_MEN/+0.6V_DDR_VTT	
THIS SHEET OF ENGINEERING DRAWING IS THE PROPRIETARY PROPERTY OF COMPAL ELECTRONICS, INC. AND CONTAINS CONFIDENTIAL AND TRADE SECRET INFORMATION. THIS SHEET MAY NOT BE TRANSFERRED FROM THE CUSTODY OF THE COMPETENT DIVISION OF R&D DEPARTMENT EXCEPT AS AUTHORIZED BY COMPAL ELECTRONICS, INC. NEITHER THIS SHEET NOR THE INFORMATION IT CONTAINS MAY BE USED BY OR DISCLOSED TO ANY THIRD PARTY WITHOUT PRIOR WRITTEN CONSENT OF COMPAL ELECTRONICS, INC.				Size Custom	Rev X00
Date: Tuesday, June 21, 2016		Sheet 53 of 61			



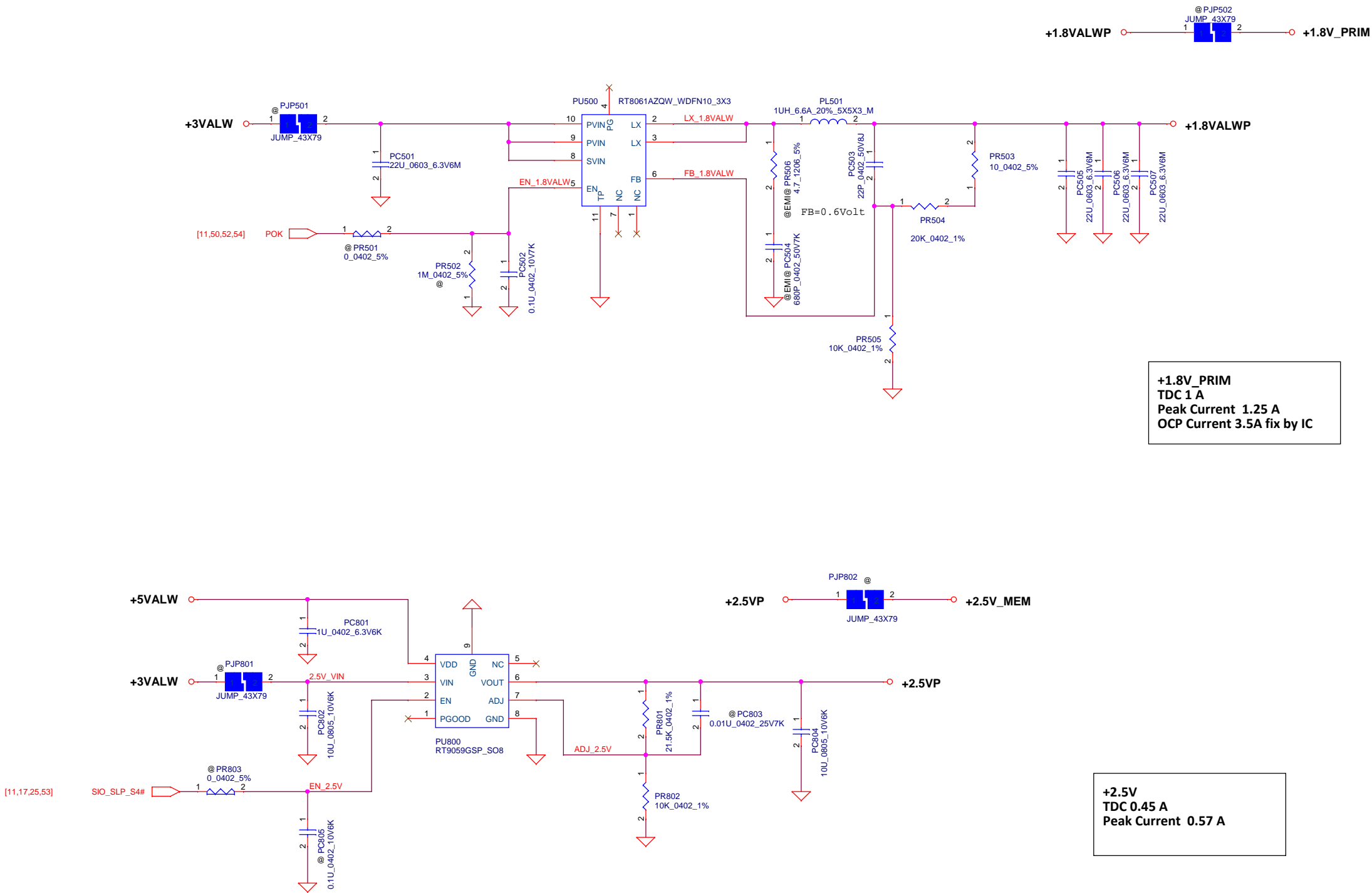
The current limit is set to 6A, 9A or 12A when this pin is pull low, floating or pull high

OCP setting	ILMT(pin3)
6A	Pull low
9A	Floating
12A	Pull high

$$V_{out} = 0.6V \cdot \left(1 + \frac{R1}{R2}\right)$$
$$V_{out} = 0.6V \cdot \left(1 + \frac{21.5K}{31.6K}\right)$$
$$V_{out} = 1.0V$$

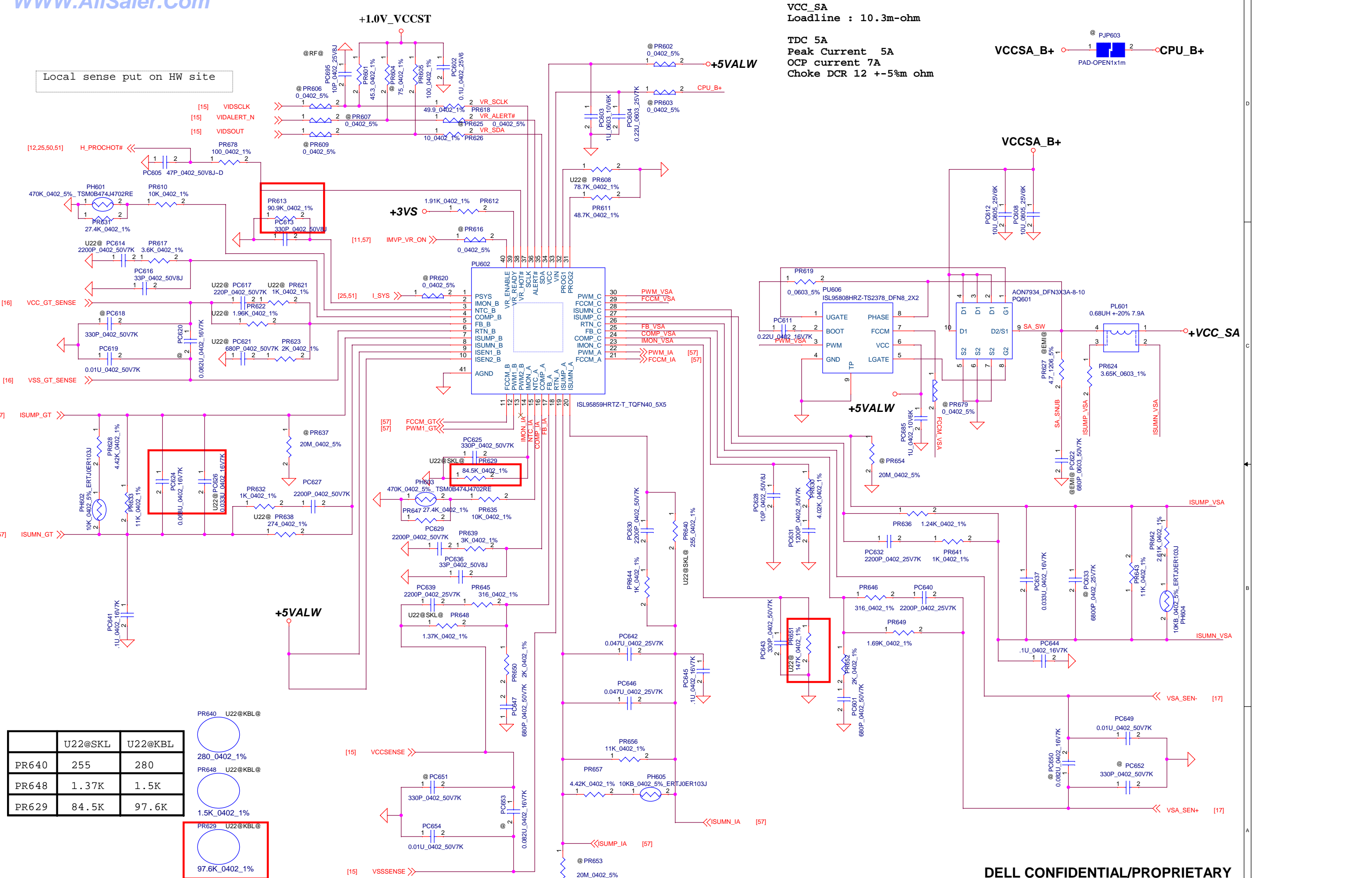
+1.0V_PRIM
TDC 6 A
Peak Current 8.6 A
OCP Current 12 A Fix by IC
TYP MAX
Choke DCR 11.0mohm , 12.0mohm

DELL CONFIDENTIAL/PROPRIETARY



DELL CONFIDENTIAL/PROPRIETARY

Security Classification		Compal Secret Data		Title	
Issued Date	2015/03/23	Deciphered Date	2014/12/15	Compal Electronics, Inc.	
THIS SHEET OF ENGINEERING DRAWING IS THE PROPRIETARY PROPERTY OF COMPAL ELECTRONICS, INC. AND CONTAINS CONFIDENTIAL AND TRADE SECRET INFORMATION. THIS SHEET MAY NOT BE TRANSFERRED FROM THE CUSTODY OF THE COMPETENT DIVISION OF R&D DEPARTMENT EXCEPT AS AUTHORIZED BY COMPAL ELECTRONICS, INC. NEITHER THIS SHEET NOR THE INFORMATION IT CONTAINS MAY BE USED BY OR DISCLOSED TO ANY THIRD PARTY WITHOUT PRIOR WRITTEN CONSENT OF COMPAL ELECTRONICS, INC.				PWR +1.8V_PRIM and +2.5V	
Size C		Document Number			Rev X00
Date:		Tuesday, June 21, 2016		Sheet 55	of 61



DELL CONFIDENTIAL/PROPRIETARY

Security Classification		Compal Secret Data		Compal Electronics, Inc.							
Issued Date	2015/03/23		Deciphered Date	2014/12/15			Title	PWR_+VCC_SA			
THIS SHEET OF ENGINEERING DRAWING IS THE PROPRIETARY PROPERTY OF COMPAL ELECTRONICS, INC. AND CONTAINS CONFIDENTIAL AND TRADE SECRET INFORMATION. THIS SHEET MAY NOT BE TRANSFERRED FROM THE CUSTODY OF THE COMPETENT DIVISION OF R&D DEPARTMENT EXCEPT AS AUTHORIZED BY COMPAL ELECTRONICS, INC. NEITHER THIS SHEET NOR THE INFORMATION IT CONTAINS MAY BE USED BY OR DISCLOSED TO ANY THIRD PARTY WITHOUT PRIOR WRITTEN CONSENT OF COMPAL ELECTRONICS, INC.				Size	Document Number			Rev	X00		
				Date:	Tuesday, June 21, 2016			Sheet	56	of	61

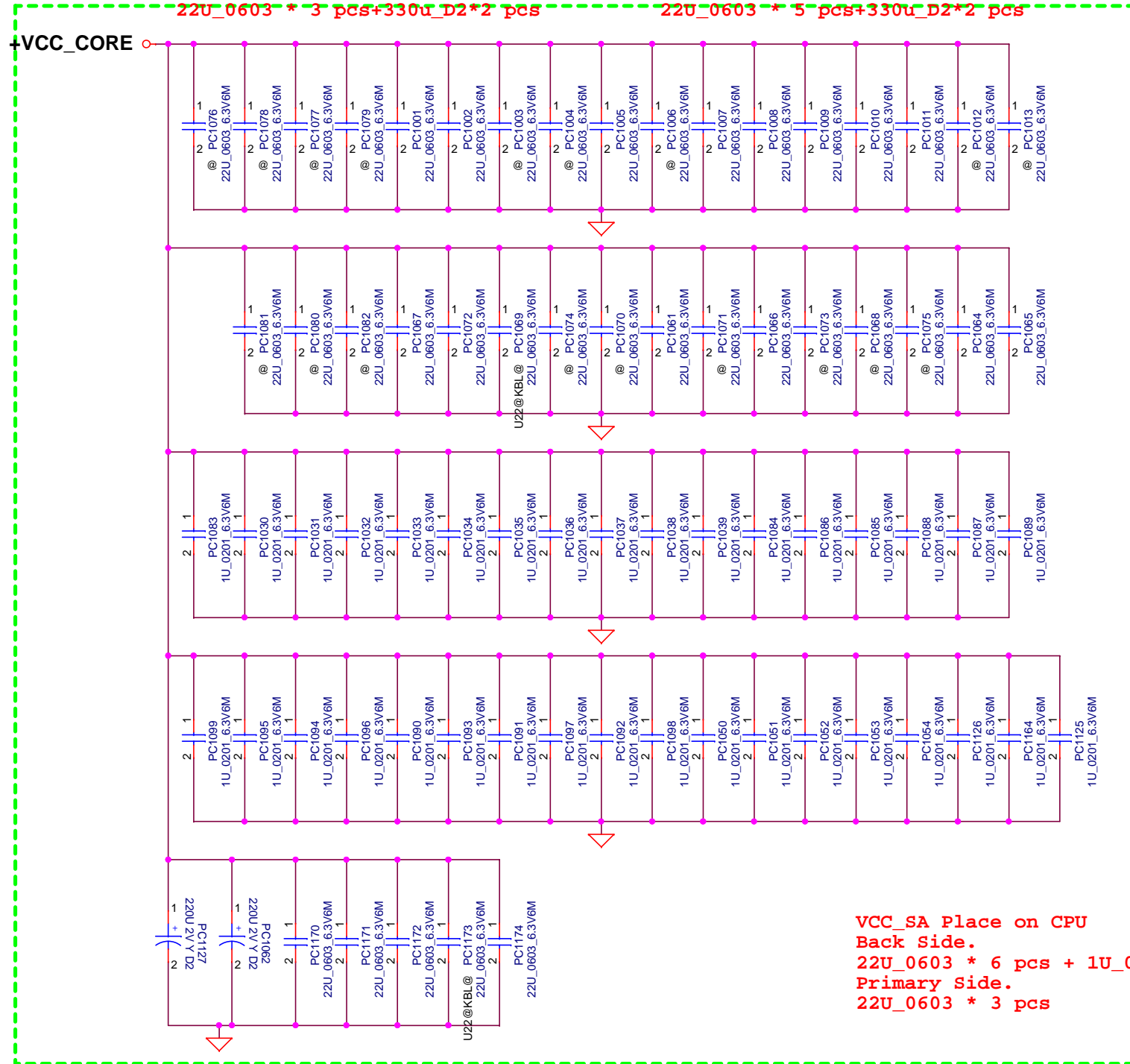


Security Classification		Compal Secret Data		Compal Electronics, Inc.		
Issued Date	2015/03/23	Deciphered Date	2014/12/15	Title		
THIS SHEET OF ENGINEERING DRAWING IS THE PROPRIETARY PROPERTY OF COMPAL ELECTRONICS, INC. AND CONTAINS CONFIDENTIAL AND TRADE SECRET INFORMATION. THIS SHEET MAY NOT BE TRANSFERRED FROM THE CUSTODY OF THE COMPETENT DIVISION OF R&D DEPARTMENT EXCEPT AS AUTHORIZED BY COMPAL ELECTRONICS, INC. NEITHER THIS SHEET NOR THE INFORMATION IT CONTAINS MAY BE USED BY OR DISCLOSED TO ANY THIRD PARTY WITHOUT PRIOR WRITTEN CONSENT OF COMPAL ELECTRONICS, INC.				PWR +VCC core and +VCC GT		
				Size	Document Number	Rev
				Date:	Tuesday, June 21, 2016	Sheet 57 of 61

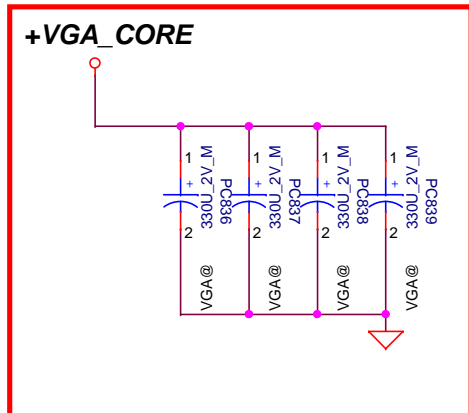
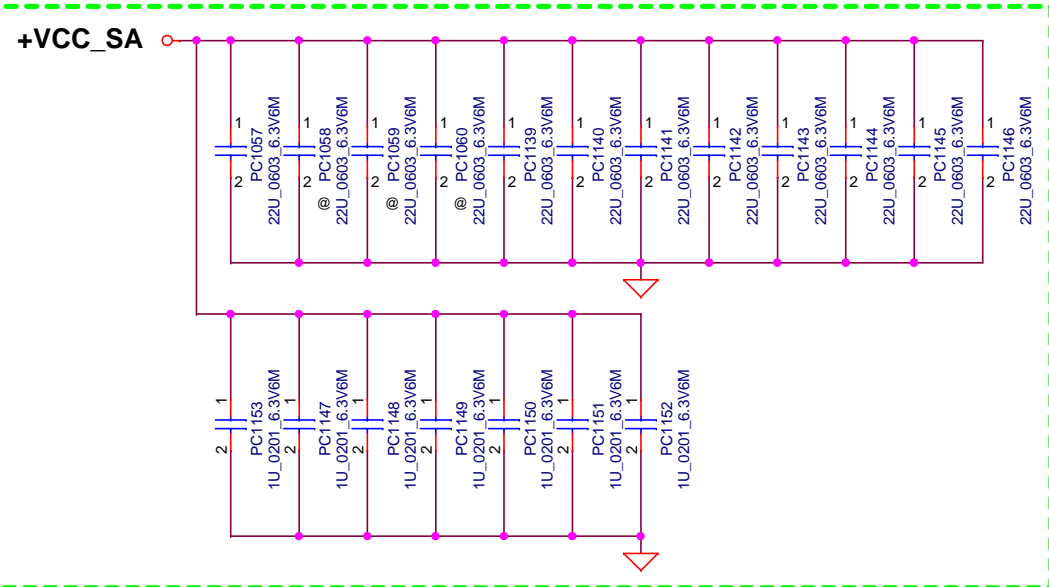
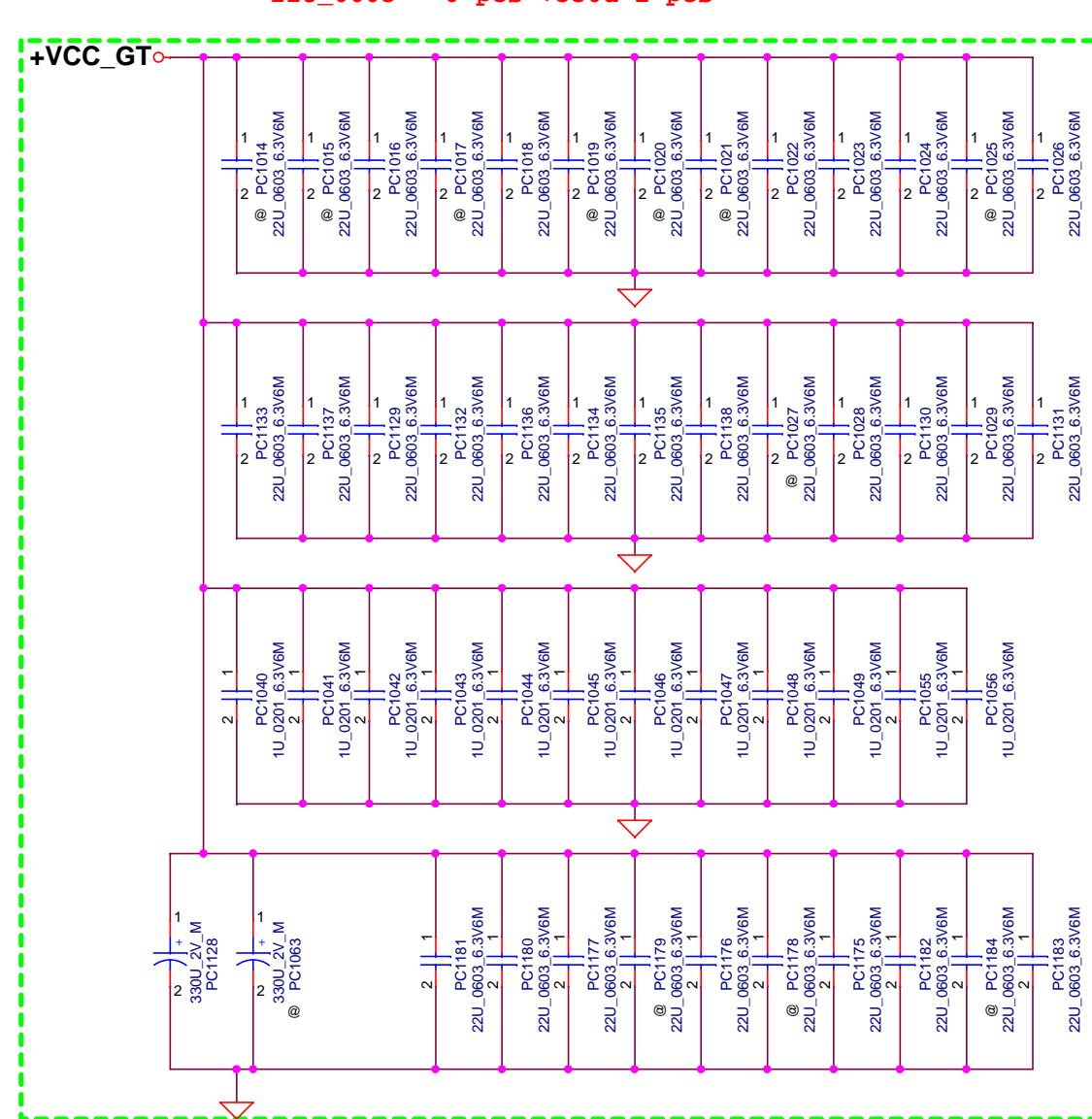
SKL :
VCC_CORE Place on CPU
Back Side.
22U_0603 * 15 pcs +1U_0201*35 pcs
Primary Side.
22U_0603 * 3 pcs+330u_D2*2 pcs

KBL :
VCC_CORE Place on CPU
Back Side.
22U_0603 * 15 pcs +1U_0201*35 pcs
Primary Side.
22U_0603 * 5 pcs+330u_D2*2 pcs

VCC_GT Place on CPU
Back Side.
22U_0603 * 19 pcs +1U_0201*12 pcs
Primary Side.
22U_0603 * 6 pcs +330u*1 pcs



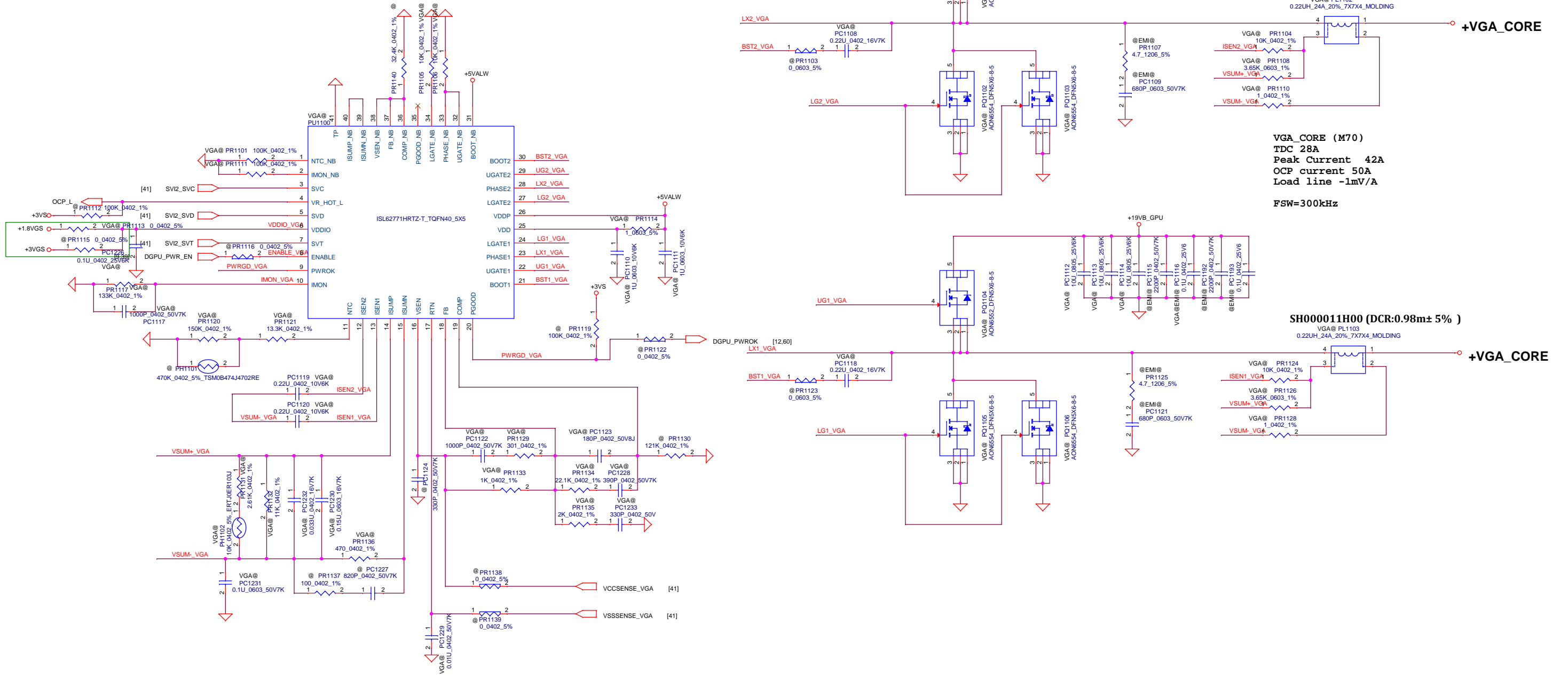
VCC_SA Place on CPU
Back Side.
22U_0603 * 6 pcs + 1U_0201*7 pcs
Primary Side.
22U_0603 * 3 pcs



For VGACORE

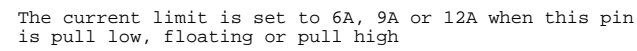
DELL CONFIDENTIAL/PROPRIETARY

Security Classification		Compal Secret Data		Title	
Issued Date	2014/11/05	Deciphered Date	2014/12/15	Compal Electronics, Inc.	
THIS SHEET OF ENGINEERING DRAWING IS THE PROPRIETARY PROPERTY OF COMPAL ELECTRONICS, INC. AND CONTAINS CONFIDENTIAL AND TRADE SECRET INFORMATION. THIS SHEET MAY NOT BE TRANSFERRED FROM THE CUSTODY OF THE COMPETENT DIVISION OF R&D DEPARTMENT EXCEPT AS AUTHORIZED BY COMPAL ELECTRONICS, INC. NEITHER THIS SHEET NOR THE INFORMATION IT CONTAINS MAY BE USED BY OR DISCLOSED TO ANY THIRD PARTY WITHOUT PRIOR WRITTEN CONSENT OF COMPAL ELECTRONICS, INC.				Document Number	Rev X00
Date: Tuesday, June 21, 2016				Sheet 58 of 61	



DELL CONFIDENTIAL/PROPRIETARY

Compal Secret Data				Compal Electronics, Inc.	
Security Classification	2015/03/23	Deciphered Date	2014/12/15	Title	
Issued Date	2015/03/23	Deciphered Date	2014/12/15	PWR_VGA_CORE	
THIS SHEET OF ENGINEERING DRAWING IS THE PROPRIETARY PROPERTY OF COMPAL ELECTRONICS, INC. AND CONTAINS CONFIDENTIAL AND TRADE SECRET INFORMATION. THIS SHEET MAY NOT BE TRANSFERRED FROM THE CUSTODY OF THE COMPETENT DIVISION OF R&D DEPARTMENT EXCEPT AS AUTHORIZED BY COMPAL ELECTRONICS, INC. NEITHER THIS SHEET NOR THE INFORMATION IT CONTAINS MAY BE USED BY OR DISCLOSED TO ANY THIRD PARTY WITHOUT PRIOR WRITTEN CONSENT OF COMPAL ELECTRONICS, INC.				Rev	X00
Date: Tuesday, June 21, 2016				Sheet	59 of 61



OCP setting	ILMT(pin13)
6A	Pull low
9A	Floating
12A	Pull high

Version Change List (P. I. R. List)

Item	Page#	Title	Date	Request Owner	Issue Description	Solution Description	Rev.
1	P51	PWR	20160321	COMPAL	design change charger IC design change	PU706 change to ISL88739 PR732 change to 53.6K PR774 change to 1K PC748 change to 0.1U delete PR727,PC762,PC763,PC776	0.1(X00)
2	P56	PWR	20160321	COMPAL	design change for IA_Core Iccmax 32A	Change the PR640 to 280 Ohm Change the PR648 to 1.5k Change the PR629 to 93.1k	0.1(X00)
3	P58	PWR	20160321	COMPAL	design change	delete PC1003,PC1004,PC1006,PC1012,PC1013,PC1014,PC1015,PC1017,PC1019,PC1020,PC1021,PC1025,PC1027,PC1058,PC1059,PC1060,PC1068,PC1070,PC1071,PC1073,PC1074,PC1075,PC1076,PC1077,PC1078,PC1079,PC1080,PC1081,PC1082 add PC1170,PC1171,PC1172,PC1173,PC1174,PC1175,PC1176,PC1177,PC1180,PC1181,PC1182,PC1183	0.1(X00)
4	P50	PWR	20160504	COMPAL	Reserve Erp lot6	Reserve PR2,PR5 ,PR7,PR10,PQ1	0.3(X02)
5	P51	PWR	20160504	COMPAL	PQ740 damage issue	Change PQ740 to SB00000SY00 (MDU1512R)	0.3(X02)
6	P51	PWR	20160504	COMPAL	EMI solution	Change to SE068102J80 (1000P) Location : PC780,PC781,PC100,PC131,PC115,PC133,PC230,PC231,PC694,PC691,PC692,PC693,PC1420,PC1421	0.3(X02)
7	P51	PWR	20160614	COMPAL	Change SOT23-6P to SOT23-3P	change PQ709 to SB00000ST00 (PQ709,PQ712)	1.0(A00)
8	P51	PWR	20160614	COMPAL	Add pull high resistance	Add PR781	1.0(A00)

DELL CONFIDENTIAL/PROPRIETARY

Security Classification	Compal Secret Data			Compal Electronics, Inc.	
Issued Date	2015/12/22	Deciphered Date	2017/01/31	Title	PWR Change list
THIS SHEET OF ENGINEERING DRAWING IS THE PROPRIETARY PROPERTY OF COMPAL ELECTRONICS, INC. AND CONTAINS CONFIDENTIAL AND TRADE SECRET INFORMATION. THIS SHEET MAY NOT BE TRANSFERED FROM THE CUSTODY OF THE COMPETENT DIVISION OF R&D DEPARTMENT EXCEPT AS AUTHORIZED BY COMPAL ELECTRONICS, INC. NEITHER THIS SHEET NOR THE INFORMATION IT CONTAINS MAY BE USED BY OR DISCLOSED TO ANY THIRD PARTY WITHOUT PRIOR WRITTEN CONSENT OF COMPAL ELECTRONICS, INC.				Size	Document Number
				Date:	Tuesday, June 21, 2016
				Sheet	61 of 61